

SuperServer®

SYS-222C-TN

USER'S MANUAL

Revision 1.1 (MNL-2713)

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Manual Revision 1.1

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Preface

About This Manual

This manual is written for professional system integrators and PC technicians. It provides information for the installation and use of the SYS-222C-TN server. Installation and maintenance should be performed by certified service technicians only.

Notes

For your system to work properly, follow the links below to download all necessary drivers/utilities and the user's manual for your server.

- Supermicro product manuals: https://www.supermicro.com/support/manuals
- Product drivers and utilities: https://www.supermicro.com/wdl
- Product safety info: https://www.supermicro.com/about/policies/safety_information.cfm
- A secure data deletion tool designed to fully erase all data from storage devices can be found on our website: https://www.supermicro.com/about/policies/disclaimer.cfm?url=/wdl/utility/Lot9_Secure_Data_Deletion_Utility
- Frequently Asked Questions: https://www.supermicro.com/FAQ/index.php
- If you still have questions after referring to our FAQs, contact our support team. Region-specific Technical Support email addresses can be found at: "Contacting Supermicro" on page 13
- If you have any feedback on Supermicro product manuals, contact our writing team at: Techwriterteam@supermicro.com

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Conventions Used in the Manual

Special attention should be given to the following symbols for proper installation and to prevent damage done to the components or injury to yourself.



Warning! Indicates important information given to prevent equipment/property damage or personal injury.



Warning! Indicates high voltage may be encountered while performing a procedure.

Important: Important information given to ensure proper system installation or to relay safety precautions.

Note: Additional information given to differentiate various models or to provide information for proper system setup.

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Contacting Supermicro

Headquarters

Address:	Super Micro Computer, Inc. 980 Rock Ave. San Jose, CA 95131 U.S.A.
Tel:	+1 (408) 503-8000
Fax:	+1 (408) 503-8008
Email:	Marketing@supermicro.com (General Information) Sales-USA@supermicro.com (Sales Inquiries) Government_Sales-USA@supermicro.com (Gov. Sales Inquiries) Support@supermicro.com (Technical Support) RMA@Supermicro.com (RMA Support) Webmaster@supermicro.com (Webmaster)
Website:	https://www.supermicro.com

Europe

Address:	Super Micro Computer B.V. Het Sterrenbeeld 28, 5215 ML 's-Hertogenbosch, The Netherlands
Tel:	+31 (0) 73-6400390
Fax:	+31 (0) 73-6416525
Email:	Sales_Europe@supermicro.com (Sales Inquiries) Support_Europe@supermicro.com (Technical Support) RMA_Europe@supermicro.com (RMA Support)
Website:	https://www.supermicro.nl

Asia-Pacific

Address:	Super Micro Computer, Inc. 3F, No. 150, Jian 1st Rd. Zhonghe Dist., New Taipei City 235 Taiwan (R.O.C)
Tel:	+886 (2) 8226-3990
Fax:	+886 (2) 8226-3992
Email:	Sales-Asia@supermicro.com.tw (Sales Inquiries) Support@supermicro.com.tw (Technical Support) RMA@supermicro.com.tw (RMA Support)
Website:	https://www.supermicro.com.tw

Chapter 1:

Introduction

This chapter provides a brief outline of the functions and features of the SYS-222C-TN system. It is based on the X14DBHM motherboard and the CSE-DC201TS-R000NP chassis.

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1.1 System Overview

The following provides an outline of the functions and features of the SuperServer® SYS-222C-TN. It is based on the X14DBHM motherboard and the CSE-DC201TS-R000NP chassis.

System Overview	
Motherboard	X14DBHM
Chassis	CSE-DC201TS-R000NP
Processor	Dual Intel® Xeon® 6700/6500-series processors (in Socket E2 LGA4710) with four UPIs (24 GT/s max.) and a thermal design power (TDP) up to 350 W air cooled
Memory	32 DIMM slots supports up to 4 TB of ECC DDR5 RDIMM memory with speeds of up to 6400 MT/s (1DPC) or 5200 MT/s (2DPC)
Drive Support	24 hot-swap 2.5" NVMe/SAS/SATA drive bays (additional storage cards and cables required) Two M.2 PCIe 5.0 x2 NVMe SSD slots M-key in the 22110 or 2280 form factors for boot; VROC required for RAID **Note:** M.2 slots are intended to be used only for boot devices. Write-intensive workloads may result in the SSD overheating. PCIe lanes are shared between CEM slots and drive bays. Enabling more CEM slots may reduce the number of NVme drives available.
Expansion Slots	Two PCIe 5.0 x16 AIOM (OCP 3.0 compatible) Option 1 and 2: Four PCIe 5.0 x16 slots (full-height, full-length) One PCIe 5.0 x8 slot (full-height, full-length) Option 2: Two PCIe 5.0 x16 slot (full-height, full-length) One PCIe 5.0 x8 slot (full-height, full-length) Option 3: Six PCIe 5.0 x16 slots (full-height, full-length) **Note:** PCIe lanes are shared between CEM slots and drive bays. Enabling more NVMe drives may reduce the number of CEM slots available. Full-length card requires 1U heatsinks with special air shroud.
I/O Ports	Via DC-SCM: One RJ45 1 GbE Dedicated IPMI LAN port One USB 3.0 Type-A port One USB 2.0 Type-A port One VGA port One TPM header
System Cooling	Four 8-cm heavy duty fans with optimal fan speed control Two air shrouds
Power	Redundant Titanium level AC power supplies with options for 2000 W or 3200 W
Form Factor	2U: 17.3 x 3.5 x 30.7 in. / 438 x 88 x 780 mm (WxHxD)

Note: A Quick Reference Guide can be found on the product page of the Supermicro Website. The following safety models associated with the SYS-222C-TN have been certified as compliant with UL or CSA: DC201-R20X14 or DC201-MHS.

1.2 System Features

The following views of the system display the main features. Refer to the System Specifications appendix of this manual for additional specifications.

Front View

The following features are located on the front of SYS-222C-TN server. The 2U chassis features different drive configurations.



Figure 1-1. Front View

Front Features	
Feature	**Description**
Control Panel	Front control panel with LEDs and buttons. See the Control Panel for more details.
Service/Asset Tag	Pull-out service or asset tag has the BMC password details.

Logical Storage Drive Numbers	
Item	**Description**
0-23	24 hot-swap 2.5" NVMe/SATA/SAS hybrid drive bays
NVMe/SATA/SAS support requires additional parts from the Optional Parts list.	

NVMe SSD Drive Indicators

Each NVMe SSD module has two LED indicators: an activity indicator and a status indicator. For RAID configurations using a controller, the meaning of the status indicator is described in the table below. For OS RAID or non-RAID configurations, some LED indications are not supported, such as hot spare. For VROC configurations. refer to the Intel Virtual RAID on CPU (VROC) section of this manual under Optional Components.

Drive LEDs			
LED	**Color**	**Pattern**	**Device Behavior**
Activity LED	Blue	Solid	Idle SAS/NVMe storage module installed
	Blue	Blinking	I/O activity
	Off	N/A	Idle SATA drive installed
Status LED	Red	Solid	Failure of drive with RSTe support
	Red	Blinking at 1 Hz	Rebuild drive with RSTe support
	Red	Blinking with two blinks and one stop at 1 Hz	Hot spare for drive with RSTe support
	Red	On for five seconds, then off	Power on for drive with RSTe support
	Red	Blinking at 4 Hz	Identify drive with RSTe support
	Green	Solid	Safe to remove NVMe storage module
	Amber	Blinking at 1 Hz	Do not remove NVMe storage module

Control Panel

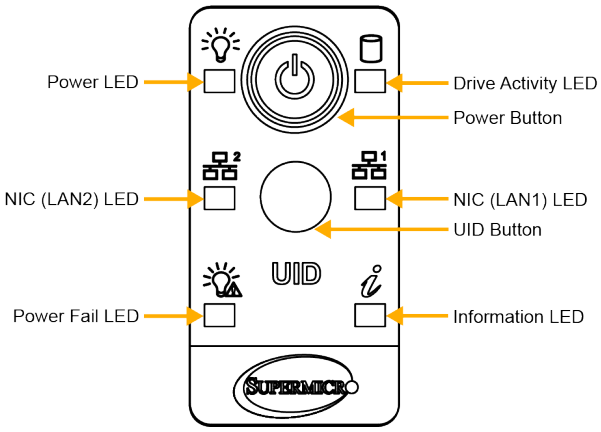


Figure 1-2. Control Panel

Control Panel Features	
Feature	**Description**
Power LED	Indicates power is being supplied to the system power supply. This LED should normally be illuminated when the system is operating.
Drive Activity LED	Indicates activity on a storage device when flashing.
Power Button	The main power button is used to apply or remove power from the power supplies to the server. Turning off system power with this button removes the main power but maintains standby power. To perform many maintenance tasks, you must also unplug the system before servicing.
NIC (LAN1) LED	Indicates network activity on odd-numbered AIOM ports when flashing.
NIC (LAN2) LED	Indicates network activity on even-numbered AIOM ports when flashing.
UID Button	The button switch is a unit identifier button for easy system location in large stack configurations. When the UID button is pressed, the blue LED on both the front and rear of the chassis will be illuminated.
Information LED	See the table below for details.
Power Fail LED	Indicates a power supply module has failed.

Information LED	
Status	**Description**
Red, solid	An overheat condition has occurred.
Red, blinking at 1 Hz	Fan failure; check for an inoperative fan.
Red, blinking at 0.25 Hz	Power failure; check for an inoperative power supply.
Red, solid with Power LED blinking green	Fault detected.
Blue and red, blinking at 10 Hz	Recovery mode.
Blue, solid	UID has been activated locally to locate the server in a rack environment.
Blue, blinking at 1 Hz	UID has been activated using the BMC to locate the server in a rack environment.
Blue, blinking at 2 Hz	BMC is resetting.
Blue, blinking at 4 Hz	BMC is setting factory results.
Blue, blinking at 10 Hz with Power LED blinking green	BMC/BIOS firmware is updating.

Rear View

The illustration below shows the features included on the rear of the SYS-222C-TN, including the power supply module display status lights.

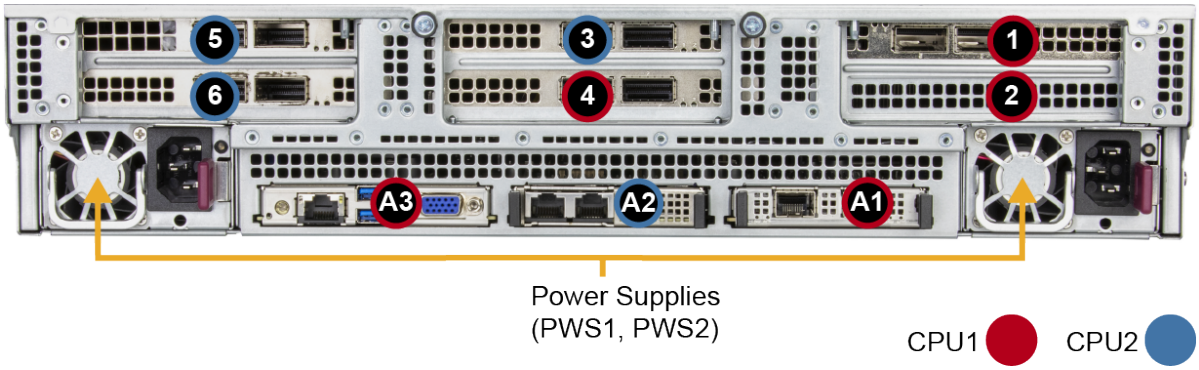


Figure 1-3. Rear View

Rear Features	
Feature	**Description**
Power Supplies	Two redundant CRPS/M-CRPS Titanium Level power supplies (options for 2000 W or 3200 W)

Expansion Slot Locations	
Slot	**Description**
1-6	Six PCIe 5.0 configurable FHFL slots
A1-A2	Two PCIe 5.0 x16 AIOM (OCP 3.0) slots
A3	One DC-SCM slot

Top View

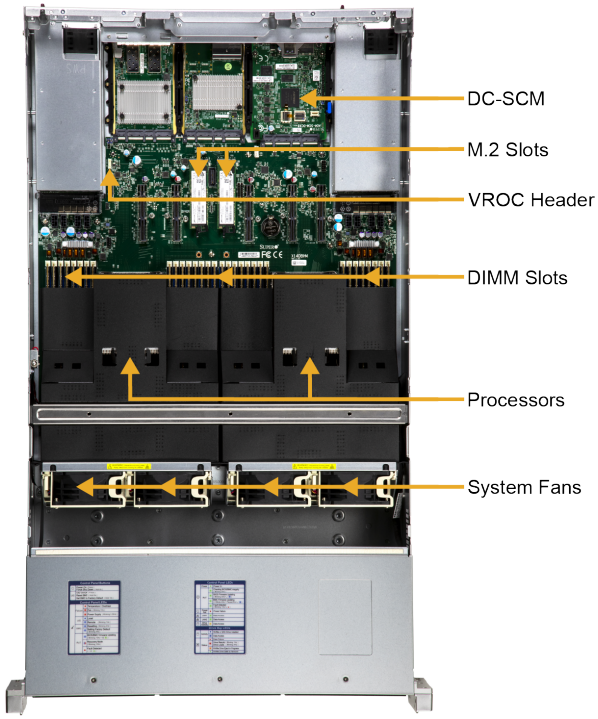


Figure 1-4. SYS-222C-TN Top View

Top Features	
Feature	**Description**
DC-SCM	Data Center Secure Control Module (AOC-SCM-DCX6)
M.2 Slots	Two M.2 NVMe slots
VROC Header	One VROC key header
DIMM Slots	32 DDR5 DIMM slots
Processors	Dual Intel® Xeon® 6700/6500 series processors
System Fans	Four 8-cm internal heavy duty fans

Wake-On-LAN and Standby

The SYS-222C-TN system architecture supports both Wake-on-LAN (WoL) functionality and Standby (STBY) power states. It operates across three primary power states, defined as follows:

Wake-on-LAN and Standby States	
S0 (Working State)	The system is fully powered and operational.
S5 (Soft O/Standby State)	The system is in a low-power standby mode with the following characteristics: • Power is maintained through a dedicated power rail. • A regulated 5 V standby supply is available with current-limiting protection. • Key components, such as the CPU and system fans, are powered down or operating at reduced functionality. • Despite components being inactive, residual heat will dissipate, utilizing a thermal management system under WoL/STBY conditions.
G3 (Mechanical O)	The system is completely powered down with AC power removed.
In S5, although the CPU is not executing instructions, heat will still generate. A dedicated thermal solution has been implemented to manage this condition, particularly when WoL is enabled.	

Thermal Validation Under WoL/STBY Conditions

Thermal characterization was performed on a reference system to simulate Wake-on-LAN and standby scenarios. Key points to note are as follows:

- The system has entered the S5 state.
- The system was set to a 40% pulse-width modulation duty cycle.
- The inlet temperature is set to 35°C with cards placed only in AOC Slot 1 and AIOM Slot A1.

Note: WoL is supported in either AOC slot 1 or AIOM slot A1 (up to 100 G), requiring upgraded fans and a CPU TDP not exceeding 225 W.

1.3 System Architecture

This section covers the locations of the system's main components and provides a motherboard block diagram.

System Block Diagrams

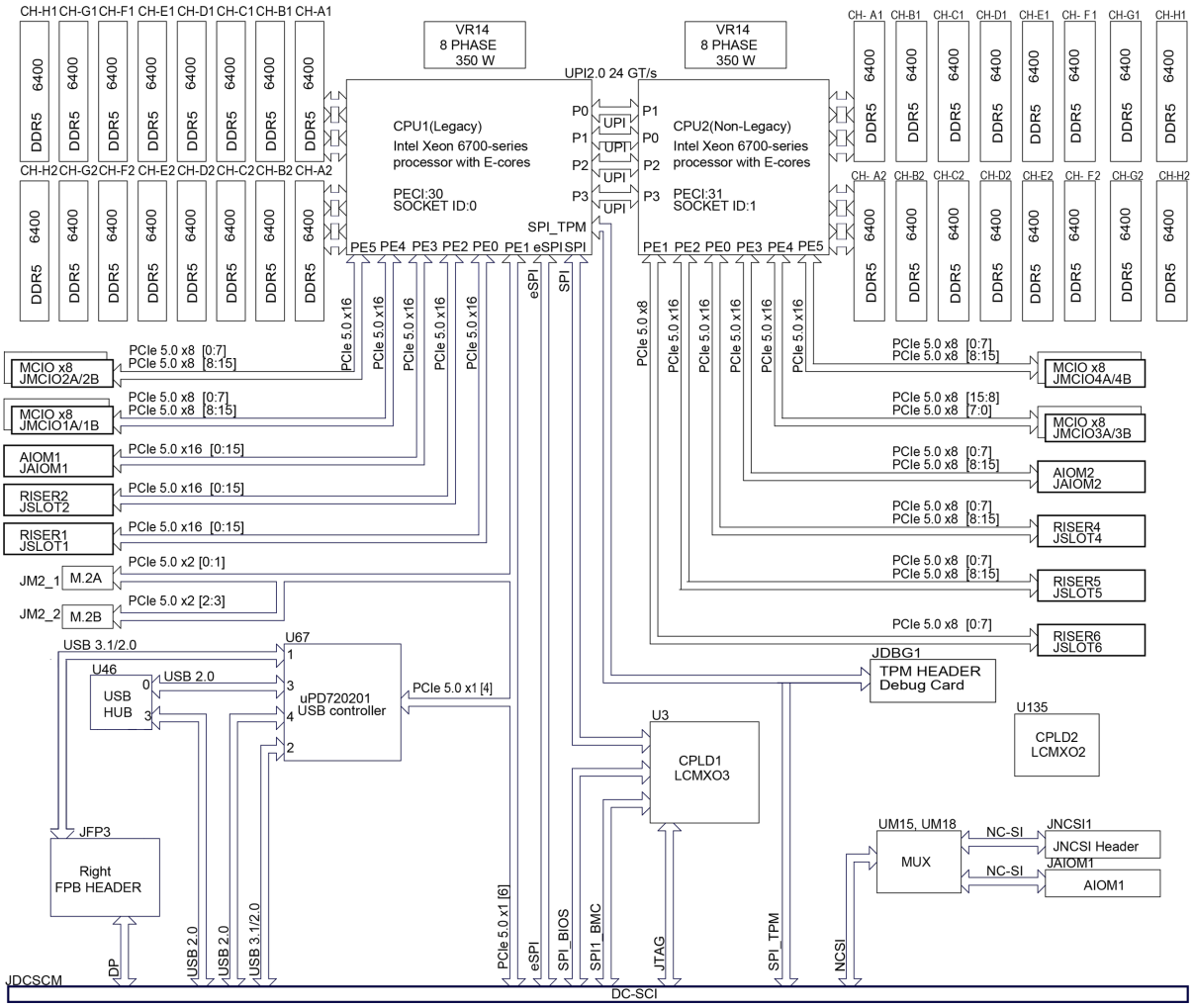


Figure 1-5. X14DBHM Block Diagram

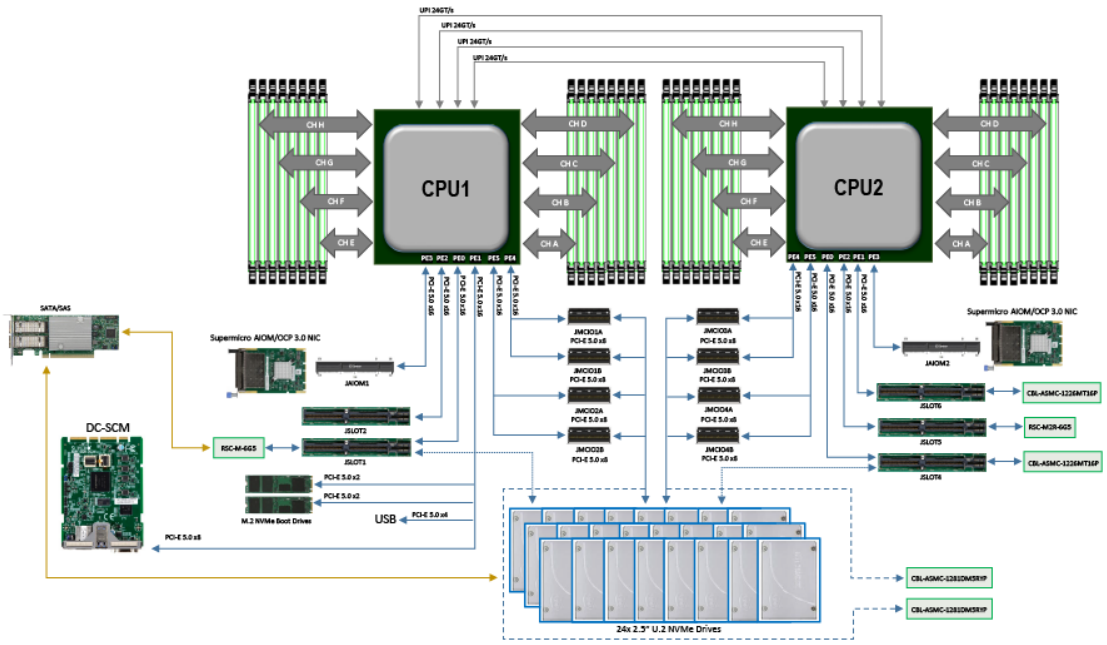


Figure 1-6. SYS-222C-TN Block Diagram

Note: This is a general block diagram and may not exactly represent the features on your motherboard. For the actual specifications of your motherboard, see "Motherboard Quick Reference" on page 28.

SYS-222C-TN PCIe Lane Distribution				
CPU	**Port**	**PCIe**	**Motherboard Connector**	**PCIe Lane Assignment**
CPU1	PE0	x16	JSLOT1	Option 1, 2, 3 & 4: PCIe slot 1
	PE1	x4	JM2_1, JM2_2	Internal 2x NVMe M.2 slots
		x4	JDCSMC1	DC-SCM module
	PE2	x16	JSLOT2	Option 1, 2 & 4: PCIe slot 4 Option 3: NVMe drive bays 0-3
	PE3	x16	JAIOM1	AIOM NIC slot A1
	PE4	x16	JMCIO1A, JMCIO1B	Option 1 & 4: NVMe drive bays 8-11 Option 2: NVMe drive bays 0-3 Option 3: NVMe drive bays 4-7
	PE5	x16	JMCIO2A, JMCIO2B	Option 1 & 4: Not used Option 2: NVMe drive bays 4-7 Option 3: NVMe drive bays 8-11
CPU2	PE0	x8	JSLOT4	Option 1, 2 & 4: PCIe slot 4 Option 3: NVMe drive bays 12-15
	PE1	x16	JSLOT6	Option 1 & 2: PCIe slot 5 Option 3: PCIe slot 3 Option 4: Not used
	PE2	x16	JSLOT5	Option 1, 2, 3 & 4: PCIe slot 6
	PE3	x16	JAIOM2	AIOM NIC slot A2
	PE4	x16	JMCIO3A, JMCIO3B	Option 1 & 4: NVMe drive bays 12-15 Option 2: NVMe drive bays 16-19 Option 3: NVMe drive bays 16-19
	PE5	x16	JMCIO4A, JMCIO4B	Option 1 & 4: Not used Option 2: NVMe drive bays 20-23 Option 3: NVMe drive bays 20-23

1.4 Motherboard Quick Reference

For details on the X14DBHM motherboard layout and other quick reference information, refer to the content below.

Motherboard Layout

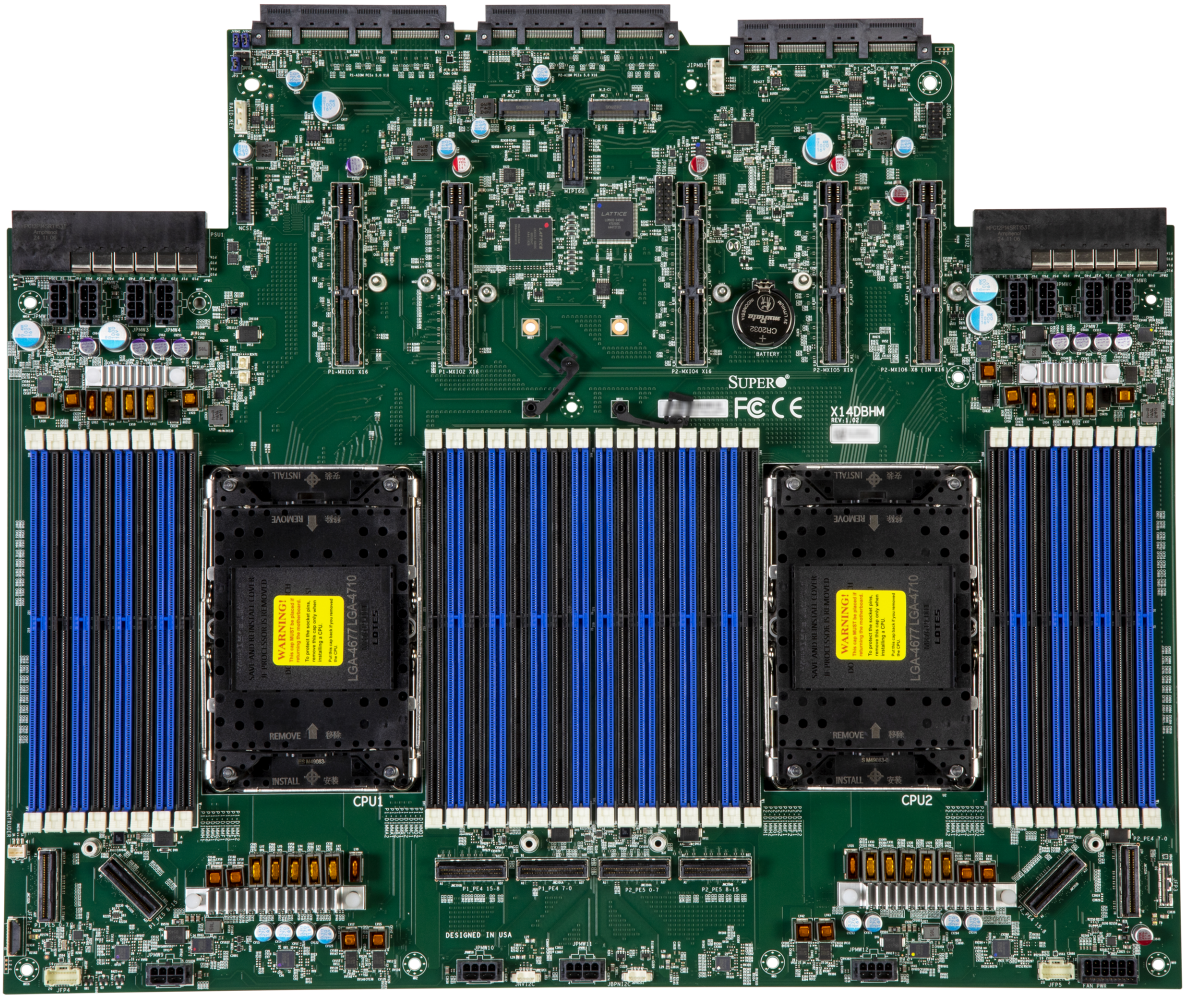


Figure 1-7. X14DBHM Motherboard Image

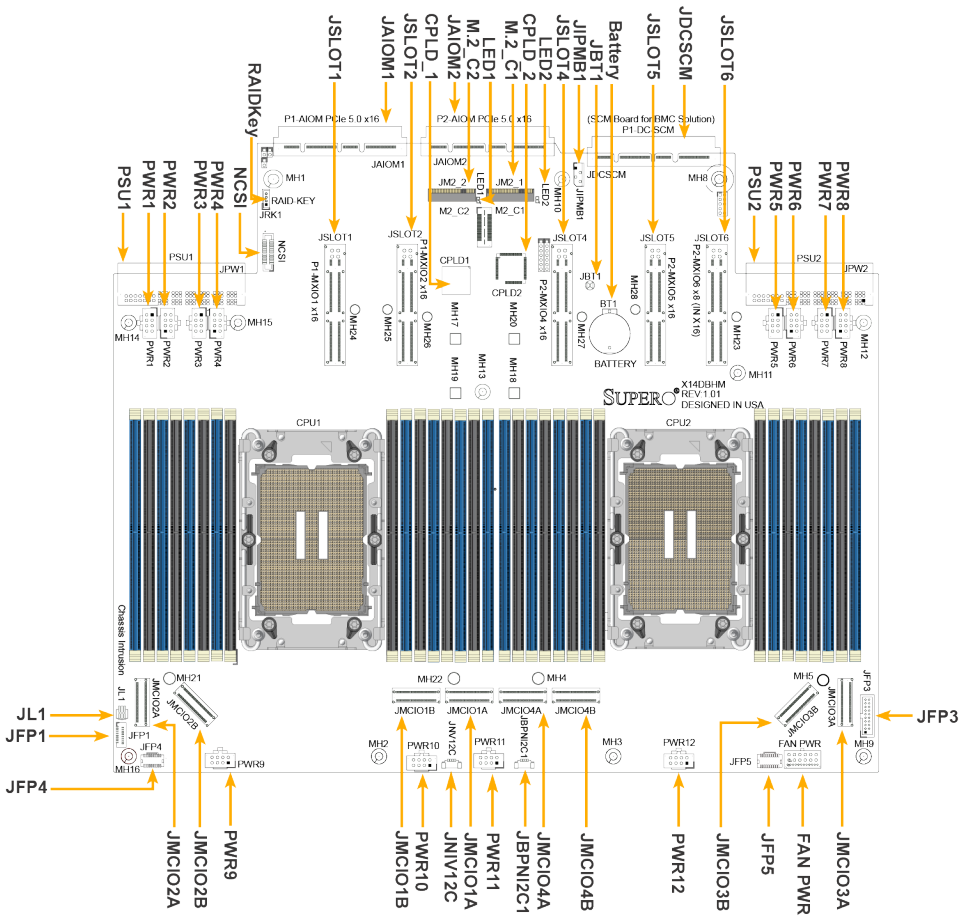


Figure 1-8. X14DBHM Motherboard Layout Rev. 1.01

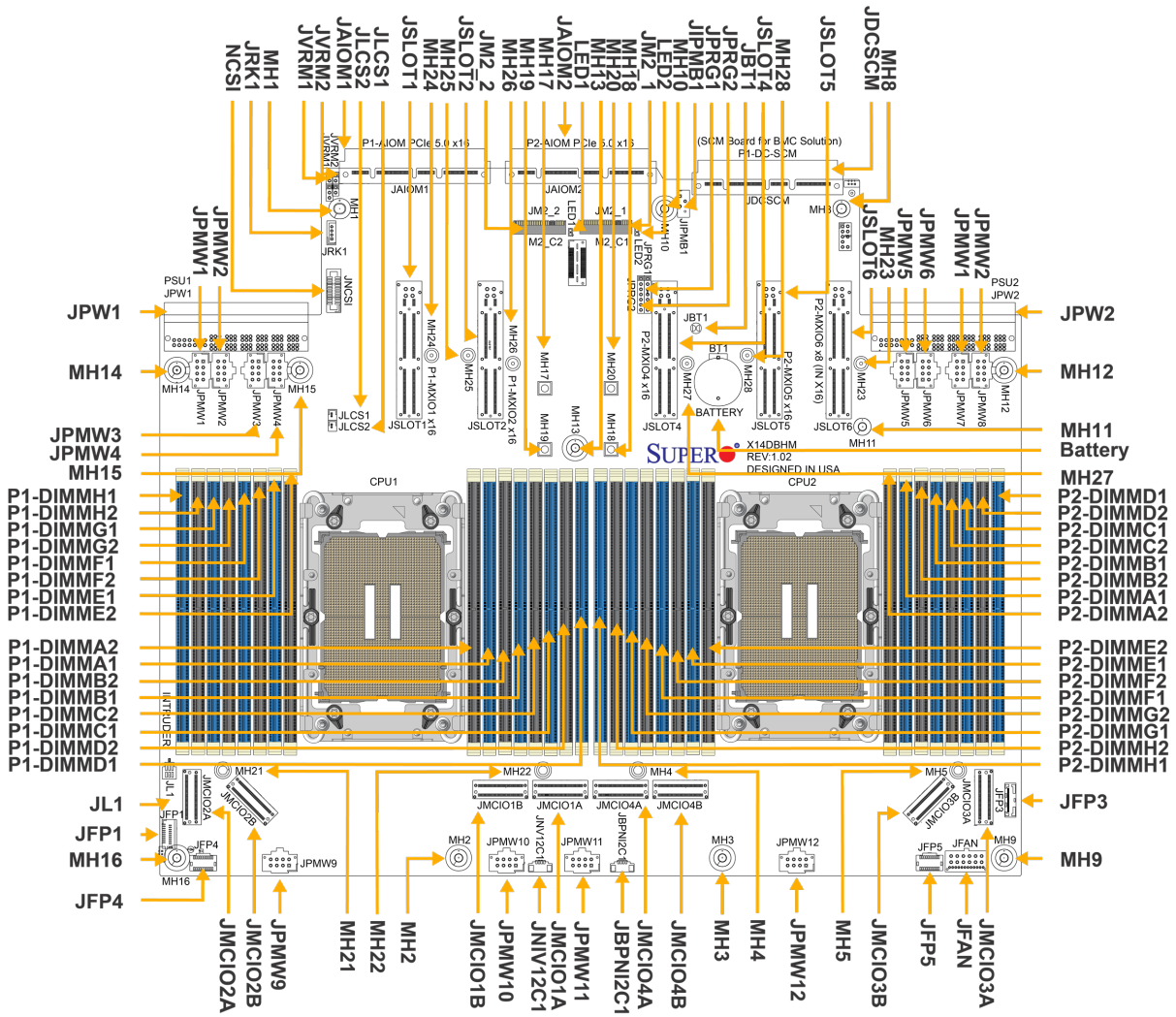


Figure 1-9. X14DBHM Motherboard Layout Rev. 1.02

Note: All graphics shown in this manual were based upon the latest PCB revision available at the time of publication of the manual. The motherboard you received may or may not look exactly the same as the graphics shown in the manual.

Notes:

- For detailed information on jumpers, connectors, and LED indicators, see "Maintenance and Component Installation" on page 51.
- "■" indicates the location of pin 1.
- "MH" indicates the location of a mounting hole.
- Components not documented are for internal testing purposes only.
- Use only the correct type of onboard CMOS battery as specified by the manufacturer. To avoid possible explosion, do not install the onboard battery upside down.

Quick Reference Table

Jumper	Description	Jumper Setting
JBT1	CMOS Clear	Open (Normal)

LED	Description	Status
LED1	M.2_C2 LED	Green Blinking: M.2: Active
LED2	M.2_C1 LED	Green Blinking: M.2: Active

Connector	Description
BT1	Onboard CMOS Battery
CPLD1/CPLD2	Complex Programmable Logic Devices
JFAN/FAN_PWR	Cooling Fan Power Connector
JAIOM1	Supermicro Advanced Input/Output Module (AIOM) Connector for Rear I/O Support (P1-AIOM PCIe 5.0 x16)
JAIOM2	Supermicro Advanced Input/Output Module (AIOM) Connector for Rear I/O Support (P2-AIOM PCIe 5.0 x16)
JBPNI^{2}C1	Backplane I^{2}C NVMe Header
JIPMB1	4-pin BMC external I^{2}C Header
JFP1	Front Control Panel Header
JFP3	Front Control Panel Header 2
JFP4–JFP5	Front Control Panel Header for INTEL (optional)

Connector	Description
JL1	Chassis Intrusion Header
JMCIO1A/1B	MCIO PCIe 5.0 x8 Connectors (P1-PE4 7-0/P1-PE4 15-8)
JMCIO2A/2B	MCIO PCIe 5.0 x8 Connectors (P1-PE5 0-7/P1-PE4 8-15)
JMCIO3A/3B	MCIO PCIe 5.0 x8 Connectors (P2-PE4 15-8/P2-PE4 7-0)
JMCIO4A/4B	MCIO PCIe 5.0 x8 Connectors (P2-PE5 0-7/P2-PE5 8-15)
JNCSI1	Network Controller Sideband Interface (NC-SI) Connector
JNVI^{2}C1	Backplane NVMe VPP Header
JPMW1–JPMW8/PWR1–PWR8	8-pin +12 V Power Connectors
JPMW9–JPMW12/PWR9–PWR12	8-pin +12 V Backplane/GPU Power Connectors
JPRG1–JPRG2	Programming Header for Motherboard Complex Programmable Logic Devices (CPLD)
JRK1	Intel VROC RAID Key Header
JSLOT1 (P1-MXIO1)	Multi-Trak I/O PCIe 5.0 x16 Slot
JSLOT2 (P1-MXIO2)	Multi-Trak I/O PCIe 5.0 x16 Slot
JSLOT4 (P2-MXIO4)	Multi-Trak I/O PCIe 5.0 x16 Slot
JSLOT5 (P2-MXIO5)	Multi-Trak I/O PCIe 5.0 x16 Slot
JSLOT6 (P2-MXIO6)	Multi-Trak I/O PCIe 5.0 x8 Slot
JVRM1–JVRM2	VRM Header
M.2_C1/M.2_C2 (JM.2_C1/C2)	M.2 M-key PCIe 5.0 x2 Slots C1/C2
MH1/MH8	Motherboard Guide Pins
MH2/MH3/MH9–MH16	Motherboard Mounting Holes
MH23–MH28	Riser Card Guide Pins
MH4/MH5/MH21/MH22	Processor Heatsink Module (PHM) Mounting Holes
MH17–MH20	M.2 M-key Mounting Holes

Connector	Description
P1-DC-SCM (JDCSCM)	DC-SCM Board connector for BMC solution (PN: AOM-SCM-DCX6)
PSU1/PSU2 (JPW1/2)	Power Supply Unit1/Unit2 Connectors

Notes:

- The table below represents the power supplies that support the main power supply units (PSU1/PSU2) in the Supermicro CloudDC servers. For detailed power supply support for your particular server, refer to your CloudDC server user manual.
  - For CloudDC Systems:

PWS-2K09A-1R
PWS-3K21A-1R2

- For details on how to configure Network Interface Card (NIC) settings, refer to the Network Interface Card Configuration User's Guide posted on our website under the link: https://www.supermicro.com/support/manuals.
- For detailed instructions on how to configure VROC RAID settings, refer to the VROC RAID Configuration User's Guide posted on the web page under the link: https://www.supermicro.com/support/manuals.

Memory Slots

The X14DBHM motherboard supports up to 4 TB of ECC DDR5 RDIMM/RDIMM 3DS/MR DIMM memory with speeds of up to 6400 MT/s (1DPC) or up to 5200 MT/s (2DPC) in 32 DIMM slots.

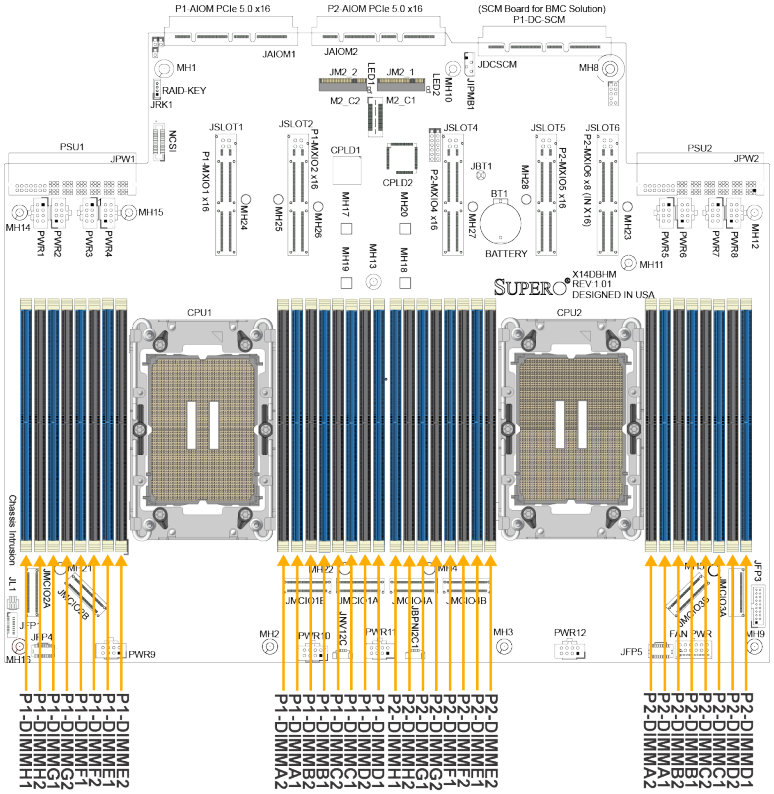


Figure 1-10. Memory Slots

DIMM Slots Supported by CPU1	DIMM Slots Supported by CPU2
P1-DIMMA1	P2-DIMMA1
P1-DIMMA2	P2-DIMMA2
P1-DIMMB1	P2-DIMMB1
P1-DIMMB2	P2-DIMMB2
P1-DIMMC1	P2-DIMMC1
P1-DIMMC2	P2-DIMMC2
P1-DIMMD1	P2-DIMMD1
P1-DIMMD2	P2-DIMMD2
P1-DIMME1	P2-DIMME1
P1-DIMME2	P2-DIMME2
P1-DIMMF1	P2-DIMMF1

DIMM Slots Supported by CPU1	DIMM Slots Supported by CPU2
P1-DIMMF2	P2-DIMMF2
P1-DIMMG1	P2-DIMMG1
P1-DIMMG2	P2-DIMMG2
P1-DIMMH1	P2-DIMMH1
P1-DIMMH2	P2-DIMMH2

1.5 DC-SCM

The AOM-SCM-DCX6 module is compliant with DC-SCM 2.0. It supports the following features and contains the following components for use with the X14DBHM motherboard and the SYS-222C-TN server:

- Supermicro RoT 2.0
- BIOS and BMC (AST 2600)

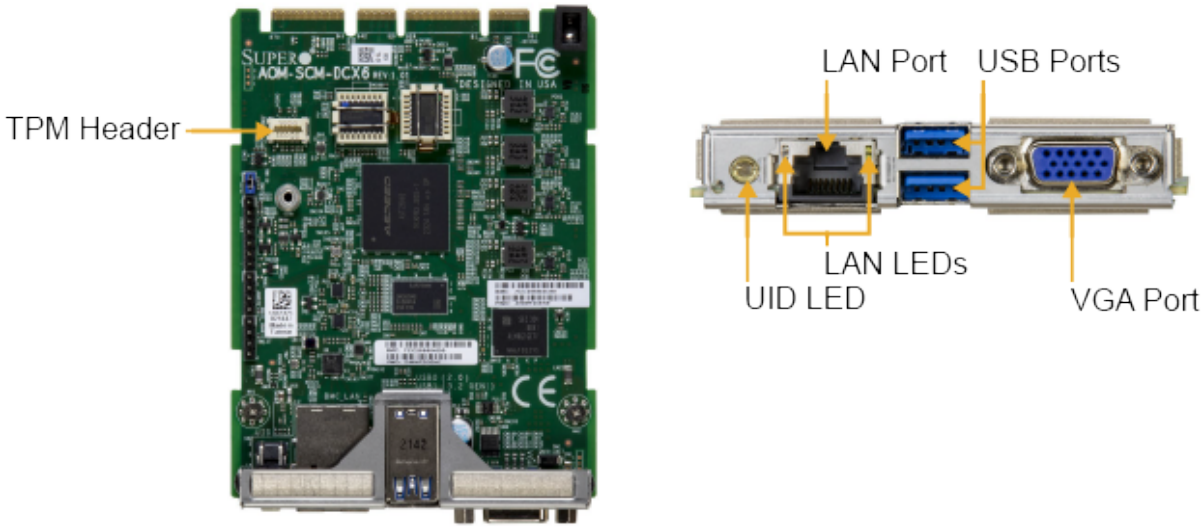


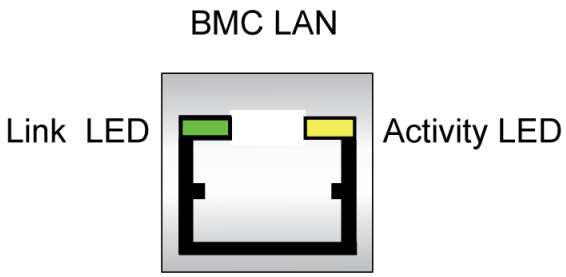
Figure 1-11. Module Component Locations

AOM-SCM-DCX6 Components	
Feature	**Description**
TPM Header	One TPM 2.0 add-on module
UID LED	One UID switch with UID LED. For details, see the Control Panel. **Note:** To perform a BMC reset, press this switch for six seconds. For a factory reset, press the switch for 12 seconds.
LAN LEDs	BMC LAN LEDs
LAN Port	One dedicated IPMI LAN port
USB Ports	One USB 2.0 upper port One USB 3.2 lower port
VGA Port	One VGA port

BMC LAN LEDs

The dedicated BMC LAN connection on the AOM-SCM-DCX6 module features two LEDs. The LED on the right indicates activity, and the LED on the left indicates the speed of the connection.

BMC LAN LEDs		
	Color/State	**Definition**
Link (left)	Green: Solid Amber: Solid	100 Mbps 1 Gbps
Activity (right)	Amber: Blinking	Active



Chapter 2:

Server Installation

This chapter provides advice and instructions for mounting your server in a server rack. If your server is not already fully integrated with processors, system memory, etc., refer to "Maintenance and Component Installation" on page 51 for details on installing those specific components.

Important: Electrostatic Discharge (ESD) can damage electronic components. To prevent such damage to printed circuit boards (PCBs), it is important to use a grounded wrist strap, handle all PCBs by their edges, and keep PCBs in anti-static bags when not in use.

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2.1 Unpacking the System

Inspect the box the server was shipped in and note if it was damaged in any way. If any equipment appears damaged, file a damage claim with the carrier who delivered it.

Decide on a suitable location for the rack unit that will hold the server. It should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated. It will also require a grounded AC power outlet nearby. Be sure to read the precautions and considerations noted in "Standardized Warning Statements for AC Systems" on page 218.

2.2 Preparing for Setup

The box in which the SYS-222C-TN server was shipped should include the rackmount hardware needed to install it into the rack. Read this section in its entirety before you begin the installation.

Choosing a Setup Location

- The server should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated.
- Leave enough clearance in front of the rack so that you can open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow sufficient space for airflow and access when servicing.
- This product should be installed only in a Restricted Access Location (dedicated equipment rooms, service closets, etc.).
- This product is not suitable for use with visual display workplace devices according to §2 of the German Ordinance for Work with Visual Display Units.

Rack Precautions

- Ensure that the leveling jacks on the bottom of the rack are extended to the floor so that the full weight of the rack rests on them.
- In single rack installations, stabilizers should be attached to the rack. In multiple rack installations, the racks should be coupled together.
- Always make sure the rack is stable before extending a server or other component from the rack.
- You should extend only one server or component at a time. Extending two or more simultaneously may cause the rack to become unstable.

System Precautions

- Review the electrical and general safety precautions in "Standardized Warning Statements for AC Systems" on page 218.
- Determine the placement of each component in the rack before you install the rails.
- Install the heaviest server components at the bottom of the rack first and then work your way up.

- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges and voltage spikes and to keep your system operating in case of a power failure.
- Allow any drives and power supply modules to cool before touching them.
- When not servicing, always keep the front door of the rack and all covers/panels on the servers closed to maintain proper cooling.

Rack Mounting Considerations



Warning! Stability hazard. The rack may tip over causing serious personal injury. Before extending the rack to the installation position, read the installation instructions. Do not put any load on the slide-rail mounted equipment in the installation position. Do not leave the slide-rail mounted equipment in the installation position.



Avertissement!
Danger d'instabilité. Le rack peut basculer et provoquer des blessures corporelles graves.
Avant d'étendre le rack en position d'installation, lire les instructions d'installation. Ne pas charger l'équipement monté sur rail de glissière en position d'installation. Ne pas laisser l'équipement monté sur rail de glissière en position d'installation.

Important: To prevent bodily injury when mounting or servicing this unit in a rack, you must take special precautions to ensure that the system remains stable. The following guidelines are provided to ensure your safety:

- If this unit is the only unit in the rack, it should be mounted at the bottom of the rack.
- When mounting this unit in a partially filled rack, load the rack from the bottom to the top, placing the heaviest component at the bottom of the rack.
- If the rack is provided with stabilizing devices, install the stabilizers before mounting or servicing the unit in the rack.
- Slide rail mounted equipment is not to be used as a shelf or a workspace.
- Do not pick up the server with the front handles. They are designed to pull the system from a rack only.

Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the room's ambient temperature. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer's maximum rated ambient temperature (TMRA).

Airflow

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

Reliable Ground

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (i.e. the use of power strips, etc.).

2.3 Ambient Temperature Considerations

The SYS-222C-TN server has been thermally validated for general, ambient operating conditions up to maximum of 35°C, with some restrictions/conditions (see the table below) depending on the components used in the server.

Note:

- All configurations were tested using the onboard M.2 SSD drive supporting booting OS only and not performing any heavy read or write tasks.
- Bay configurations will correspond to the amount of air flow the drives will be blocking from the front.
- Use of lower temperature parts will result in a lower environmental temperature.

Important:
The following restrictions and conditions apply for system configurations:

- GPUs must be installed in Slot 1 and/or Slot 6.
- WoL components should be located in Slot 1 and Slot A1.
- AOCs are permitted only in Slot A2.
- The type of transceiver cable used may impact thermal performance.

Considerations, Conditions, and Restrictions	
24-Drive Bay Configuration	General support up from 15°C-32°C Conditional support up to 30°C Edge case for 40°C support
16-Drive Bay Configuration	General support from 10°C-35°C
GPU-Based Configurations	**Note:** Values can vary based on GPU specifications, amount, and placement. General supported maximum 32°C Conditional restrictions will vary temperature from a maximum of 27°C or 30°C (see restrictions/conditions)
Configurations based on AOC	General support for CPU TDP ≤ 250 W Conditional restrictions of 25°C maximum based on AOC placement
BlueField-3 DPU Configuration	Full support 10°C-35°C (conditions apply)

Considerations, Conditions, and Restrictions	
Memory-Based Configuration	**Note:** Refer to Intel's guidelines for memory specifications related to the CPU. General support from 15°C-32°C
S5 Standby State Condition	Conditional support from 10°C-35°C

2.4 Installing the Rails

There are a variety of rack units on the market, which may require a slightly different assembly procedure. This rail set fits a rack between 26.8" and 36.4" deep. The following is a basic guideline for installing the system into a rack with the rack mounting hardware provided. You should also refer to the installation instructions that came with the specific rack you are using.

Identifying the Rails

The chassis comes with two sets of rack rails, one set for the right side of the chassis and one for the left. Each set consists of an inner rail that is pre-attached to the chassis, an outer rail that attaches to the rack, and a middle rail that slides forward in the outer rail.

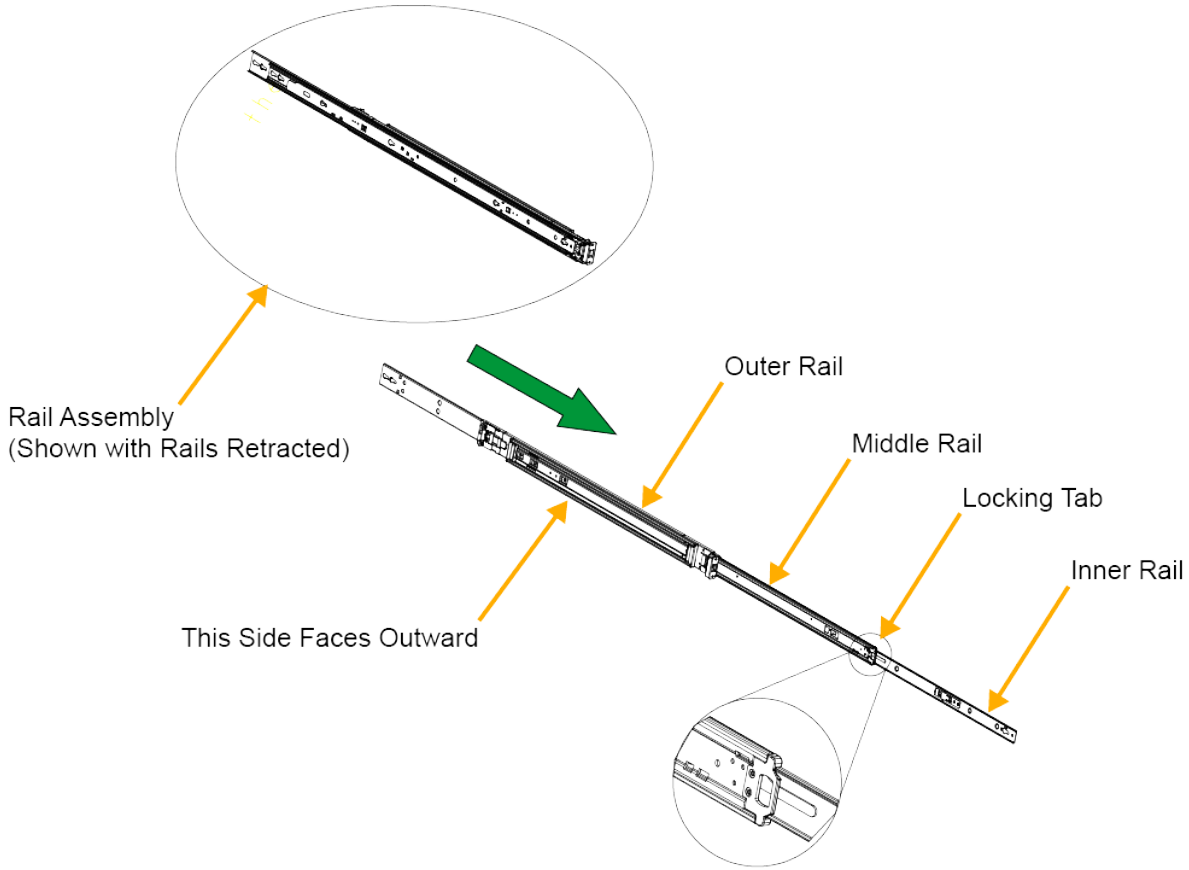


Figure 2-1. Identifying the Sections of the Rack Rails (Figure on Left is Left Rail Assembly Shown)

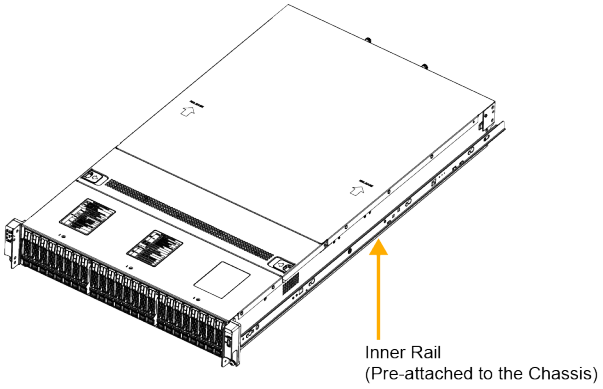


Figure 2-2. Attached Inner Rail

Note: The front chassis rails and the rack rails both have a locking tab. The locking tabs hold the server in place when fully installed and pushed into the rack (its normal operating position). The tabs also lock the server in place when extended from the rack to prevent the server from completely coming out of the rack when pulled out for servicing.

Releasing the Inner Rail

Each inner rail has a locking latch. This latch prevents the server from coming completely out of the rack when the chassis is pulled out for servicing.

To mount the rail onto the chassis, first release the inner rail from the outer rail.

Releasing the Inner Rail from the Outer Rail

1. Lift the auto-lock latch and pull the inner rail until it is fully extended.
2. Release the lever and remove the inner rail out of the middle rail.

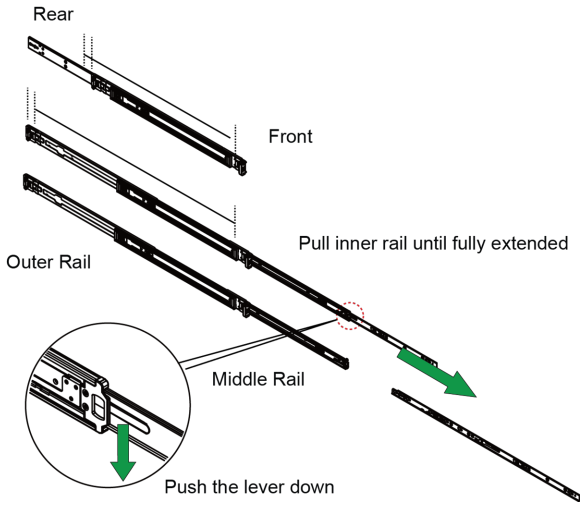


Figure 2-3. Releasing the Inner Rail

Installing the Inner Rails onto the Chassis

1. Identify the left and right inner rails. They are labeled.
2. Place the inner rail firmly against the side of the chassis, aligning the hook on the side of the chassis with the hole in the inner rail.
3. Slide the inner rail forward toward the front of the chassis until the quick release bracket snaps into place, securing the rail to the chassis.
4. Optionally, you can further secure the inner rail to the chassis with a screw.
5. Repeat for the other inner rail.

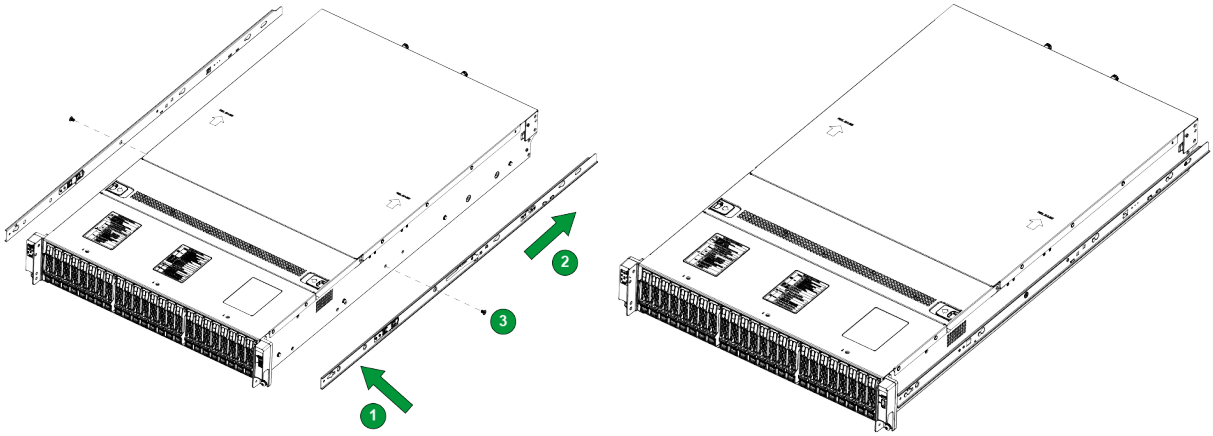


Figure 2-4. Installing the Inner Rails

Installing the Outer Rails onto the Rack

1. Insert the pegs at the rear of the outer rail into the rear rack holes. When the spring clip is clicked, the rail locks to the rack post.
2. Push the middle rail, then pull the lever forward to release the latch. Push the middle rail to close the chassis.
3. Push the pegs into the front rack holes after turning the lock to open.
4. Adjust the latch to the locking position to secure the outer rails to the rack.

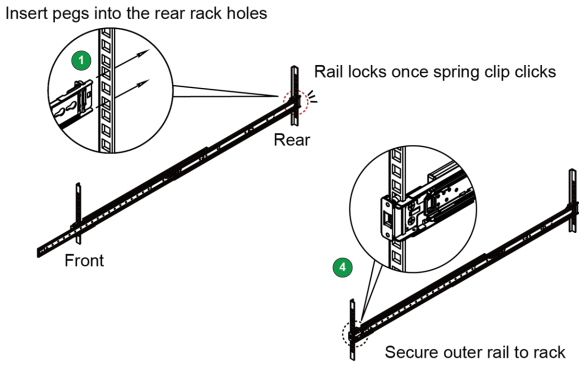


Figure 2-5. Installing Outer Rails onto the Rack

Note: The graphic is for illustrative purposes only. Always install servers to the bottom of a rack first.

2.5 Installing the Chassis into the Rack

Once rails are attached to the chassis and the rack, you can install the server.

1. Pull the middle rail out of the front of the outer rail and make sure that the rail is locked at the front of the middle rail.
2. Align the rear of the chassis rails with the middle rails and then push evenly on both sides of the chassis until it clicks into the fully extended position.
3. Depress the locking tabs on both sides of the chassis and push the it fully into the rack. The locking tabs should "click".
4. Optional screws may be used to hold the front of the chassis to the rack.

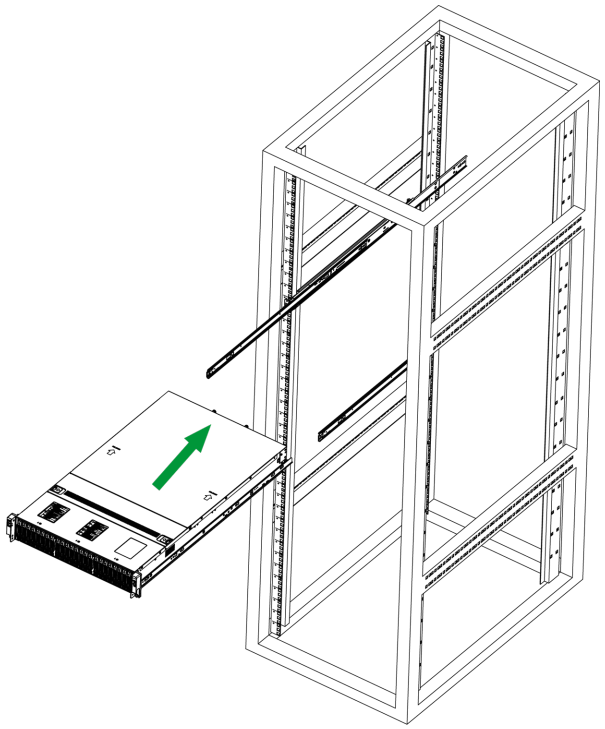


Figure 2-6. Installing the Chassis into a Rack

Removing the Chassis from the Rack

Caution! It is dangerous for a single person to off-load the heavy chassis from the rack without assistance. Be sure to have sufficient assistance supporting the chassis when removing it from the rack. Use a lift.

1. Pull the chassis forward out the front of the rack until it stops.
2. Press the release latches on each of the inner rails downward simultaneously and continue to pull the chassis forward and out of the rack.

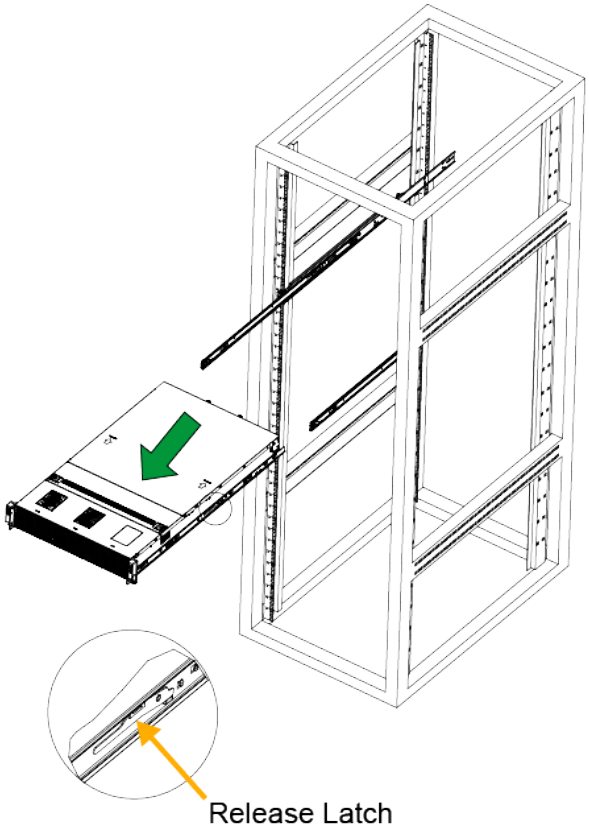


Figure 2-7. Removing the Chassis from a Rack

Chapter 3:

Maintenance and Component Installation

This chapter provides instructions on installing and replacing main system components for the SYS-222C-TN server. To prevent compatibility issues, only use components that match the specifications and/or part numbers given.

Installation or replacement of most components require that power first be removed from the system. Follow the procedures given in each section.

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3.1 Removing Power

Before performing some setup or maintenance tasks, use the following procedure to ensure that power has been removed from the SYS-222C-TN server. This step is necessary when removing or installing non hot-swap components or when replacing a non-redundant power supply.

1. Use the operating system to power down the system.
2. After the system has completely shut-down, disconnect the AC power cord(s) from the power strip or outlet.
3. Disconnect the power cord(s) from the power supply module(s).

3.2 Accessing the System

The system features a fan cover that can be flipped open. The entire top cover is removable, which allows access to the inside of the system.

Important: Except for short periods of time, do not operate the server without the cover in place. The chassis cover must be in place to allow for proper airflow and to prevent overheating.

Opening the Fan Cover

1. Press the two release buttons on the fan cover.
2. Flip the fan cover open.

Removing the Entire Top Cover

1. Remove the two thumbscrews on the rear side of the chassis.
2. Press the two release buttons and slide the cover towards the rear.
3. Lift the top cover up.

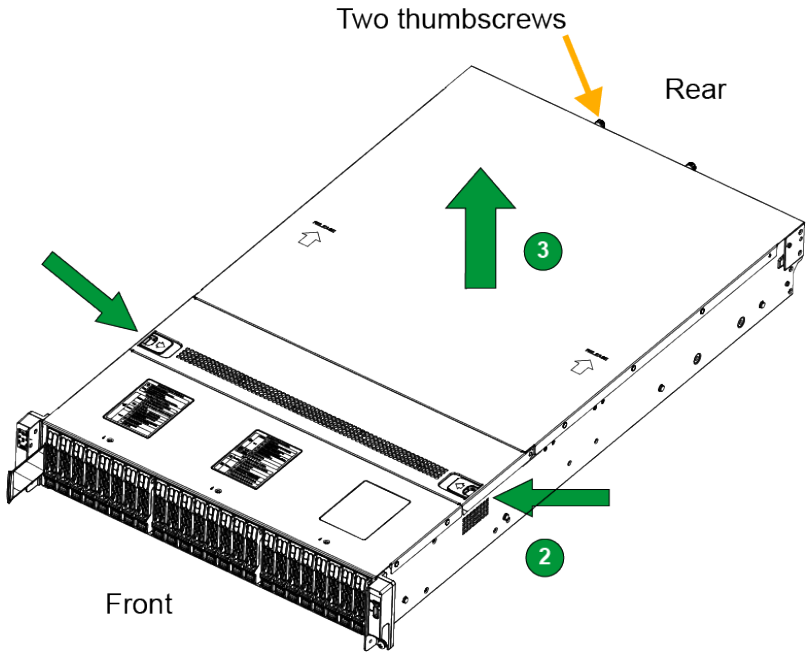


Figure 3-1. Removing the Entire Top Cover

Note: Check that all ventilation openings on the top cover and the top of the system are clear and unobstructed.

3.3 Static-Sensitive Devices

Electrostatic Discharge (ESD) can damage electronic components. To avoid damaging your motherboard, it is important to handle it very carefully. The following measures are generally sufficient to protect your equipment from ESD.

Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Touch a grounded metal object before removing the board from the antistatic bag.
- Handle the motherboard only by its edges. Do not touch its components, peripheral chips, memory modules, or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the motherboard and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure that your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners, and the motherboard.
- Use only the correct type of onboard CMOS battery. To avoid possible explosion, do not install the onboard battery upside down.

3.4 Processor and Heatsink Installation

This section provides procedures to install the processor(s) and heatsink(s).

Notes:

- Take industry standard precautions to avoid ESD damage. For details, see "Static-Sensitive Devices" on the previous page.
- Before starting, make sure that the plastic socket cap is in place and none of the socket pins are bent. If any damage is noted, contact your retailer.
- Do not connect the system power cord before the processor and heatsink installation is complete.
- When handling the processor, avoid touching or placing direct pressure on the LGA lands (gold contacts). Improper installation or socket misalignment can cause serious damage to the processor or processor socket.
- When buying a processor separately, use only a Supermicro certified heatsink.
- Refer to the Supermicro website for the most recent processor support.
- When installing the heatsink, ensure a torque driver set to the correct force is used for each screw.
- Thermal grease is pre-applied on a new heatsink. No additional thermal grease is needed.

LGA 4710 Socket E2 Processors

Processor Top View

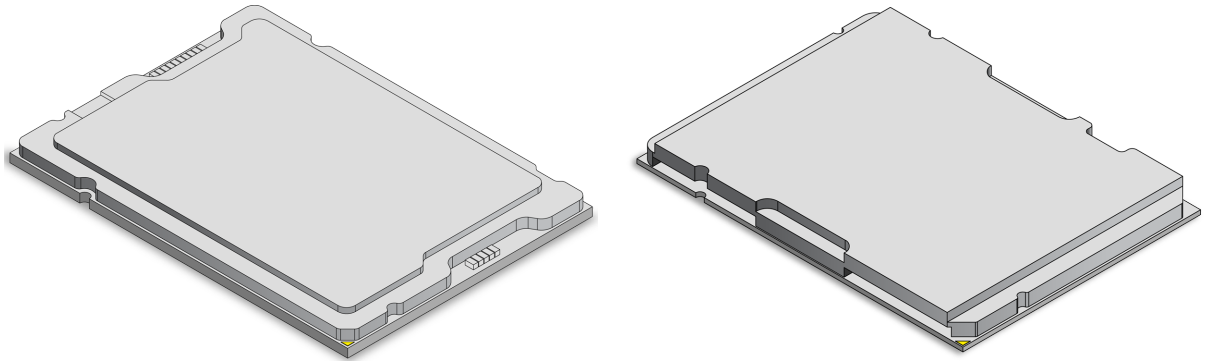


Figure 3-2. Processor (SP XCC left, SP HCC/LCC right)

Note: The motherboard supports three processor SKUs: SP XCC, SP HCC, and SP LCC. Each SKU supports a specific carrier; the SP XCC processor supports Carrier E2A while SP HCC and SP LCC support Carrier E2B. Make sure the processors of the same SKU are on the motherboard.

Overview of the Processor Socket

The processor socket is protected by a plastic protective cover.

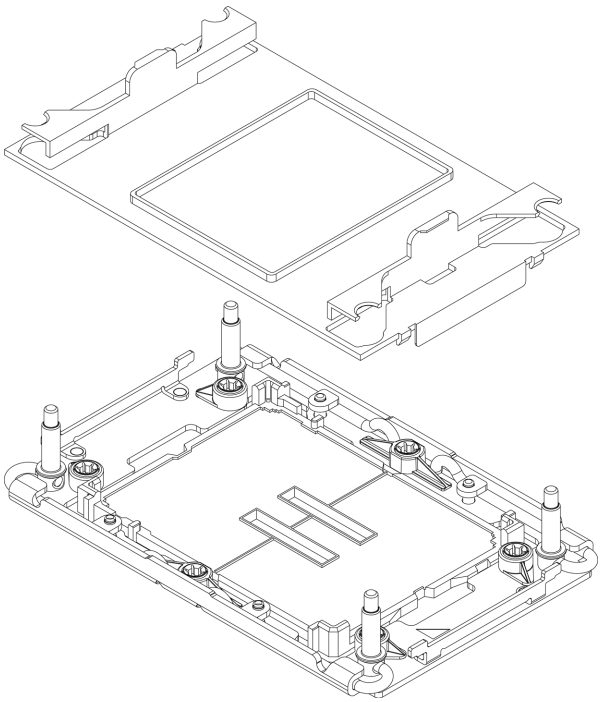


Figure 3-3. Plastic Protective Cover and Processor Socket

Overview of the Processor Carrier

The motherboard supports two types of processors and their associated processor carrier.

Processor Carriers

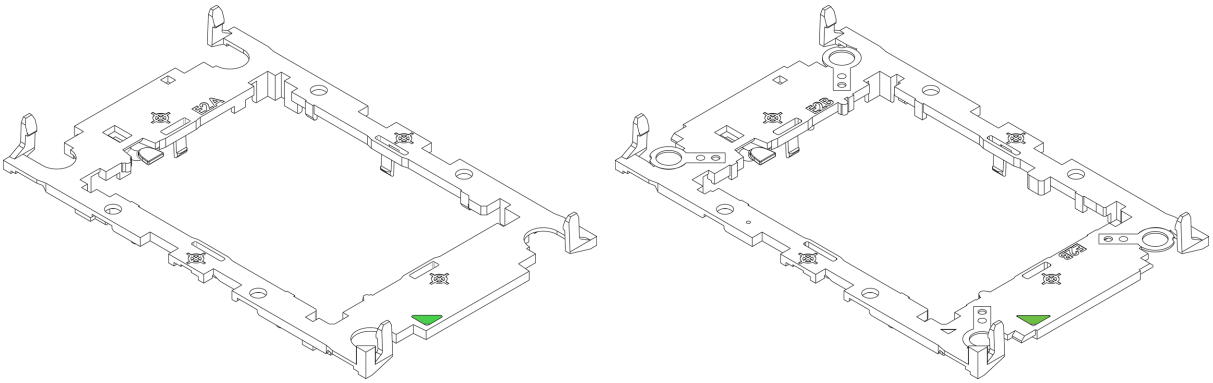


Figure 3-4. Carrier (SP XCC E2A left, SP HCC/LCC E2B right)

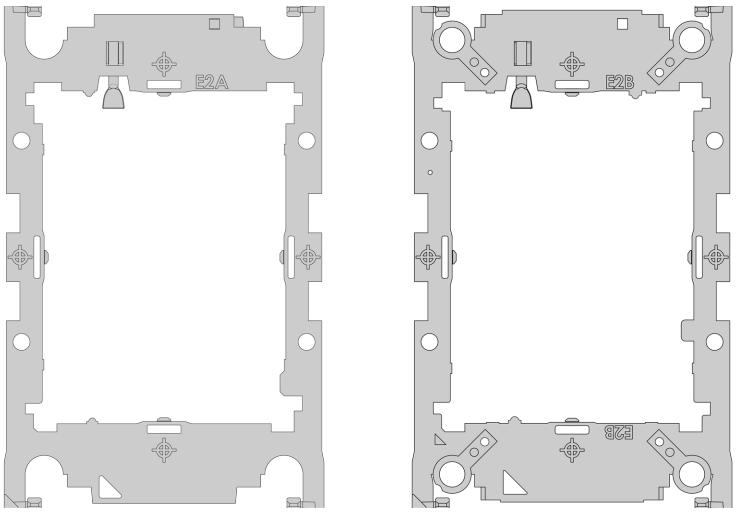


Figure 3-5. Carrier Top View (SP XCC E2A left, SP HCC/LCC E2B right)

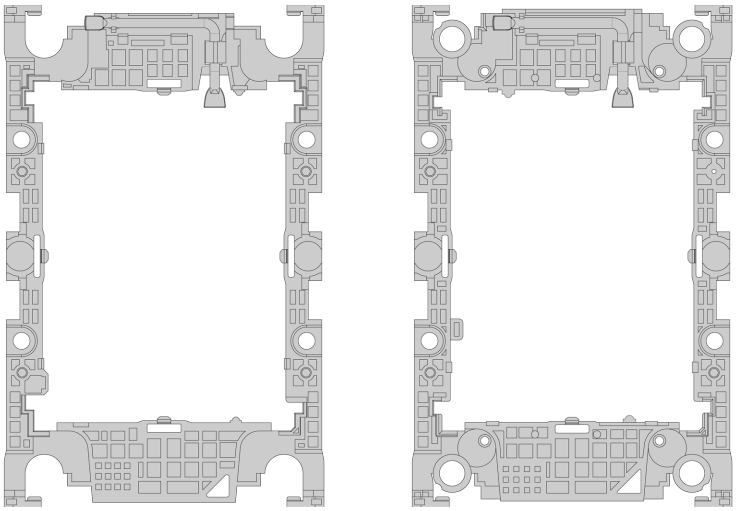


Figure 3-6. Carrier Bottom View (SP XCC E2A left, SP HCC/LCC E2B right)

Overview of the Processor Heatsink Module

The Processor Heatsink Module (PHM) contains a heatsink, a processor carrier, and the processor.

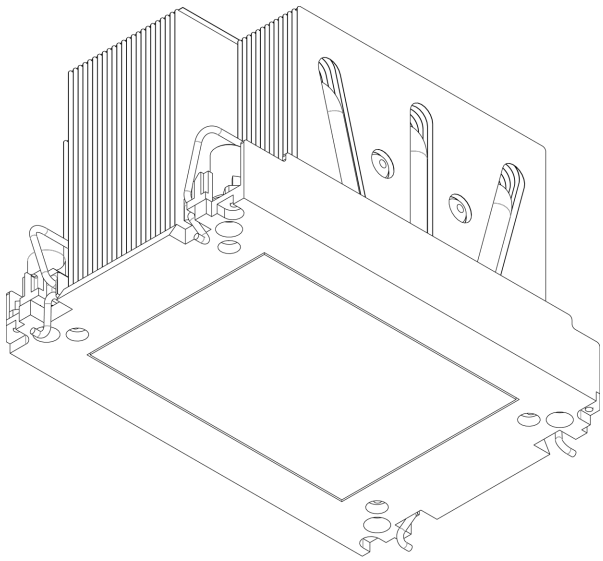


Figure 3-7. Heatsink (2U)

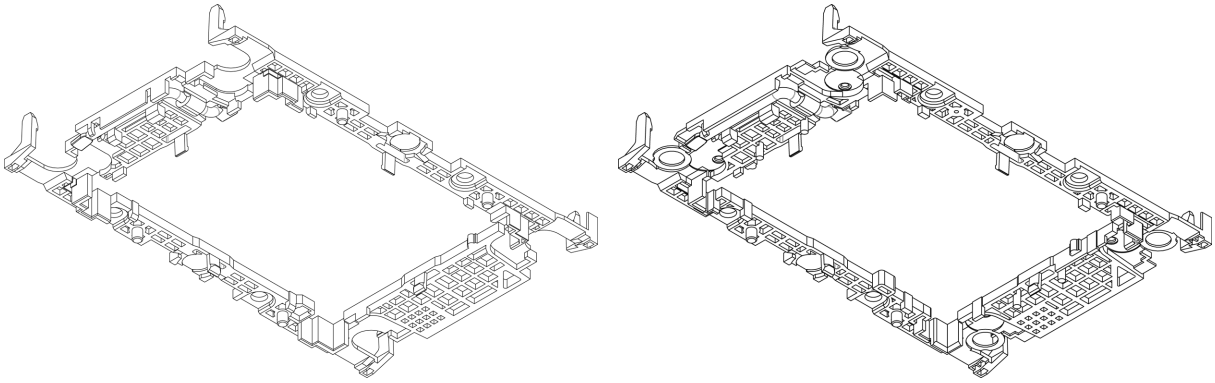


Figure 3-8. Carrier (SP XCC E2A left, SP HCC/LCC E2B right)

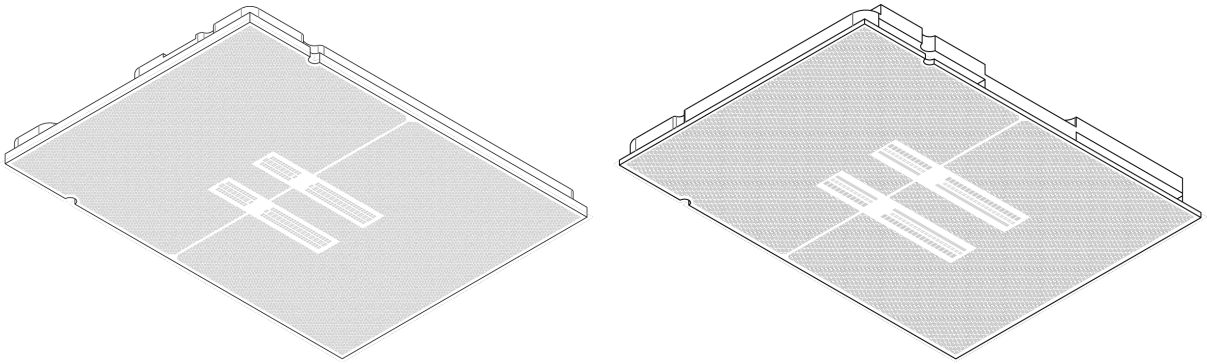


Figure 3-9. Processor (SP XCC E2A left, SP HCC/LCC E2B right)

Installing the Processor

To install the processor, follow the steps below:

1. Before installation, make sure the lever on the processor carrier is pressed down as shown below.

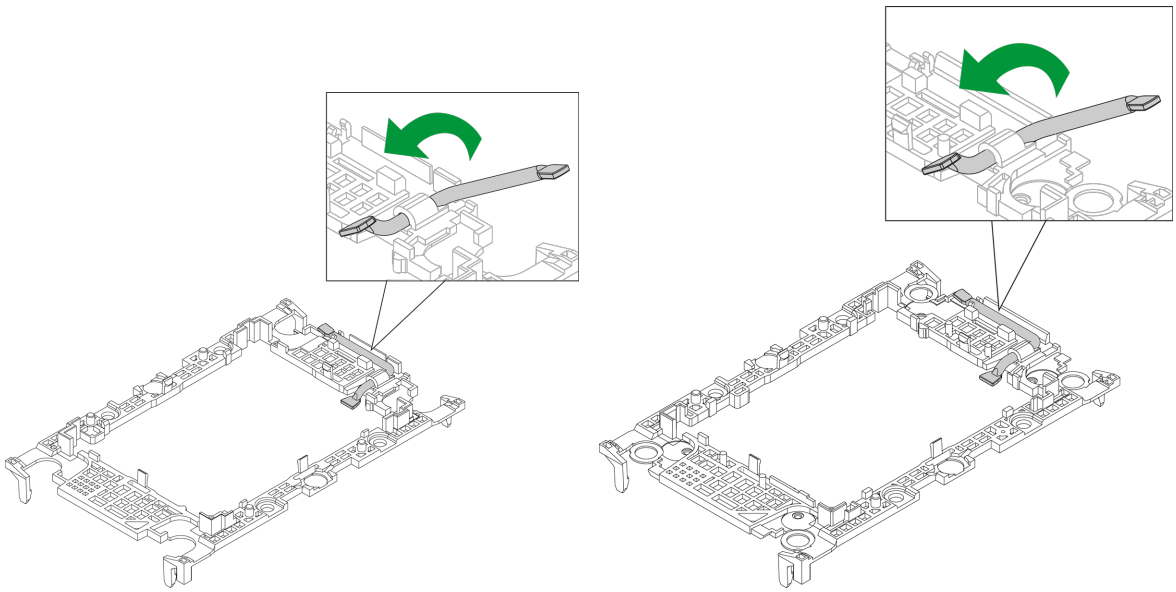


Figure 3-10. Carrier Lever (SP XCC left, SP HCC/LCC right)

2. Hold the processor with the LGA lands (gold contacts) facing up. Locate the small, gold triangle in the corner of the processor and the corresponding hollowed triangle on the processor carrier. These triangles indicate pin 1.

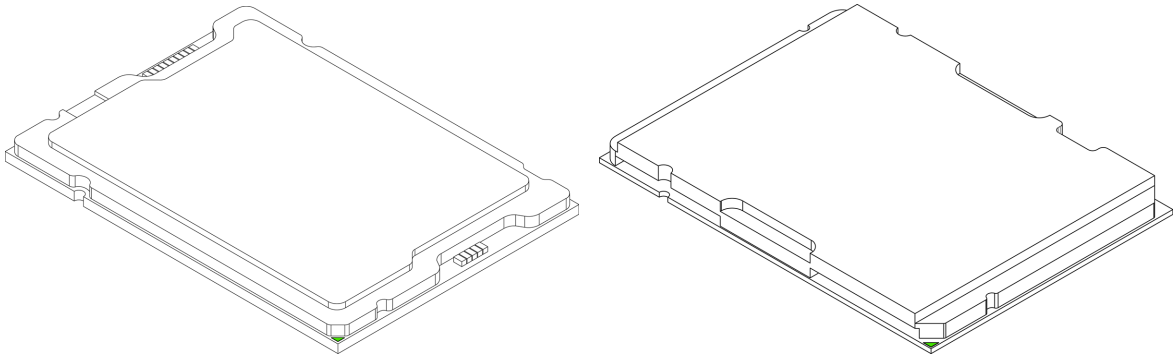


Figure 3-11. Processor (SP XCC E2A left, SP HCC/LCC E2B right)

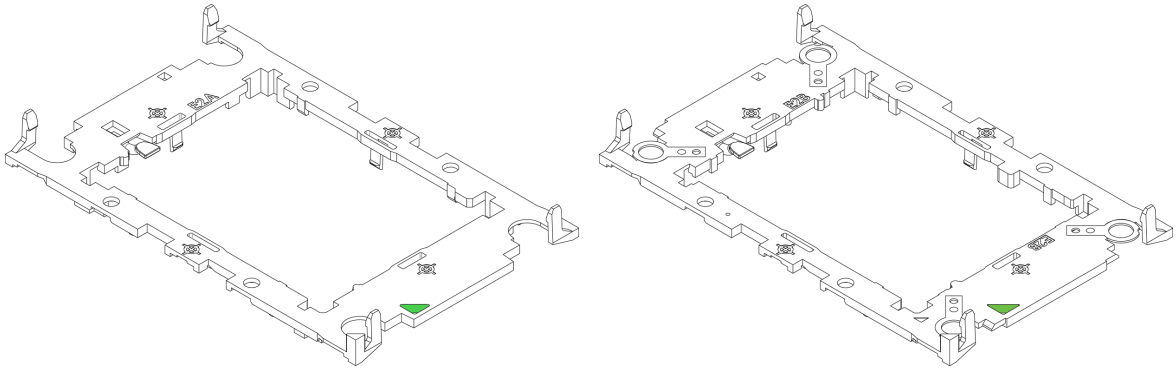


Figure 3-12. Carrier (SP XCC E2A left, SP HCC/LCC E2B right)

3. Use the triangles as a guide to carefully align and place one end of the processor into the latch marked A, and place the other end of the processor into the latch marked B as shown below.

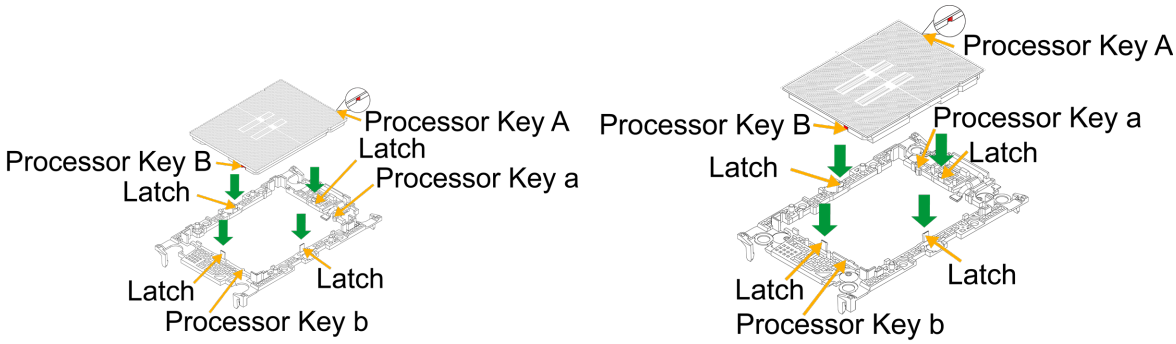


Figure 3-13. Keys and Latches Locations (SP XCC E2A left, SP HCC/LCC E2B right)

4. Examine all corners to ensure that the processor is firmly attached to the carrier.

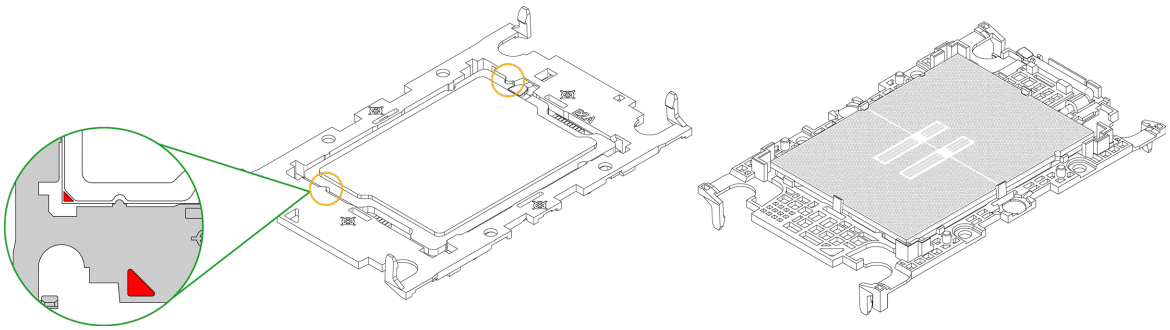


Figure 3-14. SP XCC E2A Keys and Latches

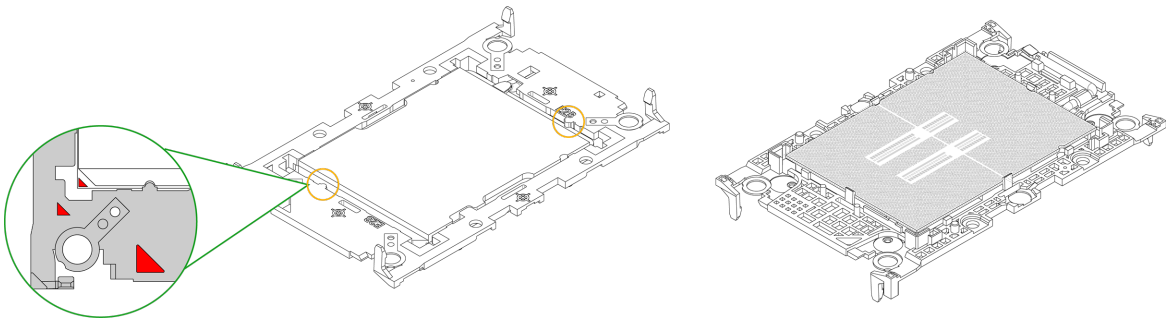


Figure 3-15. SP HCC/LCC E2B Keys and Latches Together

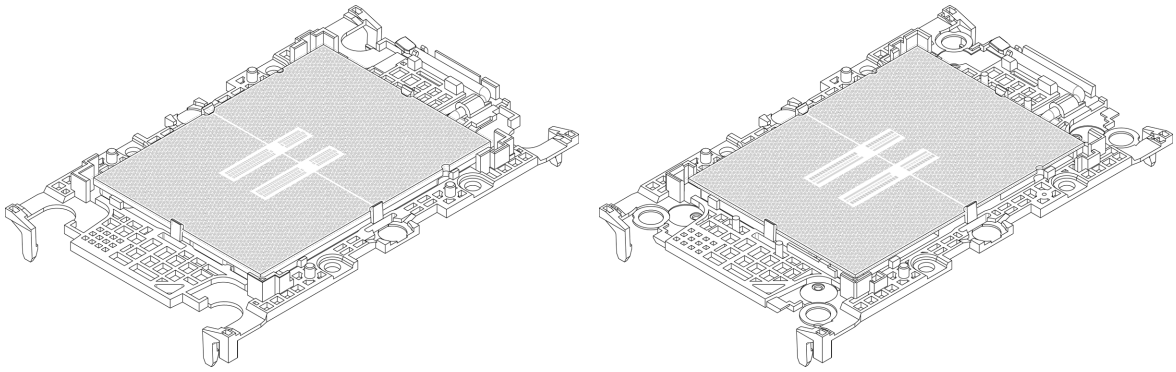


Figure 3-16. Carrier Assembly Completed (SP XCC E2A left, SP HCC/LCC E2B right)

Assembling the Processor Heatsink Module

After installing the processor into the carrier, mount it onto the heatsink to create the processor heatsink module (PHM):

1. Note the label on top of the heatsink, which marks the airflow direction. Turn the heatsink over and orient the heatsink so the airflow arrow is pointing towards the triangle on the processor.

2. If this is a new heatsink, the thermal grease has been pre-applied. Otherwise, apply the proper amount of thermal grease.
3. Hold the processor carrier so the processor's gold contacts are facing up, then align the holes of the processor carrier with the holes on the heatsink. Press the processor carrier down until it snaps into place. The plastic clips of the processor carrier will lock at the four corners.

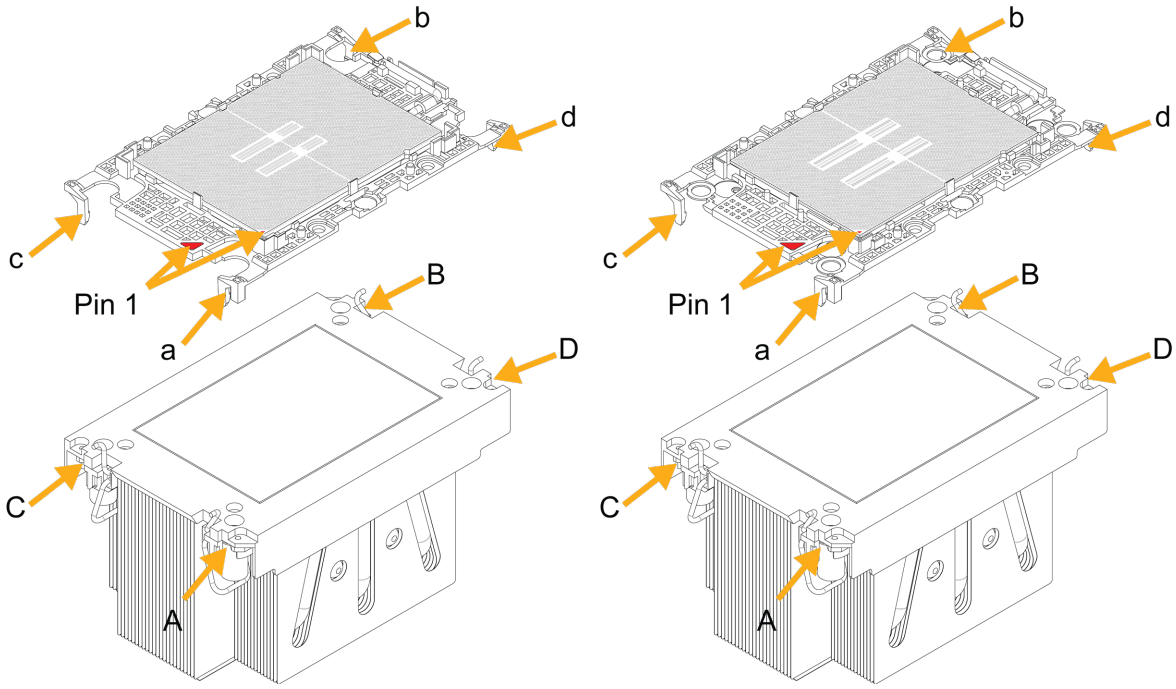


Figure 3-17. Carrier with 2U Heatsink (SP XCC left, SP HCC/LCC right)

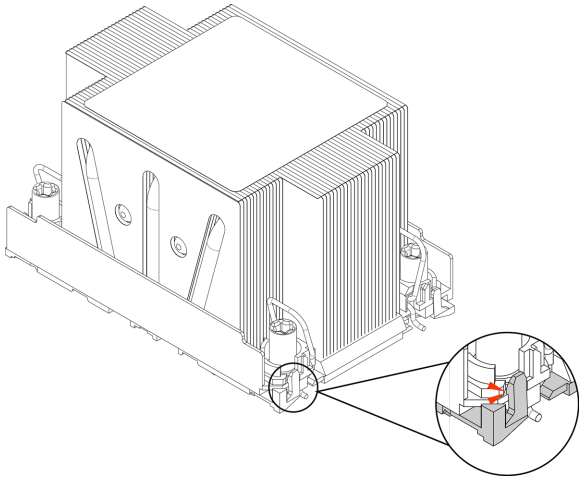


Figure 3-18. PHM Plastic Clips Locked (2U)

4. Examine all corners to ensure that the plastic clips on the processor carrier are firmly attached to the heatsink.

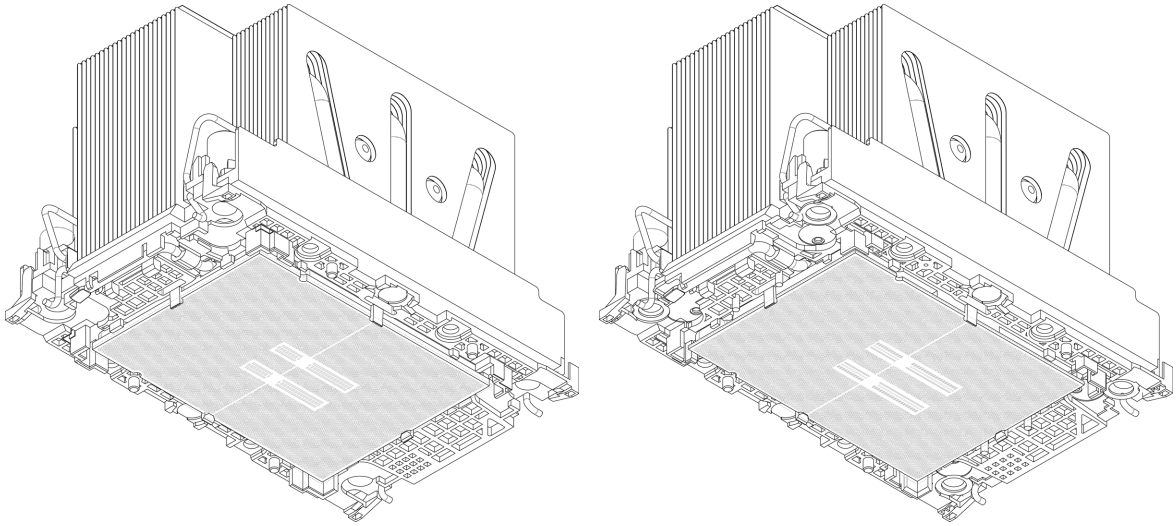
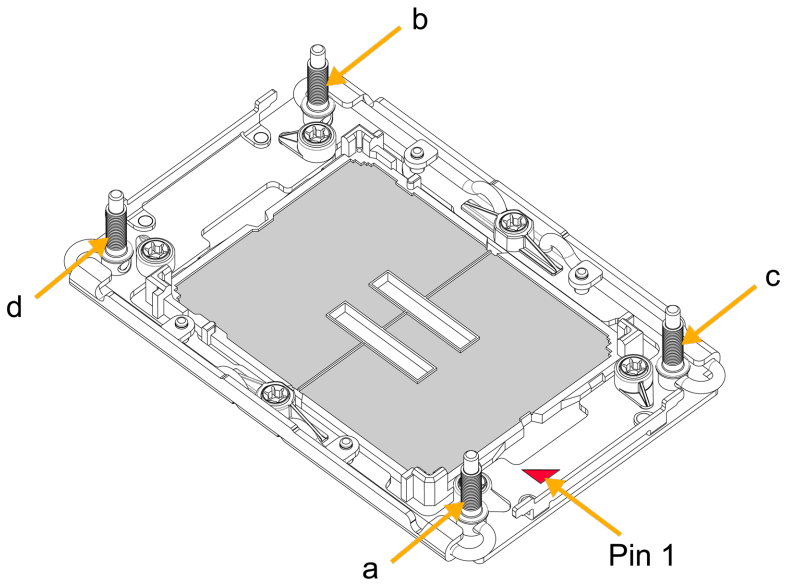


Figure 3-19. 2U PHM Completed (SP XCC left, SP HCC/LCC right)

Preparing to Install the PHM into the Processor Socket

After assembling the Processor Heatsink Module (PHM), you are ready to install it into the processor socket. To ensure the proper installation, follow the procedures below:

1. Locate four threaded fasteners (marked a, b, c, and d) on the processor socket.



a, b, c, d: Threaded Fasteners

Figure 3-20. Threaded Fasteners

2. Locate four PEEK nuts (marked A, B, C, and D) and four rotating wires (marked 1, 2, 3, and 4) on the heatsink.

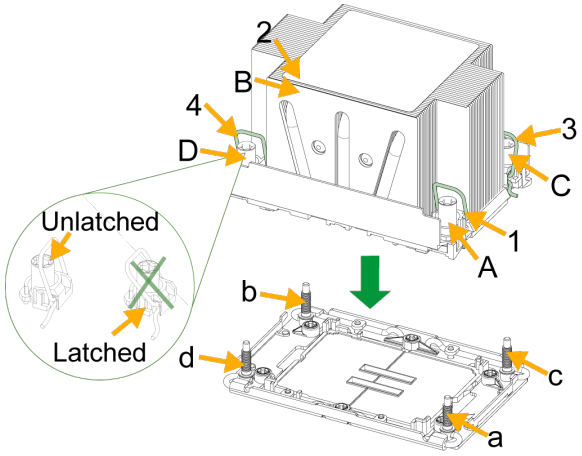


Figure 3-21. PEEK Nuts and Rotating Wires (2U)

3. Check the rotating wires (marked 1, 2, 3, and 4) to make sure that they are at unlatched positions before installing the PHM into the processor socket.

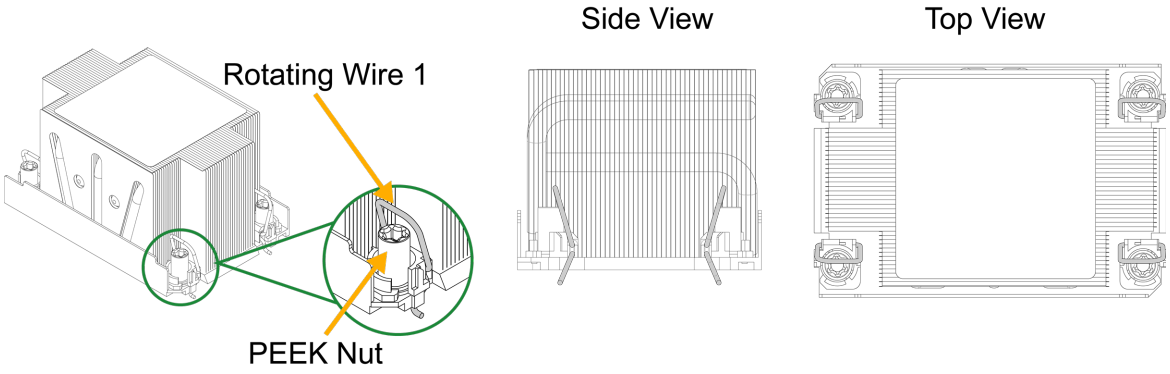


Figure 3-22. 2U Unlatched Positions

Preparing the Processor Socket for Installation

This motherboard comes with a plastic protective cover installed on the processor socket. Remove it from the socket to install the Processor Heatsink Module (PHM). Gently pull up one corner of the plastic protective cover to remove it.

1. Press the tabs inward.

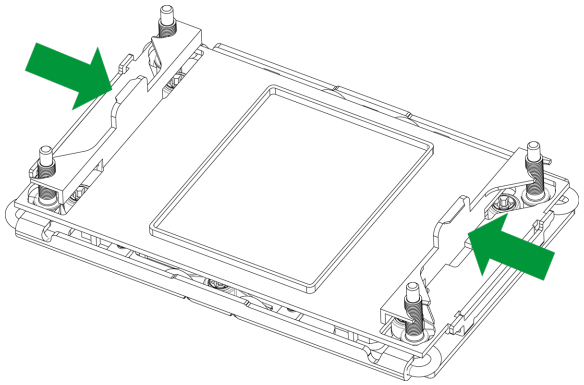


Figure 3-23. Processor Socket with Plastic Protective Cover

2. Pull up the protective cover from the socket.

   Note: Do not touch or bend the socket pins.

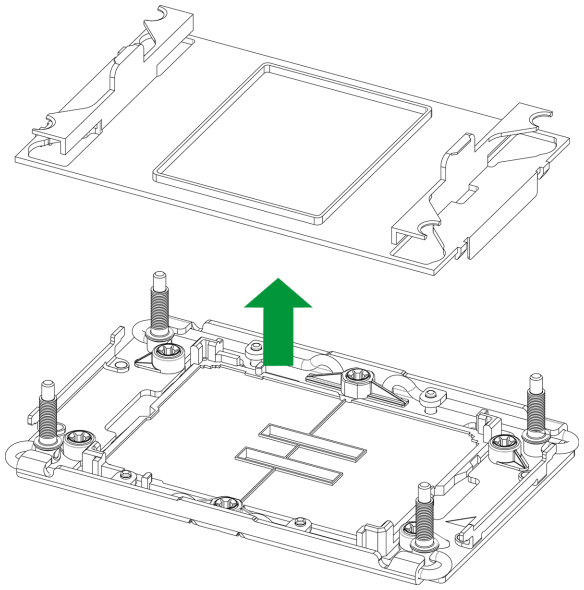


Figure 3-24. Plastic Protective Cover Removed

Installing the Processor Heatsink Module

1. Align pin 1 of the PHM with the printed triangle on the processor socket.
2. Make sure all four PEEK nuts of the heatsink (marked A, B, C, and D) are aligned with the threaded fasteners (marked a, b, c, and d), then gently place the heatsink on top of the processor socket.

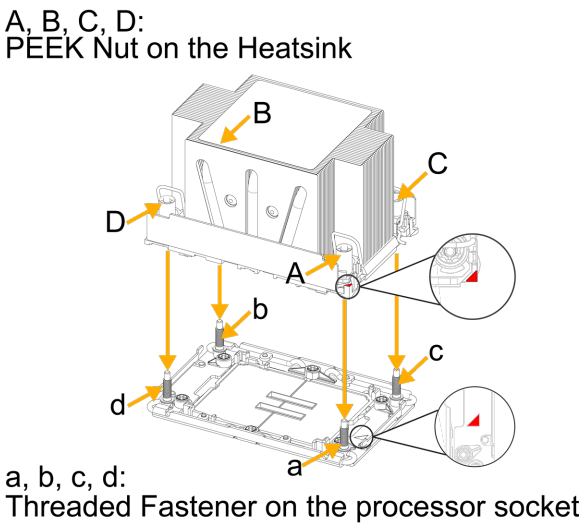


Figure 3-25. Aligning the Heatsink with the Socket (2U)

3. Press all four rotating wires outwards and make sure that the heatsink is securely latched into the processor socket.

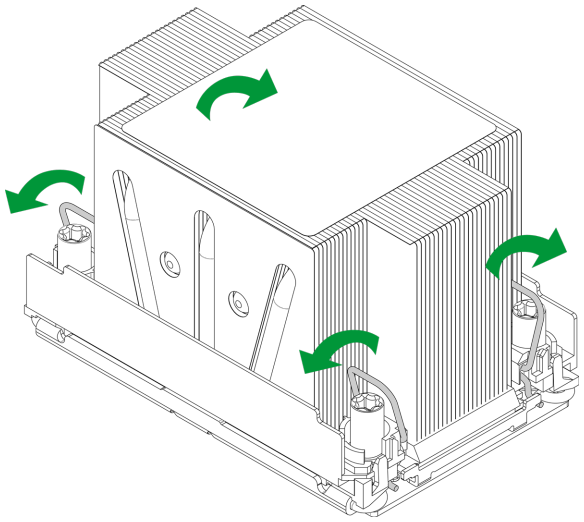


Figure 3-26. Latching the PHM (2U)

4. With a T30 bit torque driver set to a force of 8.0 lbf-in (0.904 N-m), gradually tighten the four screws to ensure even pressure. You can start with any screw, but make sure to tighten the screws in a diagonal pattern.

Important: Do not use a force greater than 8.0 lbf-in (0.904 N-m). Exceeding this force may over-torque the screw, causing damage to the processor, heatsink, and screw.

5. Examine all corners to ensure that the PHM is firmly attached to the socket.

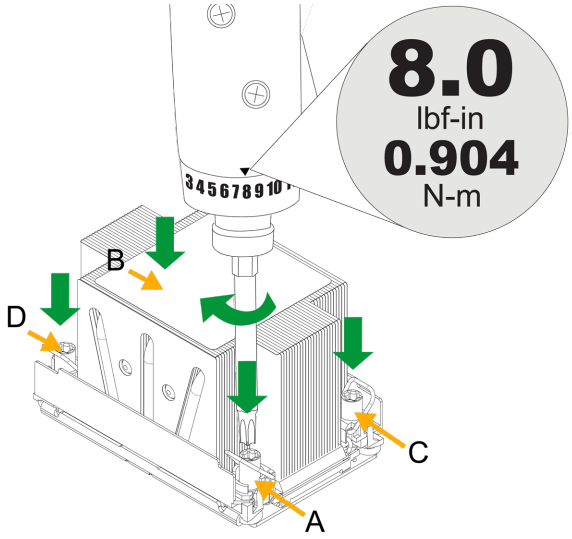


Figure 3-27. Installing the PHM with a Torque Driver (2U)

Removing the Processor Heatsink Module

Before removing the processor heatsink module (PHM) from the motherboard, shut down the system and then unplug the AC power cord from all power supplies.

Then follow the steps below:

1. Use a screwdriver to loosen the four screws. You can start with any screw, but make sure to loosen the screws in a diagonal pattern.

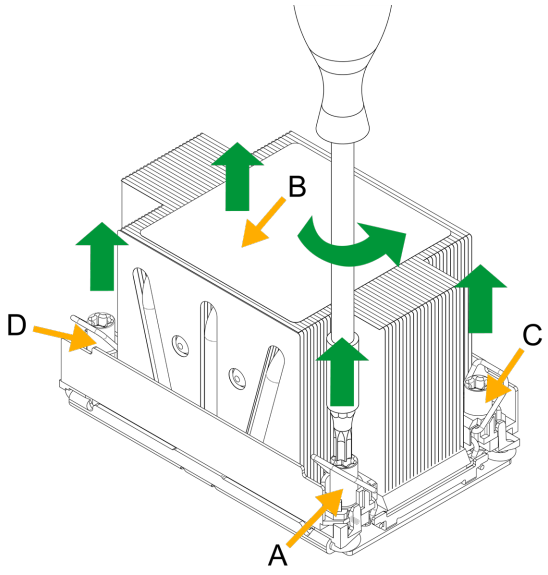


Figure 3-28. Loosening the Screws (2U)

2. Press the four rotating wires inwards to unlatch the PHM from the socket.

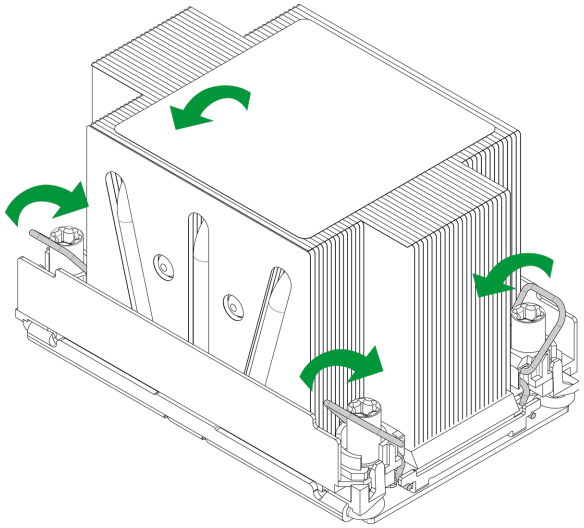


Figure 3-29. Unlatching the PHM (2U)

3. Gently lift the PHM upwards to remove it from the socket.

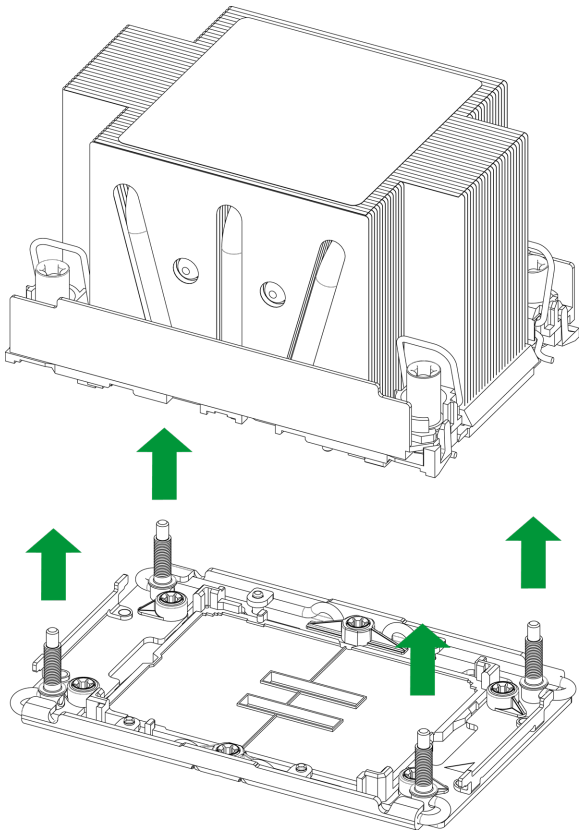


Figure 3-30. Removing the PHM from the Socket (2U)

4. To remove the processor from the heatsink, gently lift the lever from the processor carrier.

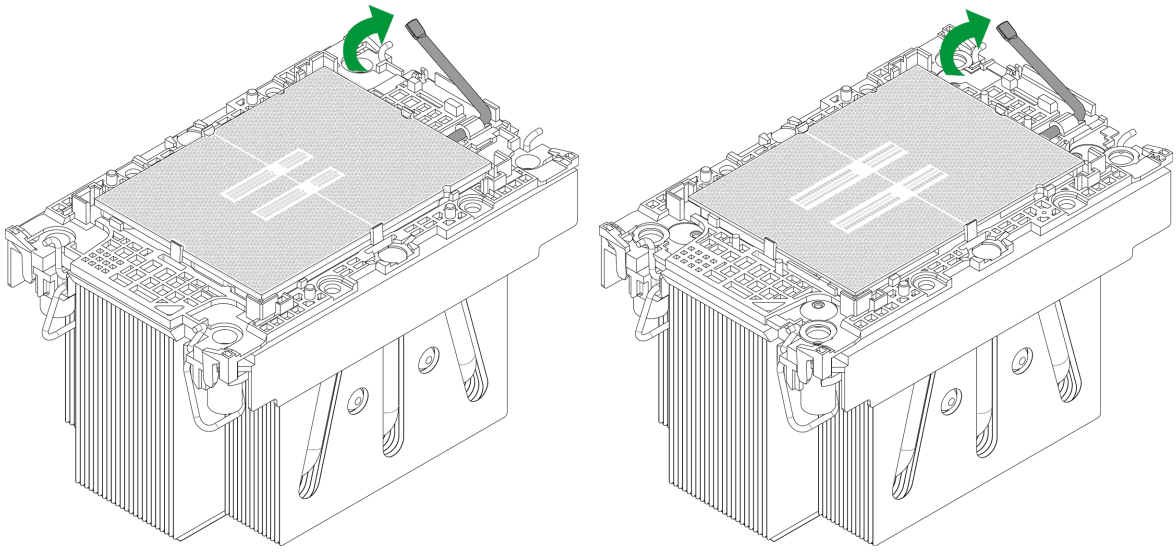


Figure 3-31. Carrier with 2U Heatsink (SP XCC left, SP HCC/LCC right)

5. To remove the processor, move the lever to its unlocked position and gently remove the processor.

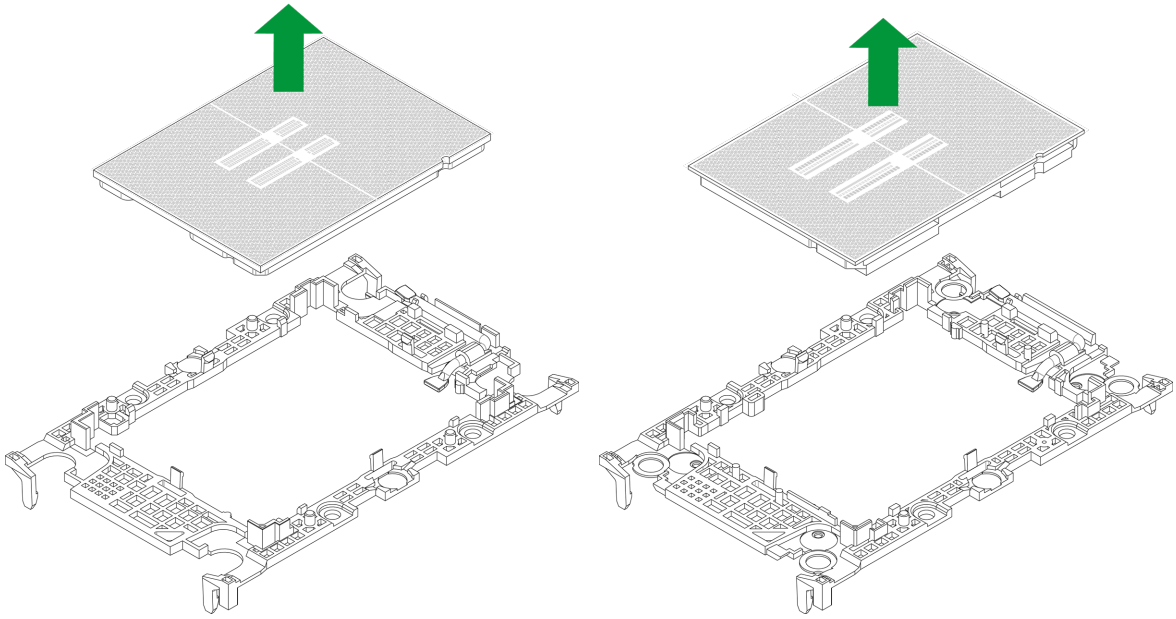


Figure 3-32. Removing the Processor (SP XCC left, SP HCC/LCC right)

3.5 Memory Support and Installation

Important: To prevent any damage, exercise extreme care when installing or removing memory modules.

Note: Check the Supermicro website for recommended memory modules.

Memory Support

The X14DBHM motherboard supports up to 4 TB of ECC DDR5 RDIMM/RDIMM 3DS memory with speeds of up to 6400 MT/s (1DPC) or up to 5200 MT/s (2DPC) in 32 DIMM slots. In addition, MRDIMM DDR5 memory with speeds up to 8000 MT/s (1DPC or 2 slots per channel) is also supported.

To enhance memory performance and ensure system stability, do not mix memory modules of different speeds, different sizes, or different types in your server.

Note: Memory speed/capacity support depends on the processors used in the system.

The Intel Xeon 6700-Series Processors with E-Cores

DDR5-6400 Memory Support for Intel® Xeon® 6700-Series Processors with E-Cores

Type	Ranks Per DIMM, Data Width (Stack)	DIMM Capacity (GB) / DRAM Density						Speed (MT/s); Voltage (V); Slots per Channel (SPC) and DIMMs per Channel (DPC)	
		16 Gb		24 Gb		32 Gb		1DPC/2SPC	2DPC/2SPC
		1DPC	2DPC	1DPC	2DPC	1DPC	2DPC	+1.1 V	
RDIMM	1Rx4	32 GB	-	-	-	-	-	6400, 6000, 5600, 5200, 4800 (DDR5-6400 rated RDIMMs only)	N/A
	2Rx8	32 GB	-	-	-	-	-		N/A
	2Rx4	64 GB	64 GB	96 GB	96 GB	-	-		5200, 4800 (DDR5-6400 rated RDIMMs only)
	2Rx4	-	-	-	-	128 GB	128 GB		
3DS RDIMM	4Rx4					256 GB	256 GB		

CXL Memory Configuration Support for Intel® Xeon® 6700-Series Processors with E-Cores								
Native DDR5 Memory Per Socket				CXL Memory Per Socket				
Slot 0 DIMM Ranks	Slot 0 DIMM Capacity (GB)	DIMM Type	DRAM Density (Gb)	CXL Memory Channels	CXL Memory Type	CXL Capacity Per Device/ Module	CXL Interleave	CXL Mode
2Rx4	64	10x4	16	2+2	DDR5 x8	64 GB	1x4*, 2x2, 4x1	1LM+Vol
2Rx4	64	10x4	16	1+1	DDR5 x16	128 GB	1x2*, 2x1	1LM+Vol
1Rx4	32	10x4	16	2	DDR5 x8	128 GB	1x2*	Intel Flat Memory Mode

Notes:

- The items with an asterisk (*) are the default settings in the BIOS.
- The Intel® Xeon® 6700-series processors with E-cores CXL memory configurations are 1DPC ('Slot 0') only for native DDR5.
- CXL Memory Channel: number of devices per root port, with root ports separated by "+," e.g. 2+2+2+2 = four root ports populated with two devices per root port.
- CXL Interleave: sets x ways, e.g. 2x4 = One set of two modules, interleaved four-way.
- CXL Modes:
  - 1LM + Vol = DDR5 ('1LM') and (volatile) CXL memory visible to SW as separate tiers, separately interleaved.
  - Flat Memory Mode = HW manages data movement between DDR5 and CXL memory, total capacity visible to SW.

Intel® Xeon® 6700-Series Processors with E-Cores DDR5 Memory Population Table (2 Processors and 32 DIMMs Installed, 1DPC)	
1 Processor DIMM Count	***Memory Population Sequence (1DPC)***
1 Processor and 1 DIMM	P1-DIMMA1
1 Processor and 4 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P1-DIMMB1/P1-DIMMD1/P1-DIMMH1/P1-DIMMF1

Intel® Xeon® 6700-Series Processors with E-Cores DDR5 Memory Population Table (2 Processors and 32 DIMMs Installed, 1DPC)	
1 Processor and 8 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1
2 Processor DIMM Count (Recommended)	***Memory Population Sequence (1DPC)***
2 Processors and 8 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P2-DIMMA1/P2-DIMMC1/P2-DIMME1/P2-DIMMG1
2 Processors and 8 DIMMs	P1-DIMMB1/P1-DIMMD1/P1-DIMMF1/P1-DIMMH1 P2-DIMMB1/P2-DIMMD1/P2-DIMMF1/P2-DIMMH1
2 Processors and 16 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1 P2-DIMMA1/P2-DIMMB1/P2-DIMMC1/P2-DIMMD1/P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1

Intel® Xeon® 6700-Series Processors with E-Cores DDR5 Memory Population Table (2 Processors and 32 DIMMs Installed, 2DPC)	
1 Processor DIMM Count	***Memory Population Sequence (2DPC)***
1 Processor and 1 DIMM	P1-DIMMA1
1 Processor and 4 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P1-DIMMB1/P1-DIMMD1/P1-DIMMF1/P1-DIMMH1
1 Processor and 8 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1 P1-DIMMA1/P1-DIMMA2/P1-DIMMC1/P1-DIMMC2/P1-DIMME1/P1-DIMME2/P1-DIMMG1/P1-DIMMG2 P1-DIMMB1/P1-DIMMB2/P1-DIMMD1/P1-DIMMD2/P1-DIMMF1/P1-DIMMF2/P1-DIMMH1/P1-DIMMH2
1 Processor and 12 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1

Intel® Xeon® 6700-Series Processors with E-Cores DDR5 Memory Population Table (2 Processors and 32 DIMMs Installed, 2DPC)	
1 Processor and 16 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMB2/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMMD2/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMF2/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1/P1-DIMMH2
2 Processor DIMM Count (Recommended)	***Memory Population Sequence (2DPC)***
2 Processors and 2 DIMMs	P1-DIMMA1 P2-DIMMA1
2 Processors and 8 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P2-DIMMA1/P2-DIMMC1/P2-DIMME1/P2-DIMMG1
2 Processors and 8 DIMMs	P1-DIMMB1/P1-DIMMD1/P1-DIMMF1/P1-DIMMH1 P2-DIMMB1/P2-DIMMD1/P2-DIMMF1/P2-DIMMH1
2 Processors and 16 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMC1/P1-DIMMC2/P1-DIMME1/P1-DIMME2/P1-DIMMG1/P1-DIMMG2 P2-DIMMA1/P2-DIMMA2/P2-DIMMC1/P2-DIMMC2/P2-DIMME1/P2-DIMME2/P2-DIMMG1/P2-DIMMG2
2 Processors and 16 DIMMs	P1-DIMMB1/P1-DIMMB2/P1-DIMMD1/P1-DIMMD2/P1-DIMMF1/P1-DIMMF2/P1-DIMMH1/P1-DIMMH2 P2-DIMMB1/P2-DIMMB2/P2-DIMMD1/P2-DIMMD2/P2-DIMMF1/P2-DIMMF2/P2-DIMMH1/P2-DIMMH2
2 Processors and 16 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1 P2-DIMMA1/P2-DIMMB1/P2-DIMMC1/P2-DIMMD1/P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1
2 Processors and 32 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMB2/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMMD2/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMF2/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1/P1-DIMMH2 P2-DIMMA1/P2-DIMMA2/P2-DIMMB1/P2-DIMMB2/P2-DIMMC1/P2-DIMMC2/P2-DIMMD1/P2-DIMMD2/P2-DIMME1/P2-DIMME2/P2-DIMMF1/P2-DIMMF2/P2-DIMMG1/P2-DIMMG2/P2-DIMMH1/P2-DIMMH2

Notes:

- The memory configurations with an asterisk (*) are recommended by Supermicro for optimal memory performance.
- DIMMs must be all DDR5-6400 rated RDIMMs.
- All DIMMs in a channel must have the same number of ranks (unless explicitly specified otherwise).
- x8 DIMMs and x4 DIMMs cannot be mixed in the same channel or same processor socket (see the memory support table above).
- Rank mixing is not allowed.
- Vendor mixing is not allowed.

The Intel Xeon 6700/6500-Series Processors with P-Cores

DDR5-6400 Memory Support for Intel® Xeon® 6700/6500-Series Processors with P-Cores								
Type	Ranks Per DIMM, Data Width (Stack)	DIMM Capacity (GB)					Speed (MT/s); Voltage (V); Slots per Channel (SPC) and DIMMs per Channel (DPC)	
		DRAM Density						
		16 Gb		24 Gb		32 Gb	1DPC/2SPC	2DPC/2SPC
		1DPC	2DPC	1DPC	2DPC	2DPC	+1.1 V	
RDIMM	1Rx8	16 GB	-	24 GB	-	-	6400, 6000, 5600, 5200, 4800 (DDR5-6400 rated RDIMMs only)	5200, 4800 (DDR5-6400 rated RDIMMs only)
	1Rx4	32 GB	-	48 GB	-	-		
	2Rx8	32 GB	32 GB	48 GB	-	-		
	2Rx4	64 GB	64 GB*	96 GB	96 GB*	128 GB*		
3DS RDIMM	4Rx4	-	128 GB	-	-	-		
	8Rx4	-	256 GB	-	-	-		
MRDIMM	2Rx8	32 GB	-	-	-	-	8000, 7200 (MRDIMM-8800 only)	N/A
	2Rx4	64 GB	-	-	-	-		N/A

Note: The items marked with an asterisk (*) are supported in 1S/2S/4S/8S systems. All others support 1S/2S only.

CXL Memory Configuration Support for Intel® Xeon® 6700/6500-Series Processors with P-Cores									
Native DDR5 Memory Per Socket				CXL Memory Per Socket					
Slot 0 DIMM Ranks	Slot 0 DIMM Capacity (GB)	DIMM Type	DRAM Density (Gb)	CXL Memory Channels	CXL Memory Type	CXL Capacity Per Device/ Module	CXL Inter leave	CXL Mode	4S and 8S support
2Rx4	96	10x4	24	2+2	DDR5 x8	96 GB	1x4*, 2x2, 4x1	1LM+Vol	Yes
2H 3DS	128	10x4	16	2+2	DDR5 x8, DDR x8	128 GB	1x4*, 2x2, 4x1	1LM+Vol	Yes
2Rx4	64	10x4	16	2+2	DDR5 x8	64 GB	hetero x12	Hetero	Yes
2Rx4	64	10x4	16	1+1	DDR5 x16	2ch 64 GB	hetero x12	Hetero	Yes
2Rx4	64	10x4	16	2+2+2+2	DDR5 x8	64 GB	1x8*, 2x4, 4x2	1LM+Vol	No
2Rx4	64	10x4	16	2	DDR5 x8	256 GB	1x2*	1LM+Vol	No
2Rx4	64	10x4	16	1+1	DDR4 x16, DDR5 x16	2ch 128 GB	1x2*	Intel Flat Memory Mode	No

Notes:

- The items with an asterisk (*) are the default settings in the BIOS.
- The Intel® Xeon® 6700-series processors with P-cores CXL memory configurations are 1DPC ('Slot 0') only for native DDR5.
- CXL Memory Channel: number of devices per root port, with root ports separated by "+," e.g. 2+2+2+2 = four root ports populated with two devices per root port.
- CXL Interleave: sets x ways, e.g. 2x4 = One set of two modules, interleaved four-way.
- CXL Modes:
  - 1LM + Vol = DDR5 ('1LM') and (volatile) CXL memory visible to SW as separate tiers, separately interleaved.
  - Hetero x12 = DDR5 and (volatile) CXL memory interleaved together in one 12-way set.
  - Flat Memory Mode = HW manages data movement between DDR5 and CXL memory, total capacity visible to SW.

Intel® Xeon® 6700/6500-Series Processors with P-Cores DDR5 Memory Population Table **(2 Processors and 32 DIMMs Installed, 1DPC)**	
1 Processor DIMM Count	***Memory Population Sequence (1DPC)***
1 Processor and 1 DIMM	P1-DIMMA1
1 Processor and 4 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P1-DIMMB1/P1-DIMMD1/P1-DIMMH1/P1-DIMMF1
1 Processor and 8 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1
2 Processor (Recommended)	***Memory Population Sequence (1DPC)***
2 Processors and 8 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P2-DIMMA1/P2-DIMMC1/P2-DIMME1/P2-DIMMG1
2 Processors and 8 DIMMs	P1-DIMMB1/P1-DIMMD1/P1-DIMMF1/P1-DIMMH1 P2-DIMMB1/P2-DIMMD1/P2-DIMMF1/P2-DIMMH1
2 Processors and 16 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1 P2-DIMMA1/P2-DIMMB1/P2-DIMMC1/P2-DIMMD1/P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1

Intel® Xeon® 6700/6500-Series Processors with P-Cores DDR5 Memory Population Table (2 Processors and 32 DIMMs Installed, 2DPC)	
1 Processor DIMM Count	***Memory Population Sequence (2DPC)***
1 Processor and 1 DIMM	P1-DIMMA1
1 Processor and 4 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P1-DIMMB1/P1-DIMMD1/P1-DIMMF1/P1-DIMMH1
1 Processor and 8 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1 P1-DIMMA1/P1-DIMMA2/P1-DIMMC1/P1-DIMMC2/P1-DIMME1/P1-DIMME2/P1-DIMMG1/P1-DIMMG2 P1-DIMMB1/P1-DIMMB2/P1-DIMMD1/P1-DIMMD2/P1-DIMMF1/P1-DIMMF2/P1-DIMMH1/P1-DIMMH2
1 Processor and 12 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1
1 Processor and 16 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMB2/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMMD2/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMF2/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1/P1-DIMMH2
2 Processor DIMM Count (Recommended)	***Memory Population Sequence (2DPC)***
2 Processors and 2 DIMMs	P1-DIMMA1 P2-DIMMA1
2 Processors and 8 DIMMs	P1-DIMMA1/P1-DIMMC1/P1-DIMME1/P1-DIMMG1 P2-DIMMA1/P2-DIMMC1/P2-DIMME1/P2-DIMMG1
2 Processors and 8 DIMMs	P1-DIMMB1/P1-DIMMD1/P1-DIMMF1/P1-DIMMH1 P2-DIMMB1/P2-DIMMD1/P2-DIMMF1/P2-DIMMH1
2 Processors and 16 DIMMs	P1-DIMMA1/P1-DIMMB1/P1-DIMMC1/P1-DIMMD1/P1-DIMME1/P1-DIMMF1/P1-DIMMG1/P1-DIMMH1 P2-DIMMA1/P2-DIMMB1/P2-DIMMC1/P2-DIMMD1/P2-DIMME1/P2-DIMMF1/P2-DIMMG1/P2-DIMMH1

Intel® Xeon® 6700/6500-Series Processors with P-Cores DDR5 Memory Population Table (2 Processors and 32 DIMMs Installed, 2DPC)	
2 Processors and 16 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMC1/P1-DIMMC2/P1-DIMME1/P1-DIMME2/P1-DIMMG1/P1-DIMMG2 P2-DIMMA1/P2-DIMMA2/P2-DIMMC1/P2-DIMMC2/P2-DIMME1/P1-DIMME2/P2-DIMMG1/P2-DIMMG2
2 Processors and 16 DIMMs	P1-DIMMB1/P1-DIMMB2/P1-DIMMD1/P1-DIMMD2/P1-DIMMF1/P1-DIMMF2/P1-DIMMH1/P1-DIMMH2 P2-DIMMB1/P2-DIMMB2/P2-DIMMD1/P2-DIMMD2/P2-DIMMF1/P2-DIMMF2/P2-DIMMH1/P2-DIMMH2
2 Processors and 24 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1 P2-DIMMA1/P2-DIMMA2/P2-DIMMB1/P2-DIMMC1/P2-DIMMC2/P2-DIMMD1/P2-DIMME1/P2-DIMME2/P2-DIMMF1/P2-DIMMG1/P2-DIMMG2/P2-DIMMH1
2 Processors and 32 DIMMs	P1-DIMMA1/P1-DIMMA2/P1-DIMMB1/P1-DIMMB2/P1-DIMMC1/P1-DIMMC2/P1-DIMMD1/P1-DIMMD2/P1-DIMME1/P1-DIMME2/P1-DIMMF1/P1-DIMMF2/P1-DIMMG1/P1-DIMMG2/P1-DIMMH1/P1-DIMMH2 P2-DIMMA1/P2-DIMMA2/P2-DIMMB1/P2-DIMMB2/P2-DIMMC1/P2-DIMMC2/P2-DIMMD1/P2-DIMMD2/P2-DIMME1/P2-DIMME2/P2-DIMMF1/P2-DIMMF2/P2-DIMMG1/P2-DIMMG2/P2-DIMMH1/P2-DIMMH2

Notes:

- DIMMs must be all DDR5 RDIMM or all MRDIMMs.
- All DIMMs in a channel must have the same number of ranks (unless explicitly specified otherwise).
- x8 DIMMs and x4 DIMMs cannot be mixed in the same channel or same processor socket (see the memory support table above).
- Mixing of non-3DS and 3DS RDIMMs is not allowed in the same channel, across different channels, and across different sockets.
- 9x4 RDIMMs cannot be mixed with other DIMMs.
- All DDR5 DIMM must be in the same speed per processor socket.
- Rank mixing is not allowed.
- Mixing of DDR5 operating frequencies is not validated within a socket or across sockets by Intel. When DIMMs with different maximum frequencies are mixed in the same channel or across different channels across processor sockets, BIOS determines and sets the DIMM speed to the highest common frequency across all channels on the platform. For example, if a 6000 MT/s max frequency DIMM is installed in one channel and a 6400 MT/s max frequency DIMM in another, BIOS sets the platform speed to 6000 MT/s.
- Mixing memory made by different vendors is allowed for both RDIMM and 3DS RDIMM.
- The 1-DIMM per processor configuration supports only 16 GB 1Rx8 and 32 GB 2Rx8 modules.

General Guidelines for Optimizing Memory Performance

- It is recommended to use DDR5 memory of the same type, size, and speed.
- Mixed DIMM speeds can be installed. However, all DIMMs will run at the speed of the slowest DIMM.
- The motherboard will support an odd number amount of memory modules. However, to achieve the best memory performance, a balanced memory population is recommended.

DIMM Installation

Important: To avoid causing any damage to the memory module or the DIMM socket, do not use excessive force when pressing the release tabs on the ends of the DIMM socket. Handle memory modules with care. To avoid ESD-related damage to your memory modules or components, carefully follow all the instructions given in "Static-Sensitive Devices" on page 55.

1. Insert the desired number of DIMMs into the memory slots based on the recommended DIMM population table earlier in this section.
2. Push the release tabs outwards on both ends of the DIMM slot to unlock it.

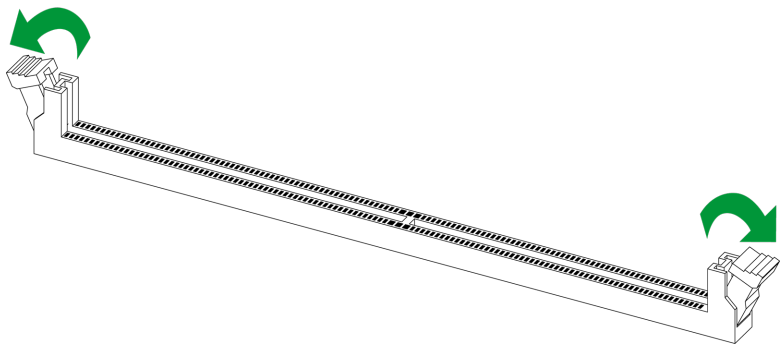


Figure 3-33. Unlocking the DIMM Slot

3. Align the key of the DIMM with the receptive point on the memory slot.

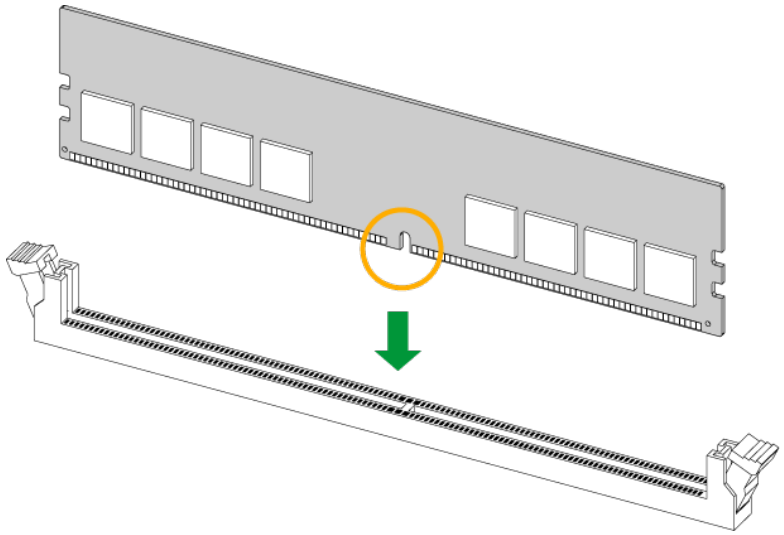


Figure 3-34. Aligning the DIMM Slot with the Receptive Point

4. Align the notches on both ends of the module against the receptive points on the ends of the slot.

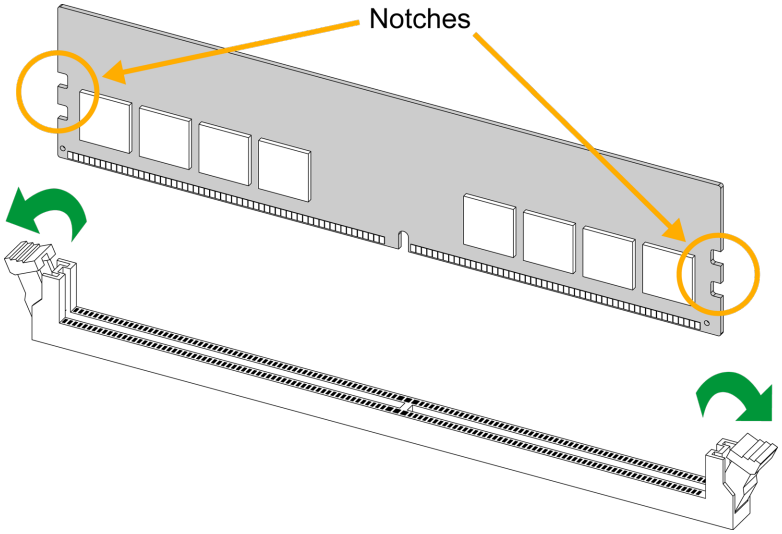


Figure 3-35. Aligning the Notches

5. Press both ends of the module straight down into the slot until the module snaps into place.
6. Press the release tabs to the lock positions to secure the DIMM into the slot.

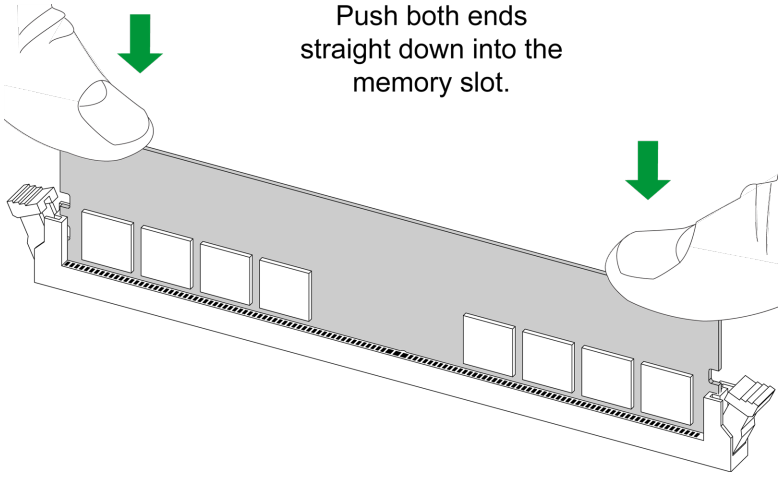


Figure 3-36. Securing the DIMM

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

DIMM Removal

Important: To avoid causing any damage to the memory module or the DIMM socket, do not use excessive force when pressing the release tabs on the ends of the DIMM socket. Handle memory modules with care. To avoid ESD-related damage to your memory modules or components, carefully follow all the instructions given in "Static-Sensitive Devices" on page 55.

Press both release tabs on the ends of the DIMM socket to unlock it. Once the DIMM is loosened, remove it from the memory slot.

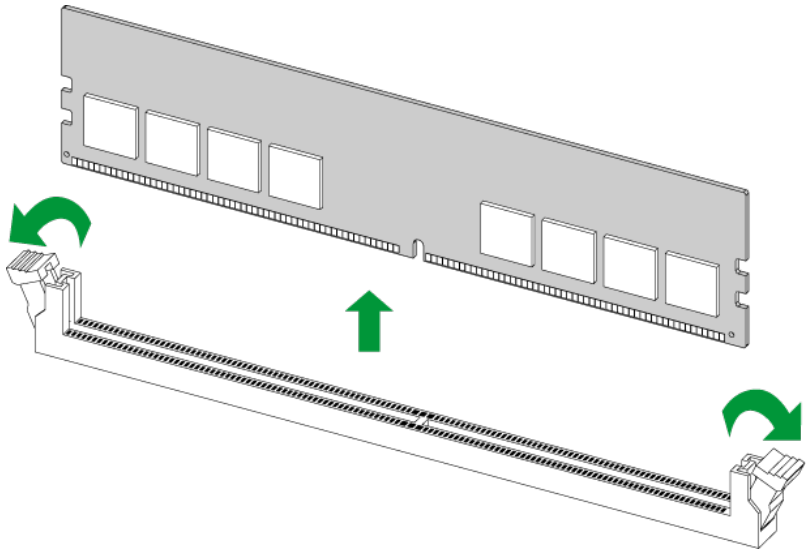


Figure 3-37. Unlocking the DIMM Slot

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

3.6 Motherboard Battery Removal and Installation

Battery Removal

To remove the onboard battery, follow the steps below:

1. Power off your system and unplug your power cable.
2. Place the system on a workbench.
3. Remove the top cover from the system.
4. Locate the onboard battery as shown below.
5. Using a tool such as a pen or a small screwdriver, push the battery lock outwards to unlock it. Once unlocked, the battery will pop out from the holder.
6. Remove the battery.

Proper Battery Disposal

Important: Handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

Battery Installation

To install an onboard battery, follow steps 1 and 2 above and continue below:

Important: When replacing a battery, be sure to only replace it with the same type.

1. Identify the battery's polarity. The positive (+) side should be facing up.
2. Insert the battery into the battery holder and push it down until you hear a click to ensure that the battery is securely locked.

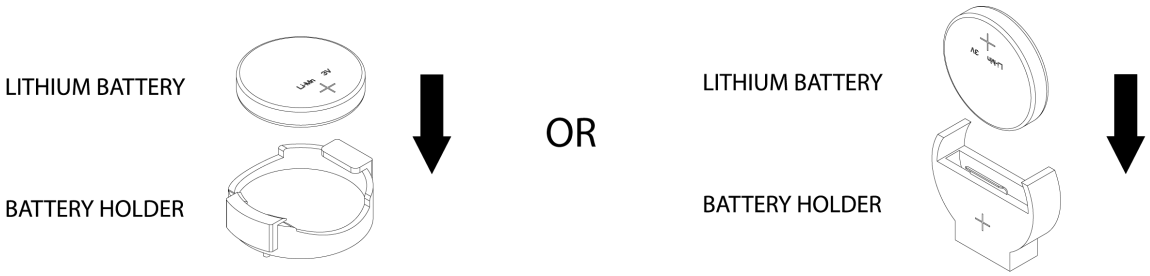


Figure 3-38. Installing a Battery

3.7 Installing Drives

The system supports up to 24 hot-swap 2.5" NVMe/SAS/SATA storage drives in hybrid bays. An optional controller card or cables is required to support NVMe/SAS/SATA.

Note: For NVMe, if more than eight drives are enabled, one or two PCIe expansion card slots are disabled. See the Expansion Cards for details.



Figure 3-39. Logical Drive Numbers

Logical Storage Drive Numbers	
Item	**Description**
0-23	24 hot-swap 2.5" NVMe/SAS/SATA drive bays

Removing Drive Carriers from the Chassis

1. Push the release button on the drive carrier to extend the handle and push the lever up.
2. Use the drive carrier handle to pull the drive out of the chassis.

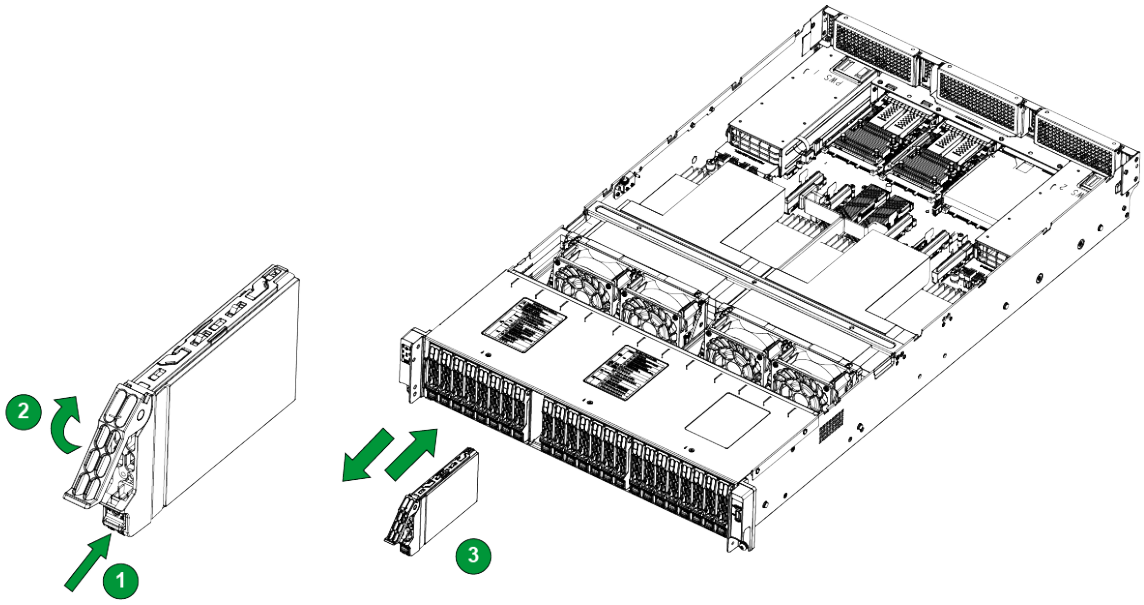


Figure 3-40. Removing a Drive Carrier

Installing a 2.5" Drive

1. Remove the dummy drive, which comes pre-installed in the drive carrier. Pull out the two locking clasps on the left outside of the carrier and lift out the dummy drive.
2. Install the drive directly into the tray with four screws underneath.
3. Insert the drive carrier into its bay, keeping the release button on the right. When the carrier reaches the rear of the bay, the release handle will retract.
4. Push the handle in until it clicks into its locked position.

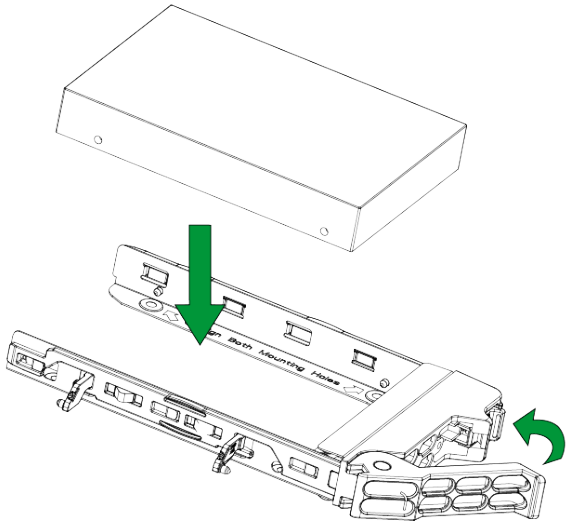


Figure 3-41. Installing a 2.5" Drive into a Carrier

Hot-Swap for NVMe Drives

Supermicro servers support NVMe surprise hot-swap. For even better data security, NVMe orderly hot-swap is recommended. NVMe drives can be ejected and replaced remotely using BMC.

Note: If you are using VROC, see Section 6.4 in this manual instead.

Ejecting a Drive

1. **BMC > Server Health > NVMe SSD**
2. Select Device, Group, and Slot, and click **Eject**. After ejecting, the drive Status LED indicator turns green.
3. Remove the drive.

Note that Device and Group are categorized by the CPLD design architecture.

A Slot is the slot number on which the NVMe drives are mounted.

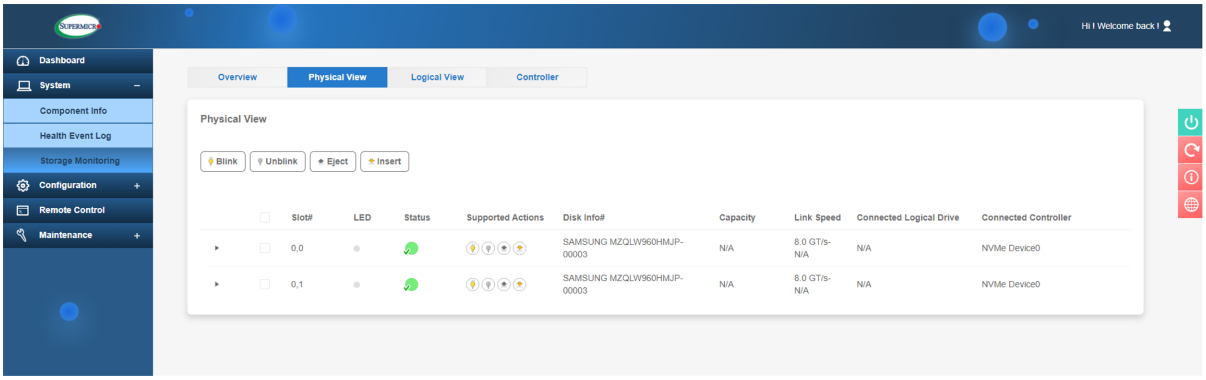


Figure 3-42. BMC Screenshot

Replacing a Drive

1. Insert the replacement drive.
2. **BMC > System > Storage Monitor > Physical View**
3. Select Device, Group, and slot and click **Insert**. The drive Status LED indicator flashes red, then turns off. The Activity LED turns blue.

3.8 Boot Drives

Before following the procedure below to install M.2 solid state drives, first turn off and remove power from the system, then remove the top cover.

Installing M.2 Solid State Drives on Motherboard

The X14DBHM motherboard has two hybrid PCIe 5.0 M.2 slots (M.2-C1, M.2-C2). M.2 allows for a variety of card sizes, increased functionality, and spatial efficiency.

The M.2 slot on the motherboard supports PCIe 5.0 x2 devices in the 2280 and 22110 form factors.

Note: M.2 slots are intended to be used for boot devices only. Any write-intensive workloads may result in thermal issues and the M.2 drives overheating.

Installing M.2 SSDs

1. Remove power from the system as described in Removing Power.
2. Remove the top cover as described in Accessing the System.
3. Refer to Motherboard Layout and locate the M.2 slot.
4. Insert the M.2 into the slot, then use the black plastic pin to secure it. If the M.2 is 80 mm, firmly pull it out to relocate from the default 110–80 mm mounting hole.
5. Repeat as necessary for more M.2 drives.
6. Replace the cover and restore power to the system.

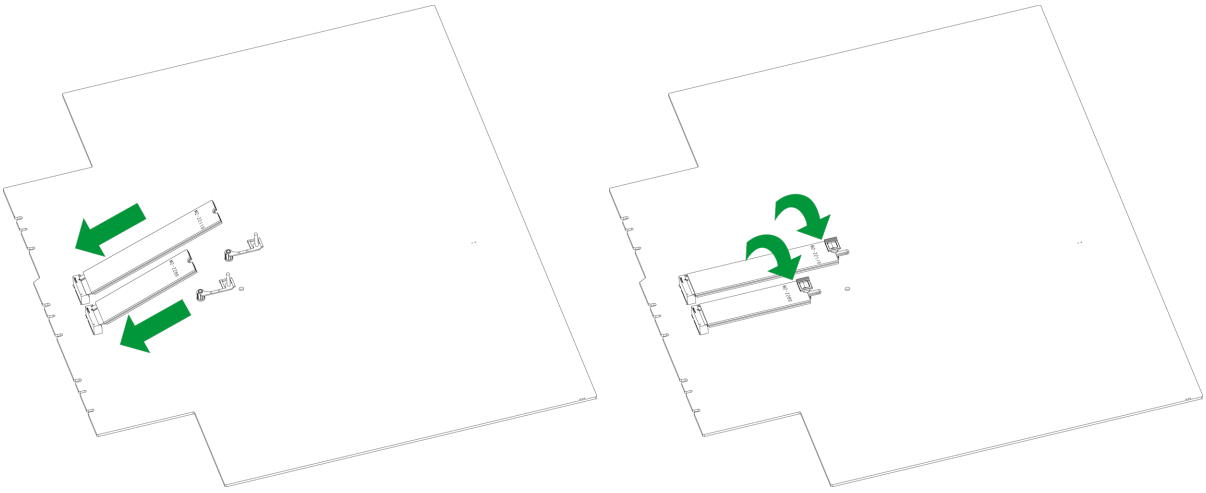


Figure 3-43. Inserting and Securing M.2 SSDs

3.9 System Cooling

Refer to the following sections for information about the cooling capabilities of the SYS-222C-TN server.

Fan Board

Eight cooling fans connect to the eight fan headers on the fan board, and JPWR1 on the fan board connects to JFAN header on the motherboard. The fan headers on the fan board support both 4-pin and 6-pin fans.

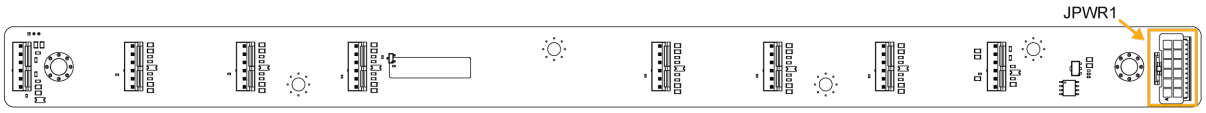


Figure 3-44. JPWR1 Location on System Fan Board

Fans

Four 8-cm fans provide the cooling for the system. Fan speed is controlled by the BMC. If a fan fails, the remaining fans will ramp up to full speed (100% duty) to compensate the cooling loss. In addition, the front control panel LED will blink at 1 Hz to indicate fan failure. Replace any failed fan at your earliest convenience with the same type and model. Make sure the chassis top cover makes a good seal so the cooling air circulates properly through the chassis.

Changing a System Fan

1. Determine which fan is failing. If possible, use the BMC.
2. Power down the system as described in "Removing Power" on page 53.
3. Open the fan cover as described in "Accessing the System" on page 54.
4. Squeeze the release latches on the side of the fan.

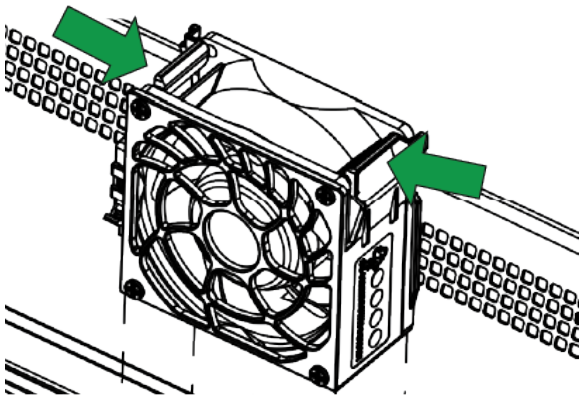


Figure 3-45. Squeezing the Release Latches

5. Lift the fan from the fan housing.

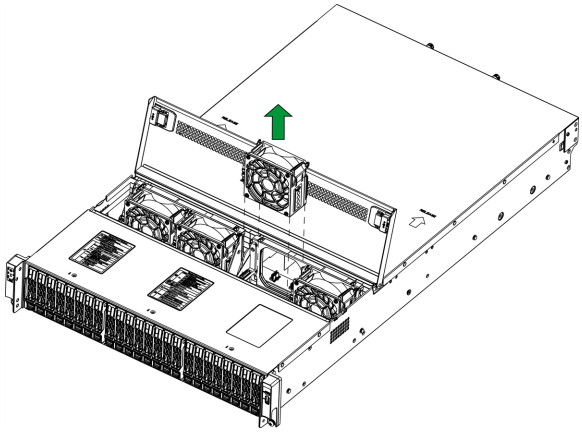


Figure 3-46. Lifting the Fan

6. Insert the replacement fan into the fan housing. Make sure the fan is oriented in the right direction.
7. Push the fan into the fan housing until the latches click and the fan is secure.
8. Power up the system and check that the fans are working properly.
9. Close the fan cover.

Air Shrouds

Air shrouds concentrate airflow to maximize fan efficiency. It covers the processors and heatsinks.

Installing the Air Shrouds

1. Place the air shroud down.
2. Attach a reinforcement bar on the air shroud.
3. Mount the reinforce bar to the chassis with four screws.

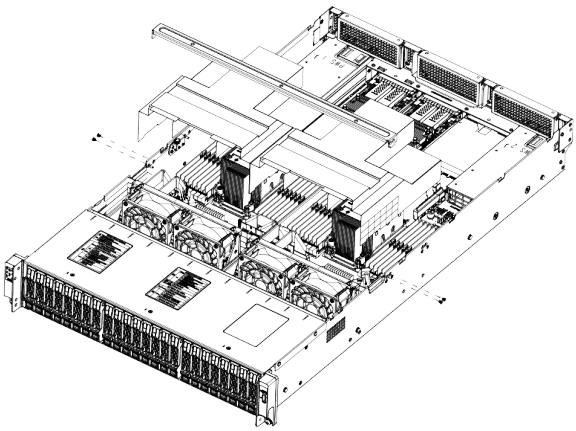


Figure 3-47. Installing the Air Shroud

3.10 Expansion Cards

Refer to the following sections for information on the expansion cards supported by the SYS-222C-TN server.

AIOM and DC-SCM Cards

The SYS-222C-TN supports two PCIe 5.0 x16 AIOM OCP 3.0 network cards and one DC-SCM card.

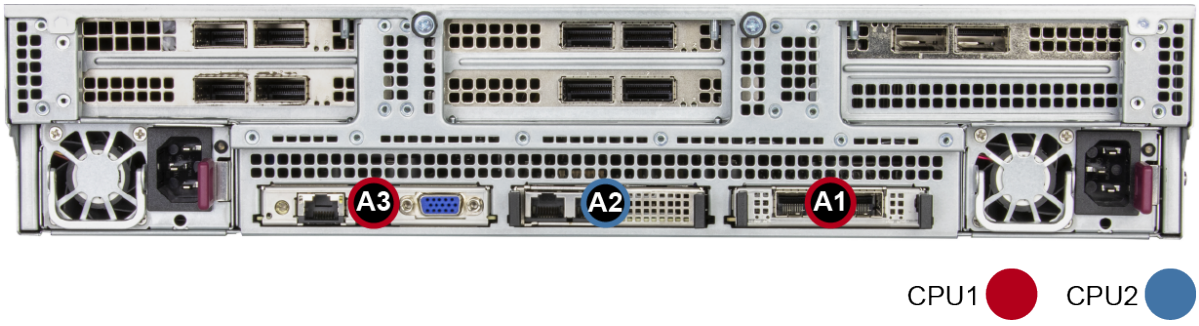


Figure 3-48. AIOM Chassis Slots

AIOM Slots			
Slot	**Mechanical**	**Electrical**	**Slot Class**
A1	Small Form Factor, OCP 3.0	x16	Up to 80 W
A2	Small Form Factor, OCP 3.0	x16	Up to 80 W
A3	DC-SCM	N/A	N/A

Note: AIOM cards exceeding the 15 W slot class may require restricted conditions to meet thermal specifications of the AIOM card. Contact your Supermicro account representative for more information.

Installing AIOM Cards

1. Remove the blank cover plate (A1, A2, or A3) by unscrewing the thumbscrew.
2. Slide the AIOM card in the opening until it seats in the motherboard slot.
3. Secure with the thumbscrew.

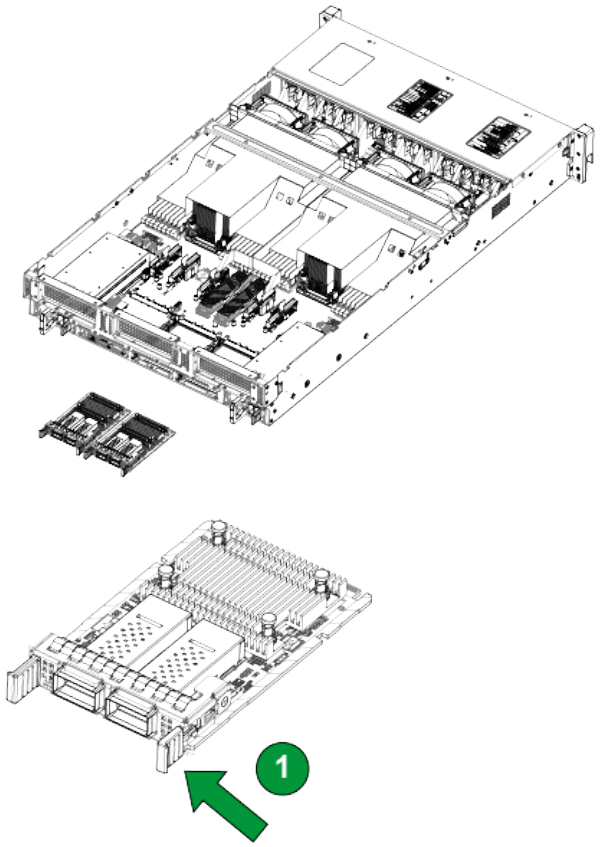


Figure 3-49. Installing AIOMs

Installing a DC-SCM Card

1. Remove power as described in "Removing Power" on page 53.
2. Open the chassis cover as described in "Accessing the System" on page 54.
3. Remove the riser cage directly above the DC-SCM slot behind CPU2.
4. Remove the blank cover plate (A3) by pushing it out of the chassis from the inside.
5. Gently insert the DC-SCM card until the blue unlock pin clicks.
6. To remove the DC-SCM card, pull out the unlock pin and use the holding tabs to gently pull out the card.

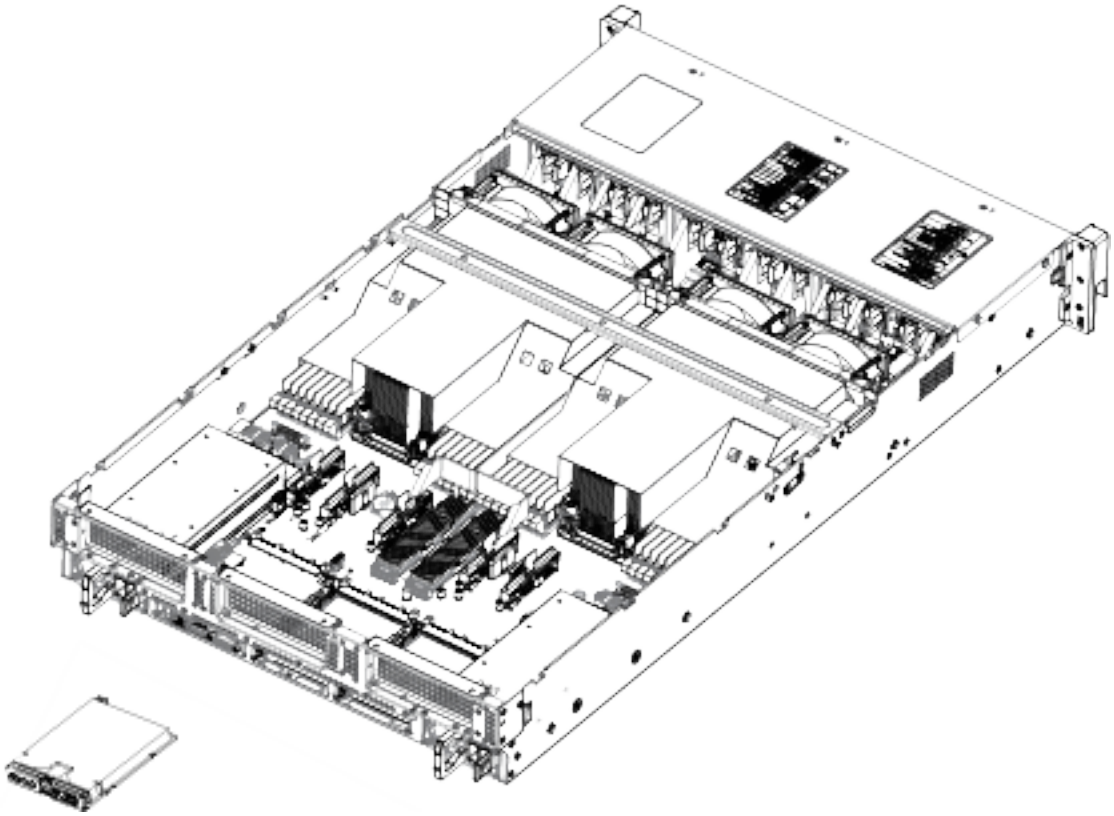


Figure 3-50. Installing DC-SCM

Riser Card and Cables

The SYS-222C-TN uses riser cards RSC-M2-6G5, RSC-M2R-6G5 and cables CBL-ASMC-1226MT16P, CBL-ASMC-1240MT16P and CBL-ASMC-1281DM5RYP for PCIe capabilities.

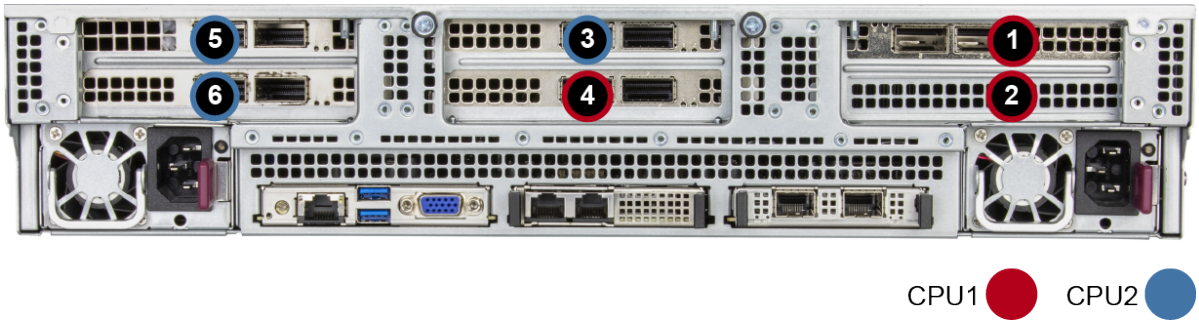


Figure 3-51. Expansion Card Slots in the Chassis

Expansion Slot Locations		
Slot	**Option**	**Description**
1	1 and 2	PCIe 5.0 x16 full-height, full-length (CPU1); full-length requires 1U heatsinks
2		No connection
3		PCIe 5.0 x16 full-height, full-length (CPU2); full-lengthrequires 1U heatsinks
4		PCIe 5.0 x16 full-height, full-length (CPU1); full-length requires 1U heatsinks
5		PCIe 5.0 x8 full-height, full-length (CPU2); full-length requires 1U heatsinks
6		PCIe 5.0 x16 full-height, full-length (CPU2); full-length requires 1U heatsinks
1	3	PCIe 5.0 x16 full-height, full-length (CPU1); full-length requires 1U heatsinks
2		No connection
3		PCIe 5.0 x8 full-height, full-length (CPU2); full-length requires 1U heatsinks
4		No connection
5		No connection
6		PCIe 5.0 x16 full-height, full-length (CPU2); full-lengthrequires 1U heatsinks
1	4	PCIe 5.0 x16 full-height, full-length (CPU1); full-length requires 1U heatsinks
2		PCIe 5.0 x16 full-height, full-length (CPU1); full-length requires 1U heatsinks
3		PCIe 5.0 x16 full-height, full-length (CPU2); full-length requires 1U heatsinks
4		PCIe 5.0 x16 full-height, full-length (CPU1); full-length requires 1U heatsinks
5		PCIe 5.0 x16 full-height, full-length (CPU2); full-length requires 1U heatsinks
6		PCIe 5.0 x16 full-height, full-length (CPU2); full-length requires 1U heatsinks

Installing Expansion Cards

1. Power down the system and remove the cover.
2. Disconnect the riser cables from the motherboard.
3. Lift out the riser brackets using the pull tabs, starting with the left-most (1|2), followed by the middle (3|4), and finishing with the right-most bracket (5|6).
4. Remove the blank PCI shields covering the chassis slots at the rear of the riser bracket.

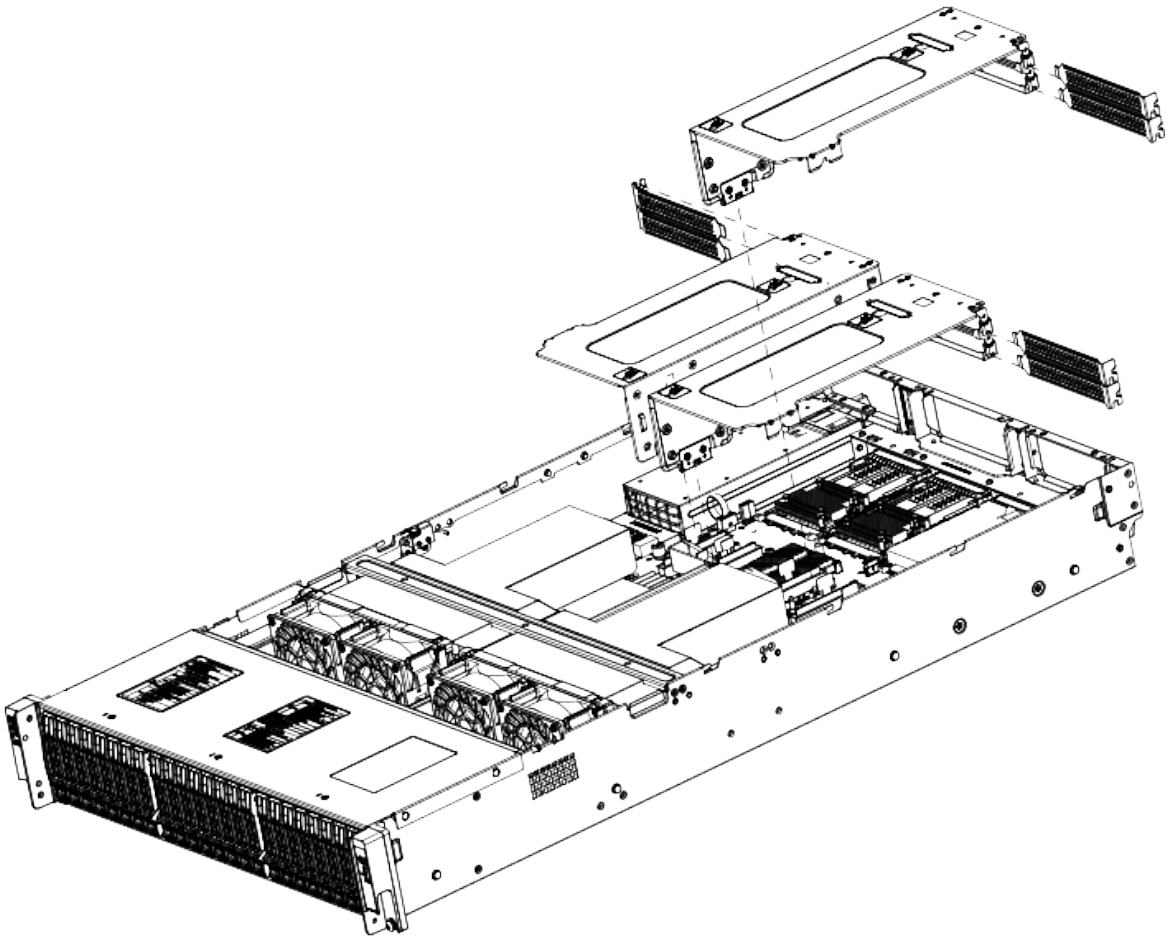


Figure 3-52. Removing Riser Card Brackets and Shields

5. Slide the expansion card into the expansion slot on the riser card.
6. Reconnect the riser cables and align the riser cards with the motherboard slots. Begin with the right-most bracket (5|6), then place the middle brackets (3|4), and finish with the left bracket (1|2). Ensure the guide holes on the chassis align with the motherboard pins and support bar.
7. Press down on the brackets until they snap into place.

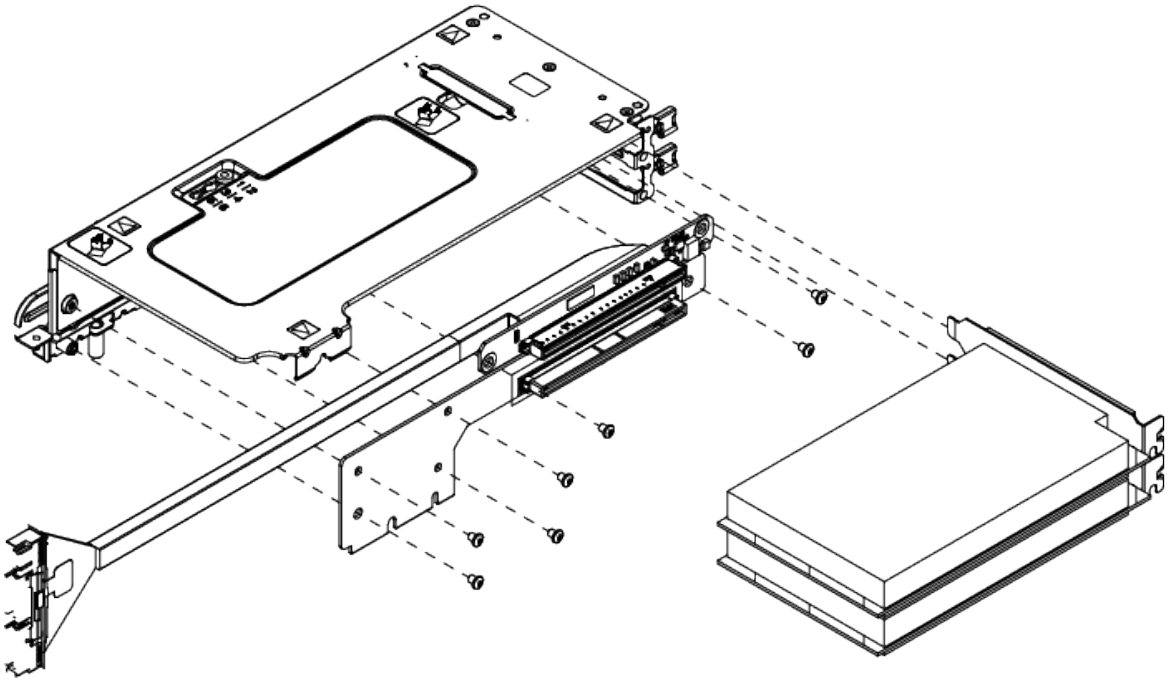


Figure 3-53. Installing Left Expansion Cards

3.11 Cable Routing Diagrams

The below diagrams indicate the cable routing for the storage, PCIe, I/O, and power cables. When disconnecting cables to add or replace components, refer to the diagrams so you can reroute them in the same manner. If cables are not connected or routed properly it may lead to device detection or performance issues.

Storage Drive Cable Routing

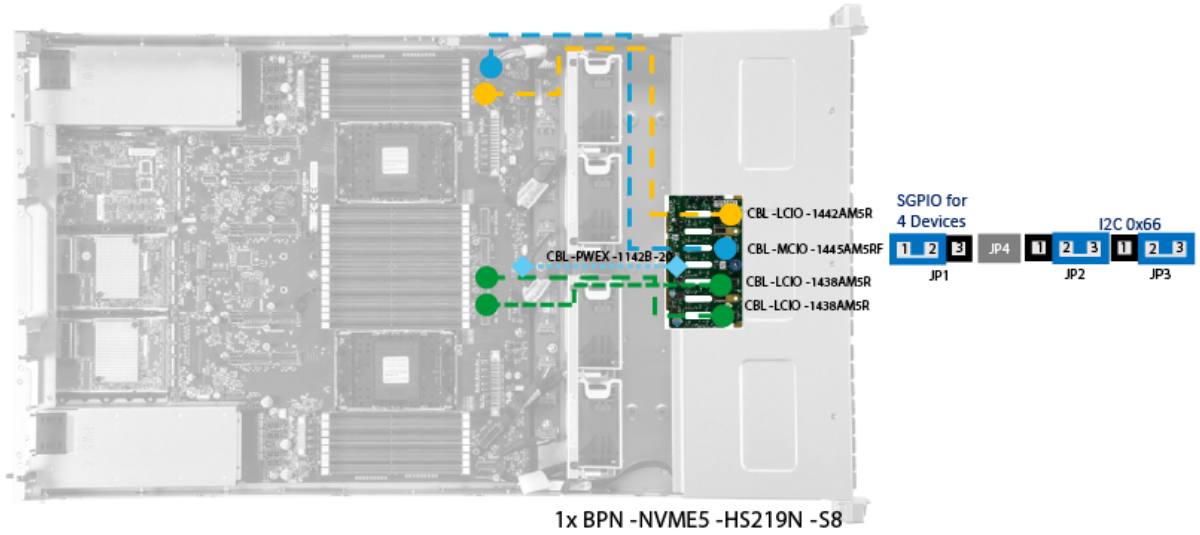


Figure 3-54. Eight NVMe Configuration (Options 1 and 3)

Eight NVMe Configuration			
Item	**Part Number**	**MBD**	**BPN**
8-9	CBL-LCIO-1438AM5R	MCIO1A	NVMe1
10-11	CBL-LCIO-1438AM5R	MCIO1B	NVMe2
12-13	CBL-MCIO-1445AM5RF	MCIO3A	NVMe3
14-15	CBL-LCIO-1442AM5R	MCIO3B	NVMe4
-	CBL-PWEX-1142B-20	JPWR10	JPWR1

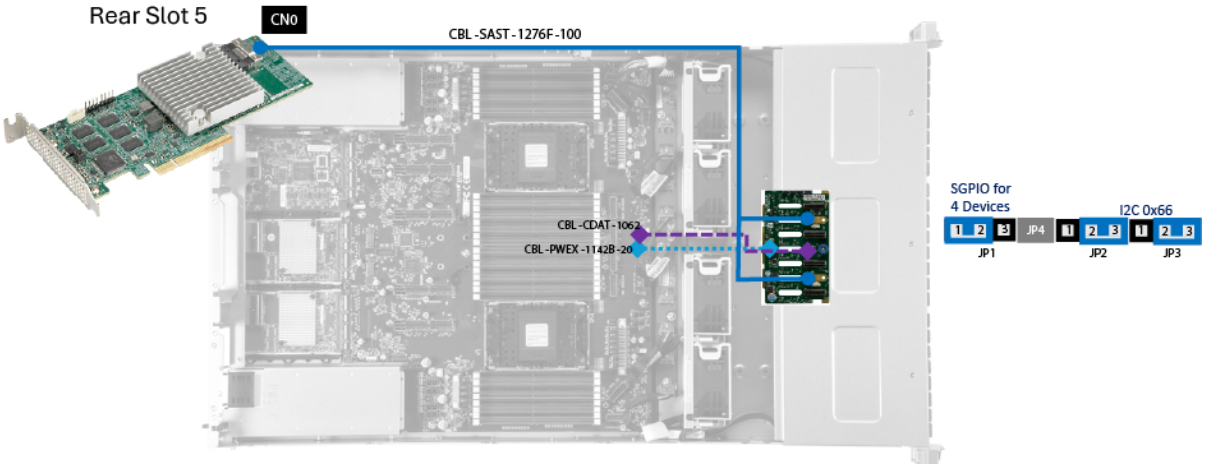


Figure 3-55. Eight SATA/SAS Configuration (Options 1 and 3)

Eight SATA/SAS Configuration			
Item	**Part Number**	**MBD**	**BPN**
8-15	CBL-SAST-1276F-100	CN0	CN1 + CN2
-	CBL-CDAT-1062	JBPNI2C	JIPMB1
-	CBL-PWEX-1142B-20	JPWR10	JPWR1

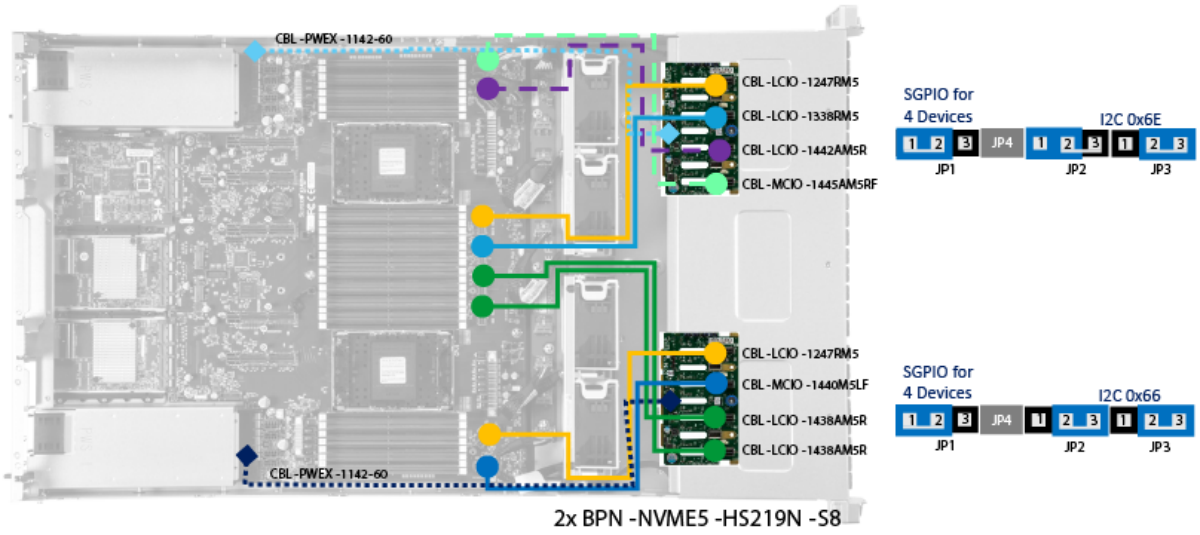


Figure 3-56. 16 NVMe Configuration (Option 1)

16 NVMe Configuration			
Item	**Part Number**	**MBD**	**BPN**
0-1	CBL-LCIO-1438AM5R	MCIO1A	NVMe1
2-3	CBL-LCIO-1438AM5R	MCIO1B	NVMe2
4-5	CBL-MCIO-1440M5LF	MCIO2A	NVMe3
6-7	CBL-LCIO-1247RM5	MCIO2B	NVMe4
16-17	CBL-MCIO-1445AM5RF	MCIO3A	NVMe1
18-19	CBL-LCIO-1442AM5R	MCIO3B	NVMe2
20-21	CBL-LCIO-1338RM5	MCIO4A	NVMe3
22-23	CBL-LCIO-1247RM5	MCIO4B	NVMe4
-	CBL-PWEX-1142-60	JPWR2	JPWR1
-	CBL-PWEX-1142-60	JPWR7	JPWR1

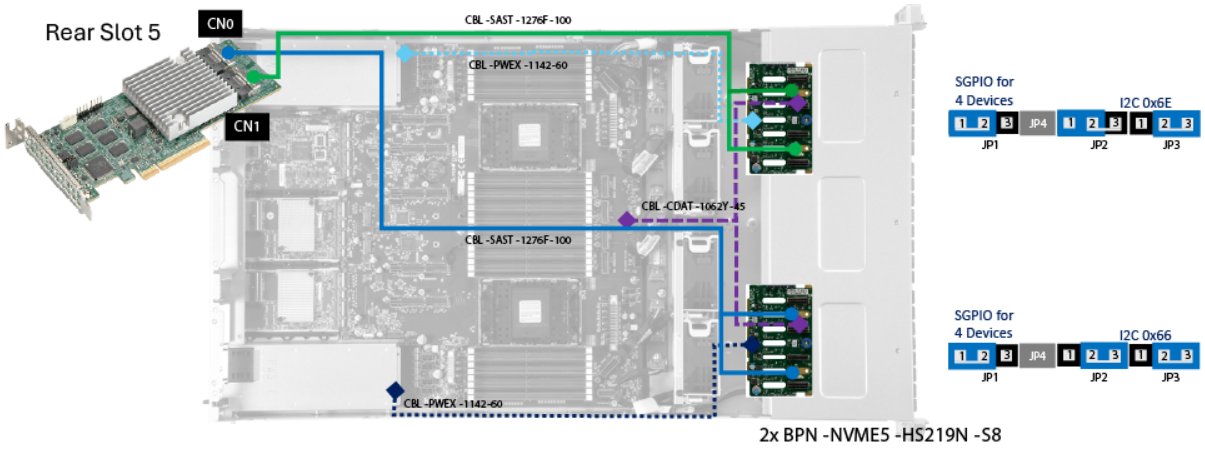


Figure 3-57. 16 SATA/SAS Configuration (Option 1)

16 SATA/SAS Configuration			
Item	**Part Number**	**MBD**	**BPN**
0-7	CBL-SAST-1276F-100	CN0	CN1 + CN2
16-17	CBL-SAST-1276F-100	CN1	CN1 + CN2
-	CBL-CDAT-1062Y-45	JBPNI2C	2x JIPMB1
-	CBL-PWEX-1142-60	JPWR2	JPWR1
-	CBL-PWEX-1142-60	JPWR7	JPWR1

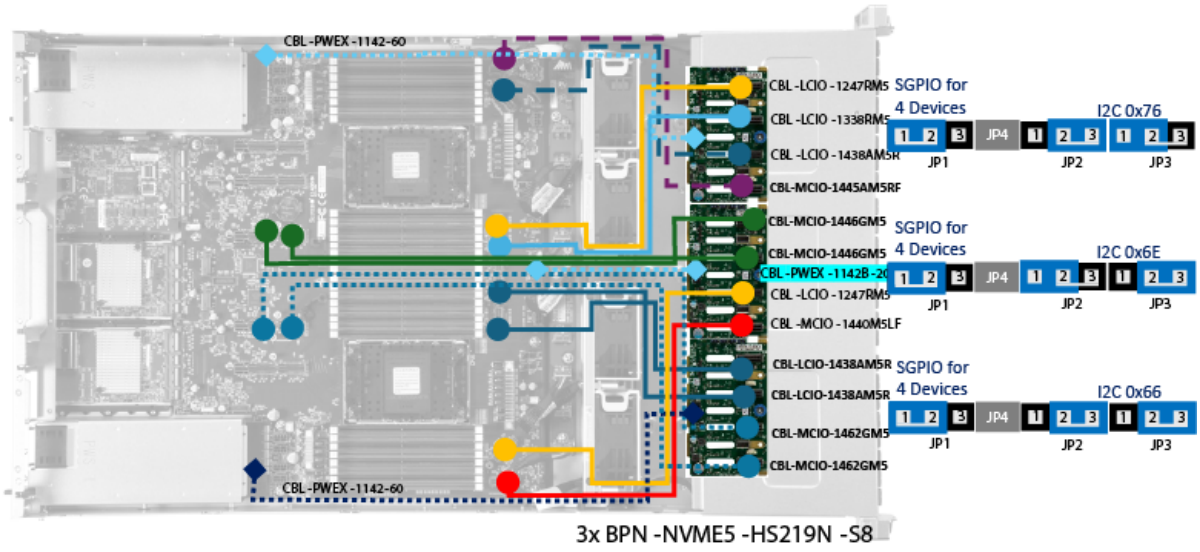


Figure 3-58. 24 NVMe Configuration (Option 2)

24 NVMe Configuration			
Item	**Part Number**	**MBD**	**BPN**
0-1	CBL-MCIO-1462GM5	JSLOT2-U	NVMe1
2-3	CBL-MCIO-1462GM5	JSLOT2-L	NVMe2
4-5	CBL-LCIO-1438AM5R	MCIO1A	NVMe3
6-7	CBL-LCIO-1438AM5R	MCIO1B	NVMe4
8-9	CBL-MCIO-1440M5LF	MCIO2A	NVMe1
10-11	CBL-LCIO-1247RM5	MCIO2B	NVMe2
12-13	CBL-MCIO-1446GM5	JSLOT4-U	NVMe3
14-15	CBL-MCIO-1446GM5	JSLOT4-L	NVMe4
16-17	CBL-MCIO-1445AM5RF	MCIO3A	NVMe1
18-19	CBL-LCIO-1438AM5R	MCIO3B	NVMe2
20-21	CBL-LCIO-1338RM5	MCIO4A	NVMe3
22-23	CBL-LCIO-1247RM5	MCIO4B	NVMe4
-	CBL-PWEX-1142-60	JPWR7	JPWR1
-	CBL-PWEX-1142B-20	JPWR10	JPWR1
-	CBL-PWEX-1142-60	JPWR2	JPWR1

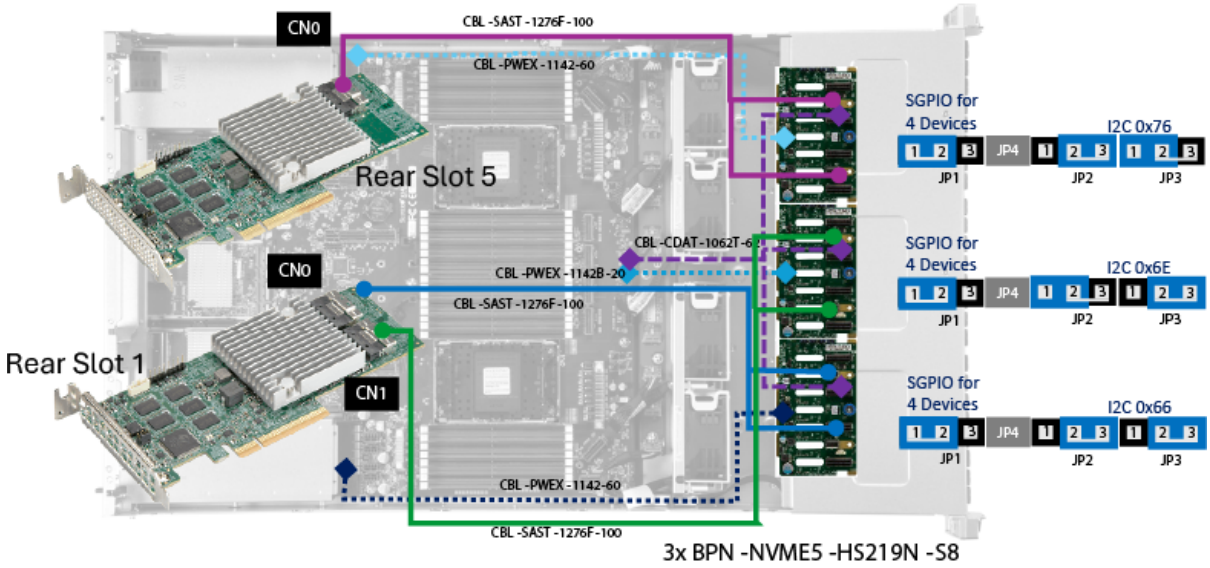


Figure 3-59. 24 SATA/SAS Configuration (Option 2)

24 SATA/SAS Configuration			
Item	**Part Number**	**MBD**	**BPN**
0-7	CBL-SAST-1276F-100	CN0	CN1 + CN2
8-15	CBL-SAST-1276F-100	CN1	CN1 + CN2
16-23	CBL-SAST-1276F-100	CN0	CN1 + CN2
-	CBL-CDAT-1062T-62	JBPNI2C	3x JIPMB1
-	CBL-PWEX-1142-60	JPWR2	JPWR1
-	CBL-PWEX-1142B-20	JPWR10	JPWR1
-	CBL-PWEX-1142-60	JPWR7	JPWR1

Riser Card Cable Routing

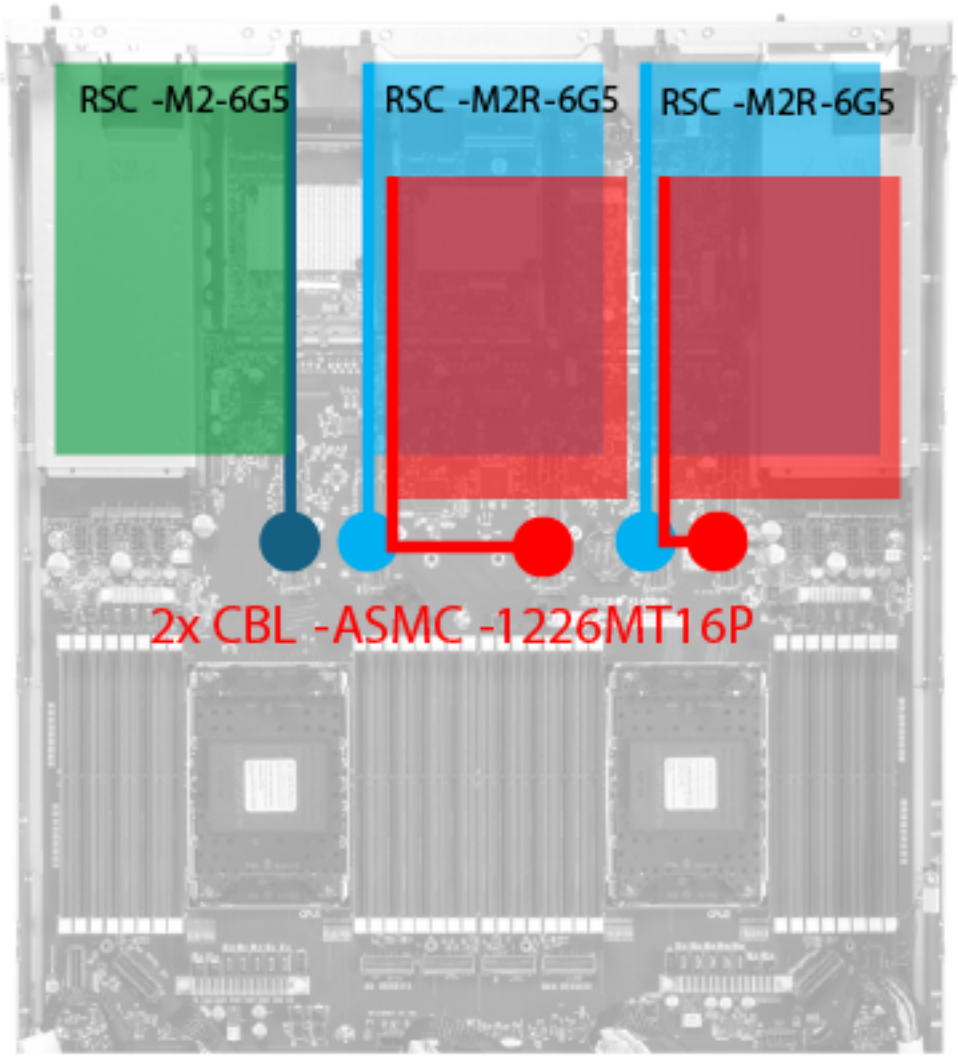


Figure 3-60. Riser Card Configuration (Option 1)

Riser Card Configuration			
Item	**Part Number**	**Motherboard Port**	**PCIe Width**
1	RSC-M2-6G5	JSLOT1	x16
4	RSC-M2R-6G5	JSLOT2	x16
6	RSC-M2R-6G5	JSLOT5	x16
3	CBL-ASMC-1226MT16P	JSLOT4	x16
5	CBL-ASMC-1226MT16P	JSLOT6	x8

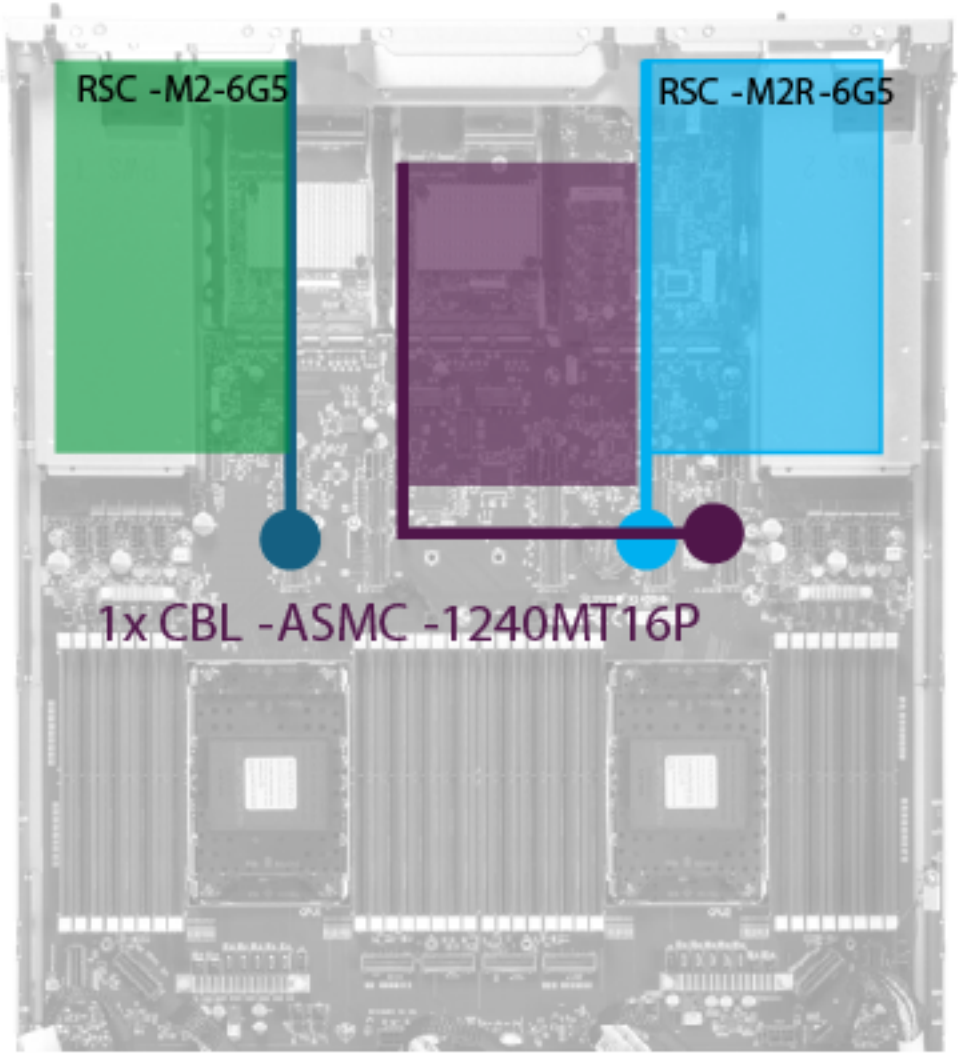


Figure 3-61. Riser Card Configuration (Option 2)

Riser Card Configuration			
Item	**Part Number**	**Motherboard Port**	**PCIe Width**
1	RSC-M2-6G5	JSLOT1	x16
6	RSC-M2R-6G5	JSLOT5	x16
3	CBL-ASMC-1240MT16P	JSLOT6	x8

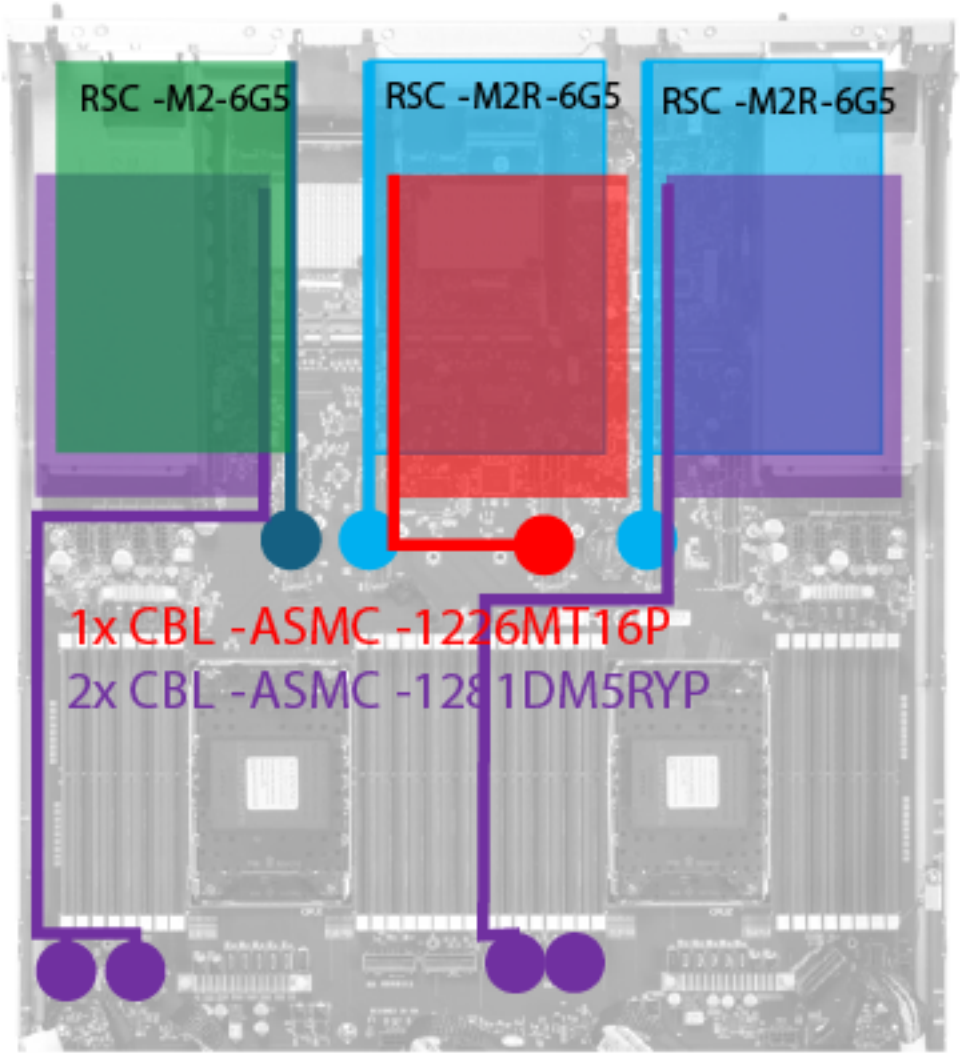


Figure 3-62. Riser Card Configuration (Option 3)

Riser Card Configuration			
Item	**Part Number**	**Motherboard Port**	**PCIe Width**
1	RSC-M2-6G5	JSLOT1	x16
4	RSC-M2R-6G5	JSLOT2	x16
6	RSC-M2R-6G5	JSLOT5	x16
3	CBL-ASMC-1226MT16P	JSLOT4	x16
2	CBL-ASMC-1281DM5RYP	MCIO2A-2B + PWR	x16
5	CBL-ASMC-1281DM5RYP	MCIO4A-4B + PWR	x16

3.12 Power Supply

The SYS-222C-TN server features redundant power supplies. The power modules can be changed without powering down the system. New units can be ordered directly from Supermicro or authorized distributors.

These power supplies are auto-switching capable. This feature enables them to automatically sense the input voltage and operate at a 100–120 V or 180–240 V.

Power Supply LEDs

On the rear of the power supply module, an LED displays the status.

Status Indicator	
LED Color and State	**Power Supply Indicator**
Green, solid	Indicates that the power supply is on. Indicates that the power supply is on.
Green, blinking	Indicates that the power supply is plugged in and turned off by the system.
Amber, blinking	Indicates that the power supply has a warning condition and continues to operate.
Amber, solid	Indicates that the power supply is plugged in and is in an abnormal state. The system might need service. Contact Supermicro technical support.
Off	No AC power to modules.

Replacing the Power Supply

1. Unplug the AC cord from the module to be replaced.
2. Push the release tab on the back of the power supply as illustrated.
3. Pull the power supply out using the handle.
4. Replace the failed power module with the same model.
5. Push the new power supply module into the power bay until it clicks.
6. Plug the AC power cord back into the module.

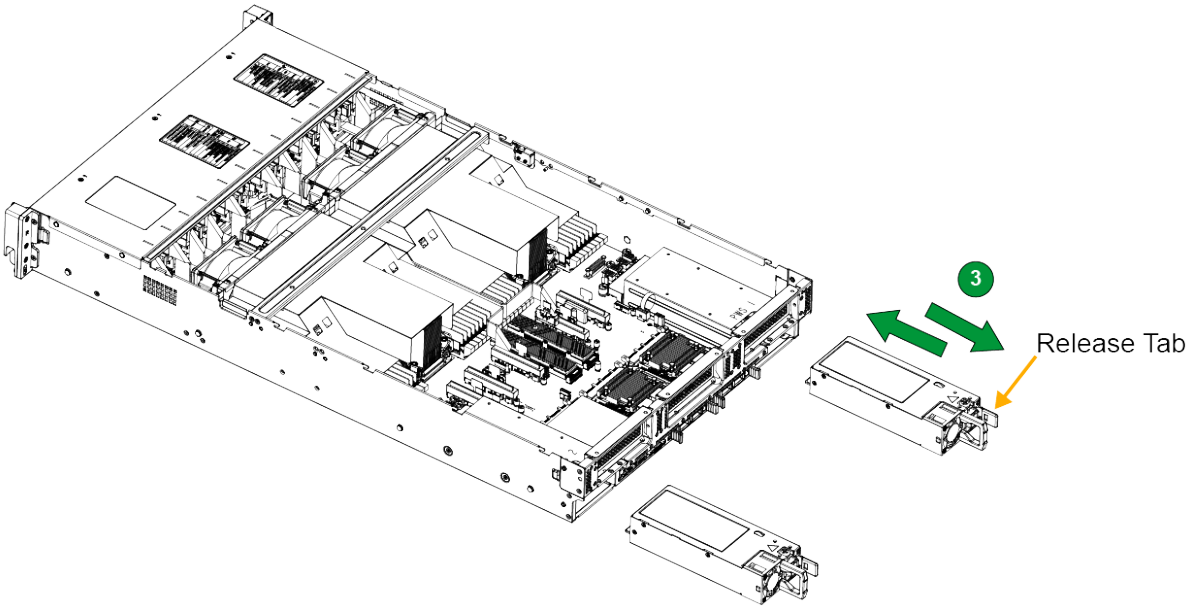


Figure 3-63. Installing a Power Supply Module

Chapter 4:

Motherboard Connections, Jumpers, and LEDs

This section describes the connections on the motherboard and provides pinout definitions. Note that depending on how the system is configured, not all connections are required. The LEDs on the motherboard are also described here. A motherboard layout indicating component locations may be found in the "Introduction" on page 14. More detail can be found in the X14DBHM motherboard manual.

Review the "Standardized Warning Statements for AC Systems" on page 218 before installing or removing components.

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Fan Power Connector 112
Main Server Power Connectors 112
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4.1 Power Supply and Power Connections

For information about the power supply and power connections of the SYS-222C-TN server, refer to the following content.

8-Pin Backplane/GPU Power Connectors

Four 8-pin +12 V power connectors located at JPMW9–JPMW12/PWR9–PWR12 on the X14DBHM are used for backplane and GPU devices for front access.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

8-Pin Riser/Backplane/GPU Power Connectors

Eight 8-pin +12 V power supply connectors, located at JPMW1–JPMW8/PWR1–PWR8 on the X14DBHM, provide power to riser card, backplane, and GPU devices via cables for rear access.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

8-pin CPU Power Pin Definitions: Eight Total	
Pin#	**Definition**
1–4	GND
5–8	+12 V (12 V Power)

Fan Power Connector

A fan power connector located at JFAN/FAN_PWR on the X14DBHM motherboard is used to provide power for system cooling fans.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Main Server Power Connectors

Two power supply connectors, located at PSU1/PSU2, provide main server power to your CloudDC server.

Notes:

- The table below represents the power supplies that support the main power supply units (PSU1/PSU2) in the Supermicro CloudDC servers. For detailed power supply support for your particular server, refer to your CloudDC server user manual.
  - For CloudDC Systems:

PWS-2K09A-1R
PWS-3K21A-1R2

- All power connectors used on this motherboard meet the ATX SSI EPS 12 V specification and must be connected to your power supply to provide adequate power to your system for all devices and components use.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

4.2 Headers and Connections

For information about the headers on the X14DBHM motherboard, refer to the following content.

Chassis Intrusion

A Chassis Intrusion header is located at JL1 on the X14DBHM motherboard. Attach the appropriate cable from the chassis to inform you when the chassis is opened.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Chassis Intrusion Pin Definitions: Three Total	
Pin#	**Definition**
1A/1B	Intrusion Input
2A/2B	GND
3A/3B	N/A

MCIO NVMe Connectors

MCIO NVMe connectors, located at JMCIO1A/1B–JMCIO4A/4B, provide eight PCIe 5.0 x8 connections for front access. JMCIO1A/1B and JMCIO2A/2B connections are supported by CPU1, and JMCIO3A/3B and JMCIO4A/4B connections, by CPU2. Use these MCIO connectors to support high-speed PCIe storage devices.

Note: When installing an NVMe device on a motherboard, be sure to connect JMCIO1A first for your system to work properly.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

NVMe SMBus Headers

Two NVMe SMBus (I²C) headers are located at JNVI²C1 and JBPNI²C1 on the X14DBHM motherboard). They are used for PCIe SMBus clock and data connections, provides hot-plug support through a dedicated SMBus interface. This feature is only available for a Supermicro complete system with a Supermicro proprietary NVMe add-on card and a proper cable installed.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

NVMe SMBus Headers Pin Definitions: Four Total	
Pin#	**Definition**
1	Data
2	GND
3	Clock
4	+3.3 V

4.3 Control Panel

Refer to the following content for information about the front control panel header on the X14DBHM motherboard.

Front Control Panel Header with I²C

There are two front control panel headers located on this motherboard.

JFP1 on the X14DBHM motherboard contains header pins for various buttons and LED indicators that are normally located on a control panel at the front of the chassis. These connectors are designed specifically for use with Supermicro chassis.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

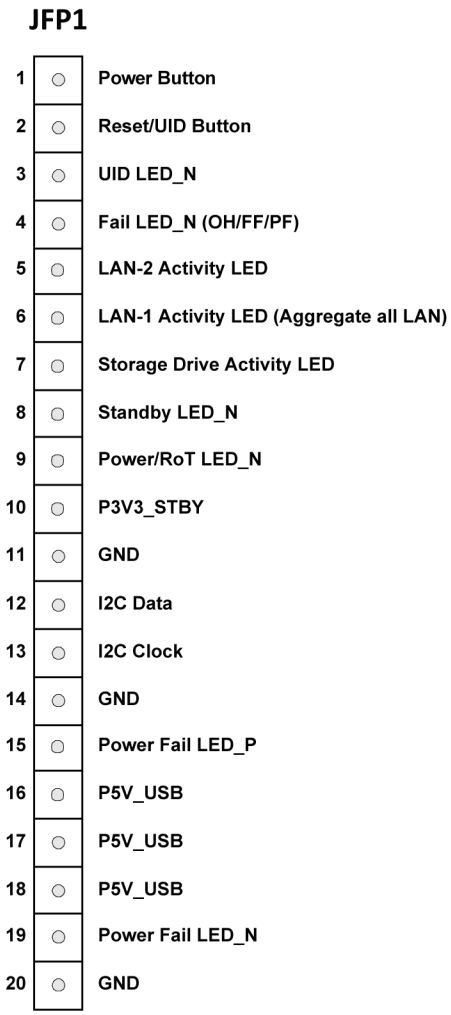


Figure 4-1. JFP1 Header Pins

Power On and BMC/BIOS Status LED Button

The Power On and BMC/BIOS Status LED button is located on pin 1 of the front control panel header located at JFP1 on the X14DBHM motherboard. Momentarily contacting pin 1 of JFP1 will power on/off the system or display BMC/BIOS status.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Power Button BMC/BIOS Status LED Indicator	
Status	**Event**
Green: Solid on	System power on
BMC/BIOS blinking green at 4 Hz	BMC/BIOS checking
BIOS blinking green at 4 Hz	BIOS recovery/update in progress
BMC blinking red x2 (two blinks red) at 4 Hz, one pause at 2 Hz (on-on-off-off)	BMC recovery/update in progress
BMC/BIOS blinking green at 1 Hz	Flash not detected or golden image checking failure

UID LED

The unit identifier LED connection is located on pin 3 of JFP1 on the X14DBHM motherboard.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Fail LED (Information LED for OH/FF/PF)

The Fail LED (Information LED for OH/Fan Fail/PWR Fail) connection, located on pin 4 of JFP1, provides warnings of overheating, power failure, or fan failure for the system.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Fail LED (Information LED) (OH/Fan Fail/PWR Fail) LED States	
Status	**Description**
Solid red (on)	An overheat condition has occurred.
Blinking red (1 Hz)	Fan failure: check for an inoperative fan.

Fail LED (Information LED) (OH/Fan Fail/PWR Fail) LED States	
Status	**Description**
Blinking red (0.25 Hz)	Power failure: check for a non-operational power supply.
Blinking red (10 Hz) (FP red LED)	CPLD recovery mode error(s).
Solid blue	UID has been activated locally. Use this function to locate a unit in the system that might be in need of service.
Blinking blue (1 Hz)	Local UID has been activated locally on. Use this function to identify a unit that might be in need of service.
BIOS/BMC blinking blue (10 Hz)	BIOS/BMC: recovery and/or update in progress.
Red Info LED blinking (10 Hz) and MB UID LED blue blinking (10 Hz)	CPLD: recovery and/or update in progress.

LAN1/LAN2 (NIC1/NIC2) LED

The Network Interface Controller (NIC) LED connection for LAN Port 1 is located on pin 6 of JFP1 on the X14DBHM motherboard, and LAN Port 2 is on pin 5.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

LAN1/LAN2 LED LED States	
Color	**State**
NIC 2: Blinking green	LAN 2: Active
NIC 1: Blinking green	LAN 1: Active

Storage Drive Activity LED

The storage drive activity LED connection is located on pin 7 of JFP1 on the X14DBHM motherboard. When this LED is blinking green, it indicates storage drive activity.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Storage Drive Activity LED LED State	
Color	**State**
Blinking Green	Storage Drive Activity

Standby Power LED

The LED indicator for standby power is located on pin 8 of JFP1 on the X14DBHM motherboard. If this LED is on, standby power is on.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Root of Trust (RoT) Power LED

The Power LED for the Root of Trust (RoT) connection is located on pin 9 of JFP1 on the X14DBHM motherboard. If this LED is on, power for the RoT chip is on.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Standby Power

A Standby Power (I²C) connection is located on pins 10– 14 of JFP1 on the X14DBHM motherboard to provide power to the system when it is in standby mode.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

+3.3 V Standby Power Pin Definitions: Five Total	
Pin#	**Definition**
10	+3.3 Standby
11	Ground
12	I²C Data
13	I²C Clock
14	Ground

Power Fail LED Indicators

Power Failure LED Indicators are located on pins 15 and 19 of JFP1 on the X14DBHM motherboard.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

FP Power LED Pin Definitions (JFP1)	
Pin#	**Definition**
15	PWR Failure LED-Positive
19	PWR Failure LED-Negative

Front Control Panel Header 2

In addition to front control panel header 1 (JFP1), front control panel header 2 (JFP3), also located on the front side of the chassis, provides additional functions, including USB 3.0 and DisplayPort support to the system.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

4.4 Rear I/O Connectors/Ports

4-pin BMC External I²C Header

A System Management Bus header for the BMC is located at JIPMB1 on the X14DBHM motherboard. Connect the appropriate cable here to use the IPMB I²C connection on your system.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Advanced I/O Module (AIOM) for I/O Support

A Supermicro proprietary Advanced I/O Module (AIOM) PCIe 5.0 x16 connector used for an add-on module is located at JAIOM1 (P1-AIOM PCIe 5.0 x16) and JAIOM2 (P2-AIOM PCIe 5.0 x16) on the X14DBHM motherboard. JAIOM1 is supported by CPU1 and JAIOM2 is supported by CPU2. This AIOM connector provides input/output connections on the I/O face of your system.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Backplane I²C NVMe Header

A backplane NVMe I²C header is located at JBPNI^{2}C1 on the front side of the X14DBHM motherboard.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

M.2 LEDs

M.2 LEDs are located at LED1 and LED2 on the X14DBHM motherboard. When these LEDs are blinking, the M.2 devices are functioning normally.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

M.2 LED State	
LED Color	**Definition**
Green: Blinking	Device Working

M.2 M-Key PCIe 5.0 x2 Slots

Two M.2 PCIe 5.0 x2 slots (M.2_C1, M.2_C2) are located on the rear side of the chassis. These M.2 slots support M.2 PCIe 5.0 x2 in the 2280/2110/22580/225110 form factors. M.2 allows for a variety of card sizes, increased functionality, and spatial efficiency. Four M.2 mounting holes (MH17, MH18, MH19, MH20) are used to support M.2 devices in different lengths.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Multi-Trak I/O PCIe 5.0 x8 Connectors

A Multi-Trak PCIe 5.0 x8 (in x16) slot is located at JSLOT6 on the rear side of the chassis. This slot is supported by CPU2.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

Multi-Trak I/O PCIe 5.0 x16 Connectors

Four Multi-Trak PCIe 5.0 x16 slots are located on the rear side of the system. P1-MXIO1 (JSLOT1) and P1-MXIO2 (JSLOT2) are supported by CPU1, while P2-MXIO4 (JSLOT4) and P2-MXIO5 (JSLOT5), by CPU2.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

NC-SI Connection

The Network Controller Sideband Interface (NC-SI) connection is located at JNCSI1 on the X14DBHM motherboard. This connection is used to connect a Network Interface Card (NIC) to the motherboard to allow the onboard Baseboard Management Controller (BMC) to communicate with a network.

Note: For detailed instructions on how to configure Network Interface Card (NIC) settings, refer to the Network Interface Card Configuration User's Guide posted on the web page under the link: https://www.supermicro.com/support/manuals.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

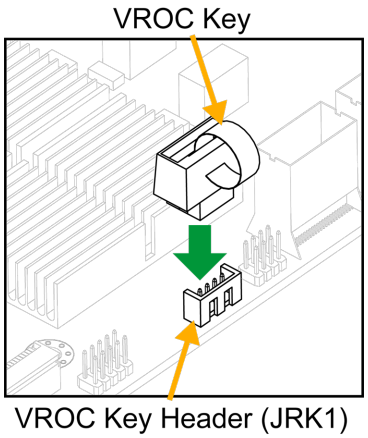
DC-SCM Connector

There is a DC-SCM connector located at JDCSCM on the X14DBHM motherboard. A Supermicro proprietary DC-SCM board can be connected to the DC-SCM connector to provide support for BMC functions for your system.

VROC RAID Key Header

A VROC RAID Key header is located at JRK1 on the X14DBHM motherboard. Install a VROC RAID key on JRK1 for NVMe RAID support as shown in the illustration below.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.



Intel VROC Key Pin Definitions: Four Total	
Pin#	**Definition**
1	GND
2	+3.3 V Standby
3	GND
4	CPU RAID Key

Note: Images displayed are for illustrative purposes only. The components installed in your system may or may not look exactly the same as the graphics shown in the manual.

Note: For detailed instructions on how to configure VROC RAID settings, refer to the VROC RAID Configuration User's Guide posted on the web page under the following link: https://www.supermicro.com/support/manuals.

4.5 Jumper Settings

To modify the operation of the motherboard, jumpers can be used to choose between optional settings. Jumpers create shorts between two pins to change the function of the connector. Pin 1 is identified with a square solder pad on the printed circuit board. See the diagram below for an example of jumping pins 1 and 2. Refer to the motherboard layout page for jumper locations.

Note: On two-pin jumpers, "Closed" means the jumper is on and "Open" means the jumper is off the pins.

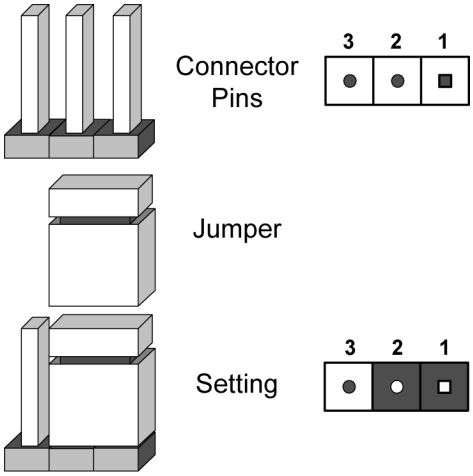


Figure 4-2. Jumping Connector Pins

CMOS Clear

JBT1 on the X14DBHM motherboard is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.



1. First power down the system and unplug the power cord(s).
2. Remove the cover of the chassis to access the motherboard.
3. Remove the onboard battery from the motherboard.

4. Short the CMOS pads, JBT1, with a metal object such as a small screwdriver for at least four seconds.

   Note: Clearing CMOS will also clear all passwords.

5. Remove the screwdriver (or shorting device).
6. Replace the cover, reconnect the power cord(s), and power on the system.

UID LED and System_Reset Button Select Jumper

Jumper JRU1 on the X14DBHM motherboard is used in conjunction with pin 2 of Front Control Panel header 1 (JFP1) to function as a System_Reset button or a UID LED button. To configure pin 2 of JFP1 for front UID button use in a chassis that supports front UID connection, close pins 2 and 3 of jumper JRU1. To set pin 2 of JFP1 for system reset support, close pins 1 and 2 of jumper JRU1.

For a detailed diagram of the X14DBHM motherboard, see the layout under "Motherboard Quick Reference" on page 28.

UID Switch/Reset Button Select Jumper (JRU1) Jumper Settings	
State	**Description**
Close pins 1 and 2 of JRU1	Pin 2 of JFP1: used for System Reset
Close pins 2 and 3 of JRU1	Pin 2 of JFP1: used for UID switch support **(Default)**

4.6 LED Indicators

For information about the LED indicators on the SYS-222C-TN server, refer to the following content.

M.2 LEDs

Refer to the M.2 Section for M.2 LED information.

Chapter 5:

Software

After the SYS-222C-TN server has been installed, you can install the Operating System (OS), configure RAID settings, and install the drivers.

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5.2 Driver Installation **130**

5.3 BMC **132**

Logging into the BMC **132**

5.1 Microsoft Windows OS Installation

If you will be using RAID, you must configure RAID settings before installing the Windows OS and the RAID driver. Refer to the RAID Configuration User Guides posted on our website at https://www.supermicro.com/support/manuals.

Installing the OS

1. Create a method to access the Microsoft Windows installation ISO file. That can be a USB flash or media drive, or the BMC KVM console.
2. Retrieve the proper drivers. Go to the Supermicro web page for your motherboard and click on "Download the Latest Drivers and Utilities," select the proper driver, and copy it to a USB flash drive.
3. Boot from a bootable device with Windows OS installation. You can see a bootable device list by pressing <F11> during the system bootup.

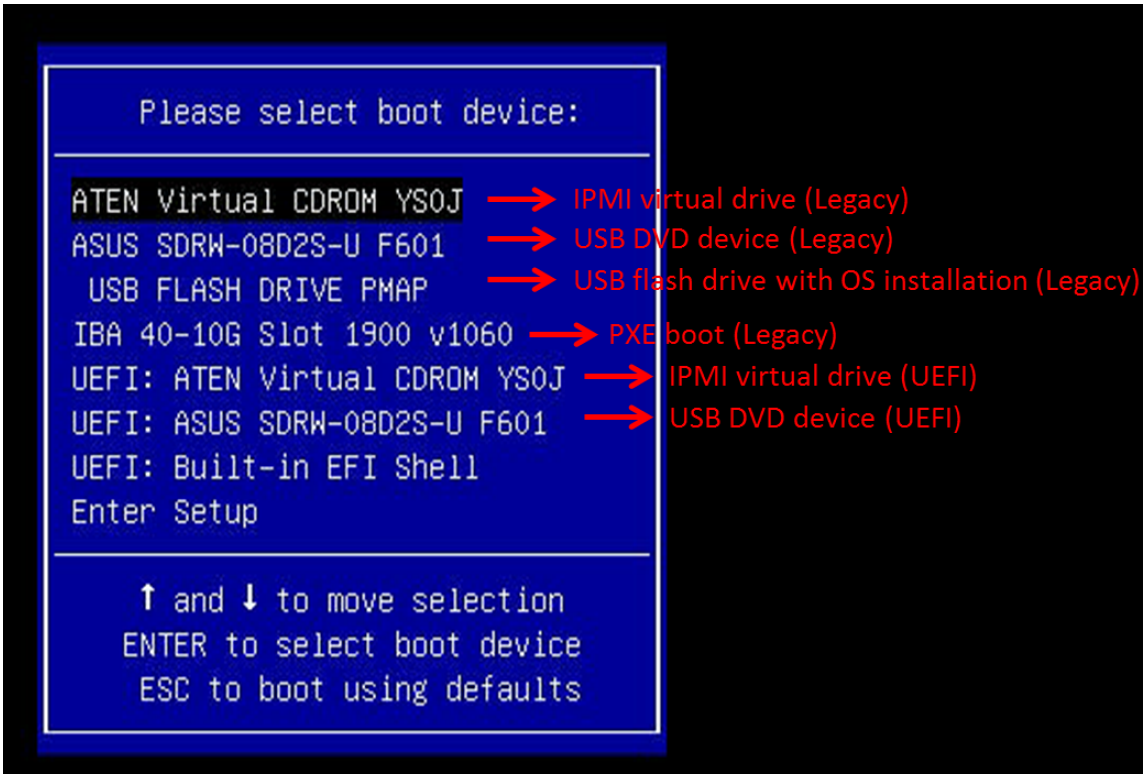


Figure 5-1. Selecting the Boot Device

4. During Windows Setup, continue to the dialog box where you select the drives on which to install Windows. If the disk you want to use is not listed, click on the “Load driver” link at the bottom left corner.

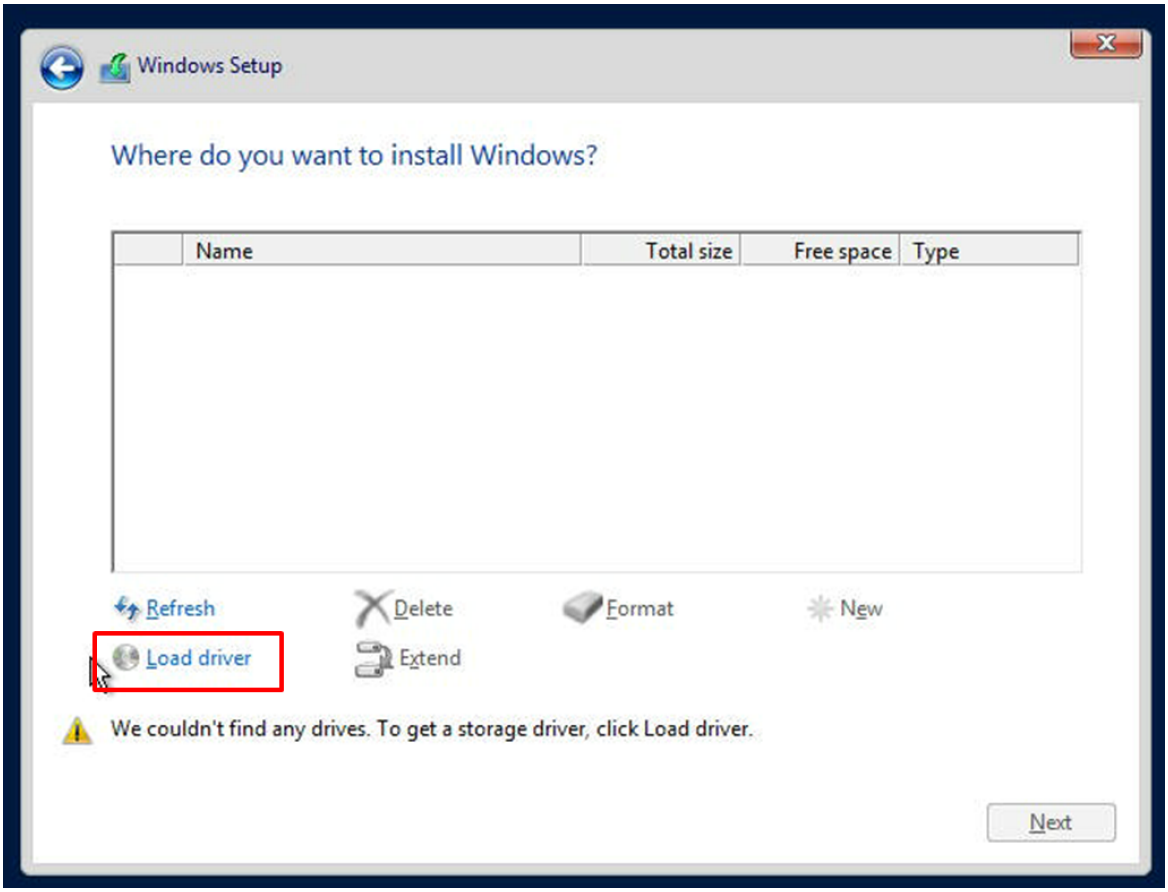


Figure 5-2. Loading the Driver Link

To load the driver, browse the USB flash drive for the proper driver files.

5. Once all devices are specified, continue with the installation.
6. After the Windows OS installation has completed, the system will automatically reboot multiple times for system updates.

5.2 Driver Installation

The Supermicro website contains drivers and utilities for your system at the following page:

https://www.supermicro.com/wdl.

Some of these drivers and utilities must be installed, such as the chipset driver. After accessing the website, go into the CDR_Images (in the parent directory of the above link) and locate the ISO file for your motherboard. Download this file to a USB flash or media drive. You may also use a utility to extract the ISO file if preferred.

Another option is to go to the Supermicro website at https://www.supermicro.com. Find the product page for your motherboard and download the latest drivers and utilities. Insert the flash drive or disk, and the screenshot shown below should appear.

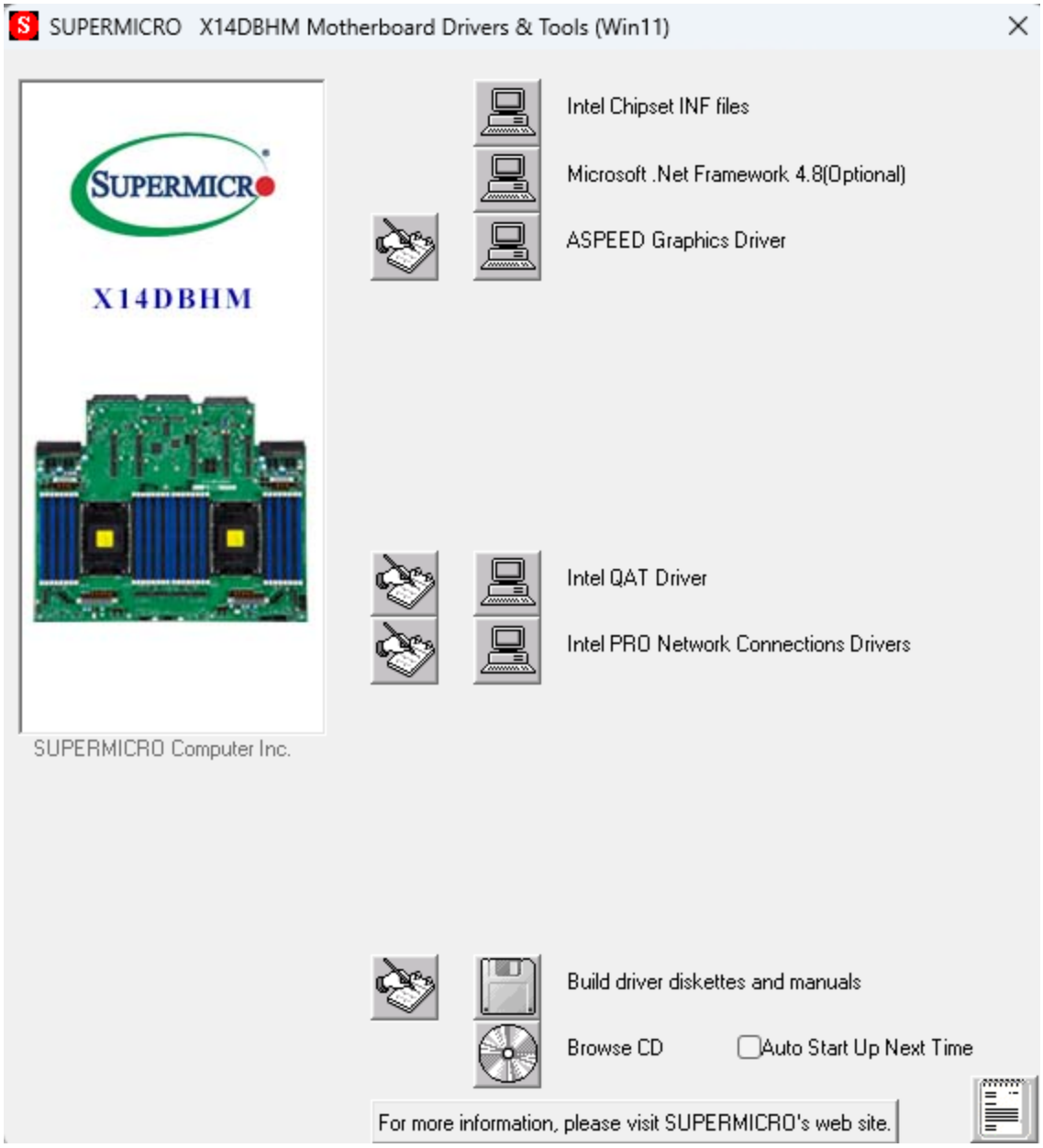


Figure 5-3. Driver and Tools Installation Screen

Note: Click the icons showing a hand writing on paper to view the readme files for each item. Click the computer icons to the right of these items to install each item (from top to bottom) one at a time. *After installing each item, you must reboot the system before moving on to the next item on the list.* The bottom icon with a CD on it allows you to view the entire contents.

5.3 BMC

Use this menu to configure Baseboard Management Console (BMC) settings.



Figure 5-4. BMC Screen

BMC Firmware Revision

This feature indicates the BMC firmware revision used in this system.

BMC STATUS

This feature indicates the status of the BMC firmware installed in this system.

Logging into the BMC

Supermicro ships standard products with a unique password for the BMC ADMIN user. This password can be found on a label on the motherboard.

When logging in to the BMC for the first time, use the unique password provided by Supermicro to log in. You can change the unique password to a user name and password of your choice for subsequent logins.

For more information regarding BMC passwords, visit our website at https://www.supermicro.com/en/support/BMC_Unique_Password.

Chapter 6:

Optional Components

This chapter describes alternate configurations and optional system components for the SYS-222C-TN server.

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6.2 RAID Cards **136**
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Creating NVMe RAID Configurations 143

6.1 HBA Card

This is a 12 Gb/s, multi-port SAS PCIe Gen 4.0 internal Host Bus Adapter (HBA) card.

The Supermicro HBA AOC-S3816L-L16iT features 16 internal SAS connectors, while the AOC-S3808L-L8iT features eight internal SAS connectors. Both are designed for high-performance storage connectivity.

These cards use Broadcom's 3816 and 3808 I/O processors for optimum performance with PCI Express Gen 4.0 host interface for increased bandwidth.

Each Add-On-Card supports up to 122 devices as HBA in IT mode via the expander backplane.

6.2 RAID Cards

These are Super Micro Computer, Inc. 12 Gb/s, multi-port PCIe Gen 4.0 RAID adapter cards.

The low-profile AOC-S3908L-H8iR RAID card features eight internal SAS connectors and the AOC-S3916L-H16iR features 16 internal SAS connectors. Both offer high-performance storage connectivity. These RAID cards are built on the Broadcom SAS IC technology and MegaRAID technology to address the growing demand for increased data throughput and scalability requirements across the enterprise-class server platforms.

With high-performance RAID architecture, including hardware RAID 5 and 6, these RAID controller cards support high capacity storage applications. They deliver cost-effective storage solutions using SATA drives and maximum performance and reliability with SAS drives. Using expander backplanes, they support up to 16, 32, and 240 drives (depending on SKU) with RAID 0, 1, 5, 6, 10, 50, and 60.

6.3 TPM Security Module

This is an SPI-capable TPM 2.0 with Infineon 9672 controller.

The JTPM1 header is used to connect a Trusted Platform Module (TPM). A TPM is a security device that supports encryption and authentication in storage drives. It enables the X14DBHM motherboard to deny access if the TPM associated with the storage drive is not installed in the SYS-222C-TN server.

For details and installation procedures, refer to the following page:

https://www.supermicro.com/en/products/accessories/addon/AOM-TPM-9672V.php

- AOM-TPM-9672V (TCG 2.0)

6.4 Intel Virtual RAID on CPU (VROC)

Intel® Virtual RAID on CPU (Intel VROC) is an enterprise RAID solution for NVMe SSDs directly attached to Intel Xeon Scalable processors. Intel Volume Management Device (VMD) is an integrated controller inside the CPU PCIe root complex.

- A single processor supports up to 12 NVMe SSDs and up to 6 RAID arrays.
- A dual processor system supports up to 24 NVMe SSDs and 12 RAID arrays.

Stripe sizes are 4K, 8K, 16K, 32K, 64K, 128K.

Requirements and Restrictions

- *Intel VROC is only available when the system is configured for UEFI boot mode.*
- To enable the **mdadm** command and support for RSTe, install the patch from
  - Linux: https://downloadcenter.intel.com/download/28158/Intel-Virtual-RAID-on-CPU-Intel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Linux-
  - Windows: https://downloadcenter.intel.com/download/28108/Intel-Virtual-RAID-on-CPU-Intel-VROC-and-Intel-Rapid-Storage-Technology-enterprise-Intel-RSTe-Driver-for-Windows-
- To enable Intel VROC, a hardware key must be inserted on the motherboard, and the appropriate processor's Virtual Management Devices must be enabled in the BIOS setup.
- It is possible to enable Intel VROC without a hardware key installed, but only RAID0 will be enabled.
- Intel VROC is not compatible with secure boot. This feature must be disabled.
- When creating bootable OS RAID1 devices, you must have both devices on the same CPU, and a VMD on that CPU.
- Spanning drives when creating RAID devices is not recommended due to performance issues, even though it is supported.

Additional Information

- Latest SSD and operating system information: https://www.intel.com/content/www/us/en/support/articles/000030310/memory-and-storage/ssd-software.html

- Additional information for the Supermicro add-on card and linked manuals: https://www.supermicro.com/products/accessories/addon/AOC-VROCxxxMOD.cfm

Hardware Key

The Intel VROC hardware key is a license key that detects the Intel VROC SKU and activates the function accordingly. The key must be plugged into the Supermicro motherboard (connector JRK1). The key options are:

Intel® VROC Keys			
VROC Package	**Description**	**Part Number**	**Intel MM Number**
Standard	RAID 0, 1, 10 Supports 3rd party SSDs	AOC-VROCSTNMOD	951605
Premium	RAID 0, 1, 5, 10 Supports 3rd party SSDs	AOC-VROCPREMOD	951606

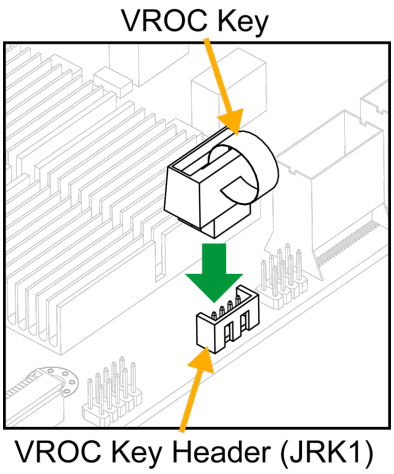


Figure 6-1. Intel VROC RAID Key and Motherboard Connector JRK1

Configuring Intel VMD

VMD must be enabled on PCIe ports which have NVMe drives attached to them in order for those drives to be added to a VROC RAID configuration. The default BIOS setting for the NVMe Mode Switch is Auto which automatically enables VMD on all installed NVMe drives.

NVMe Mode Switch:

- Auto: Enables VMD for all NVMe ports if VROC Key is installed.
- VMD: Enables VMD for all NVMe ports despite the lack of the VROC Key.
- Manual: Allows the user to select specific NVMe ports on which to enable VMD.

The NVMe Mode Switch can be viewed or selected at BIOS > Advanced > Chipset Configuration > North Bridge > IIO Configuration > Intel® VMD Technology.

Note: Without a VROC Key, there is no RAID support with the Auto switch. Only RAID 0 is supported with the VMD and Manual switches.

Configuring VMD Manually

The steps for manually configuring VMD on specific NVMe ports in UEFI BIOS are shown below. Example screenshots may differ from your server.

Important:

- If there is an existing RAID configuration, delete the RAID volume associated with the VMD controller before disabling the controller. Failure to do so may lead to unexpected behavior.
- The effects of physically changing or swapping a CPU on the VMD controller have not been thoroughly tested or documented.

1. Reboot the server and press [DEL] key to access the BIOS options.
2. Switch to Advanced > Chipset Configuration > North Bridge > IIO Configuration > Intel® VMD Technology.
3. Select VMD Mode Switch, then select Manual.

   Note that Socket 0 contains CPU1; Socket 1 contains CPU2.

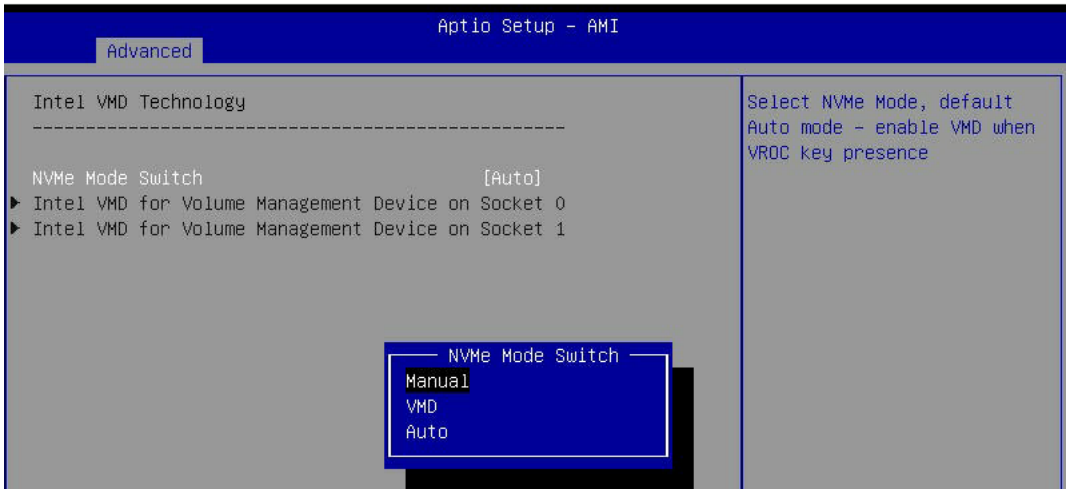


Figure 6-2. BIOS, Selecting VMD Mode

4. VMD must only be enabled on NVMe port resources. If VMD is enabled on other PCIe ports, the functionality of those ports will be impacted. See the table below.

   Select “Intel VMD for Volume Management Device on” on Socket 0 (CPU1) or Socket 1 (CPU2) to enable VMD for devices under the respective CPU.

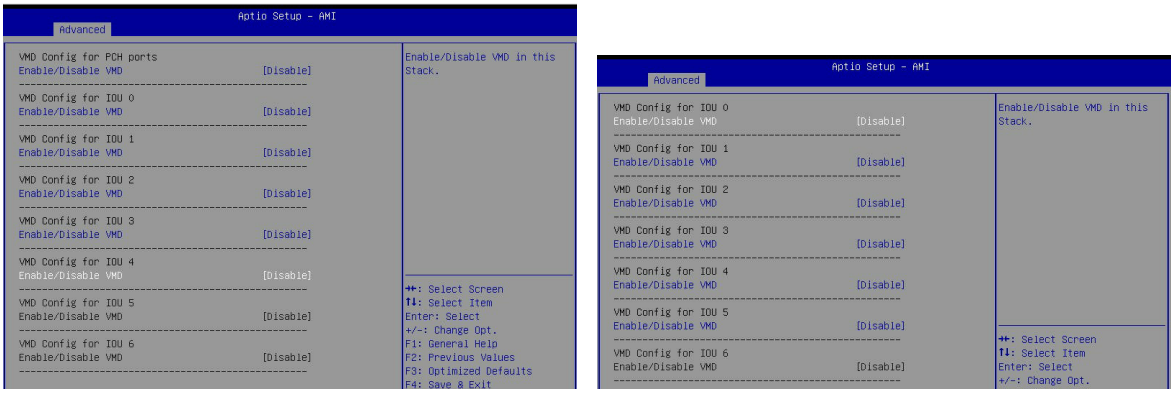


Figure 6-3. Intel VMD for Volume Management Device on Socket 0 and Socket 1

5. Choose Enable for “Enable/Disable VMD” for IOU 3 to list the available devices under IOU 3.

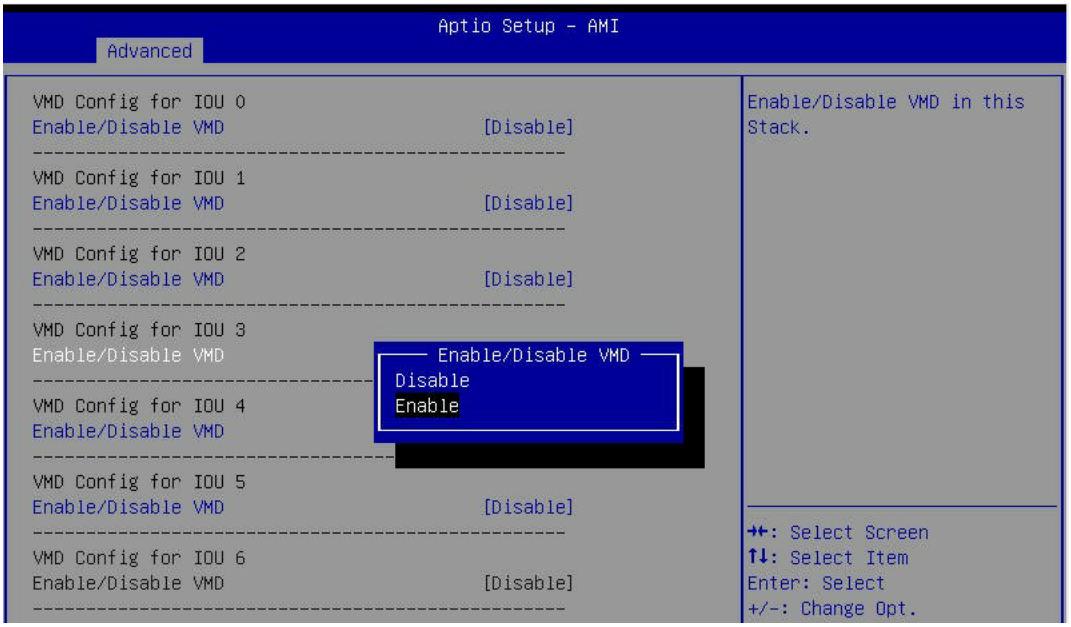


Figure 6-4. BIOS, Enabling VMD on Socket 1 (CPU2) (Example)

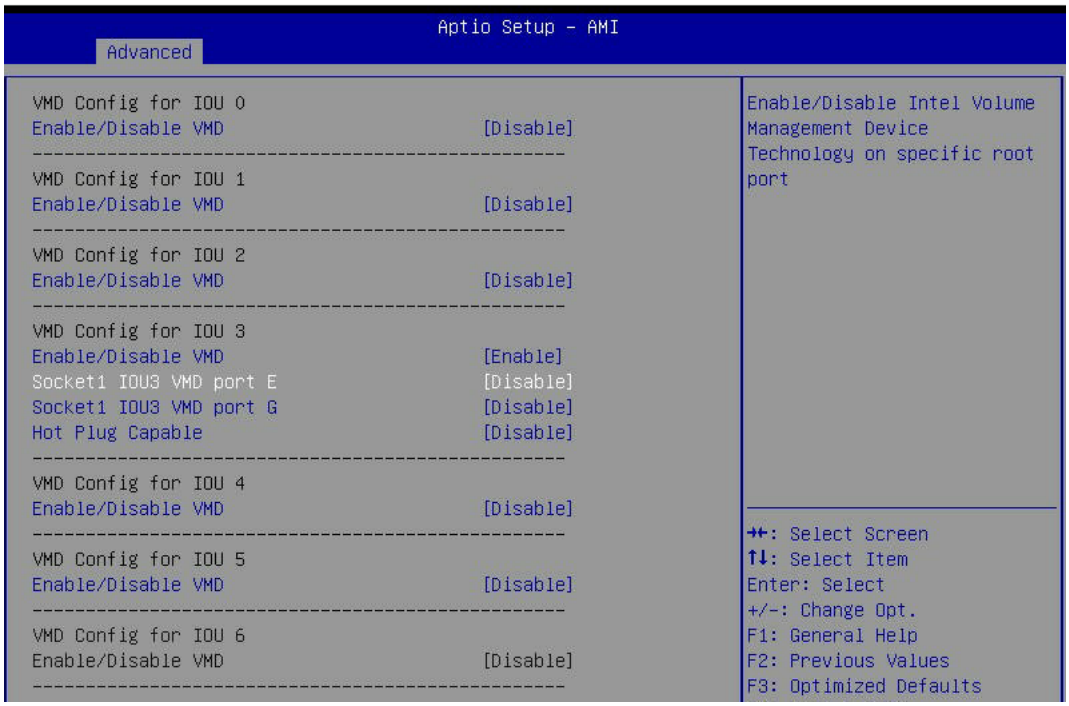


Figure 6-5. BIOS, Enabling VMD on Socket 1 (Example)

6. Enable the NVMe port resource according to table above for the NVMe drives that will be used in a RAID configuration.

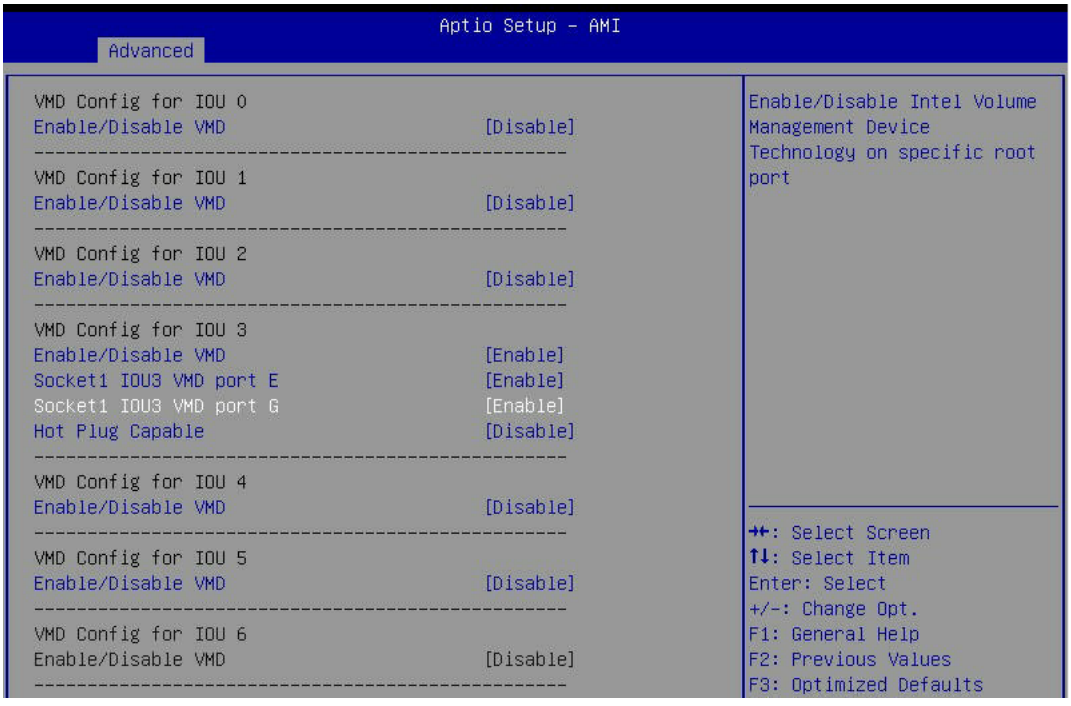


Figure 6-6. BIOS, Enabling Socket 1 (Example)

7. Choose whether to make the NVMe drives in this IOU Hot Plug Capable by selecting Enabled or Disabled.
8. Repeat steps 4 through 7 for each IOU # on each CPU to enable VMD on the desired NVMe ports.

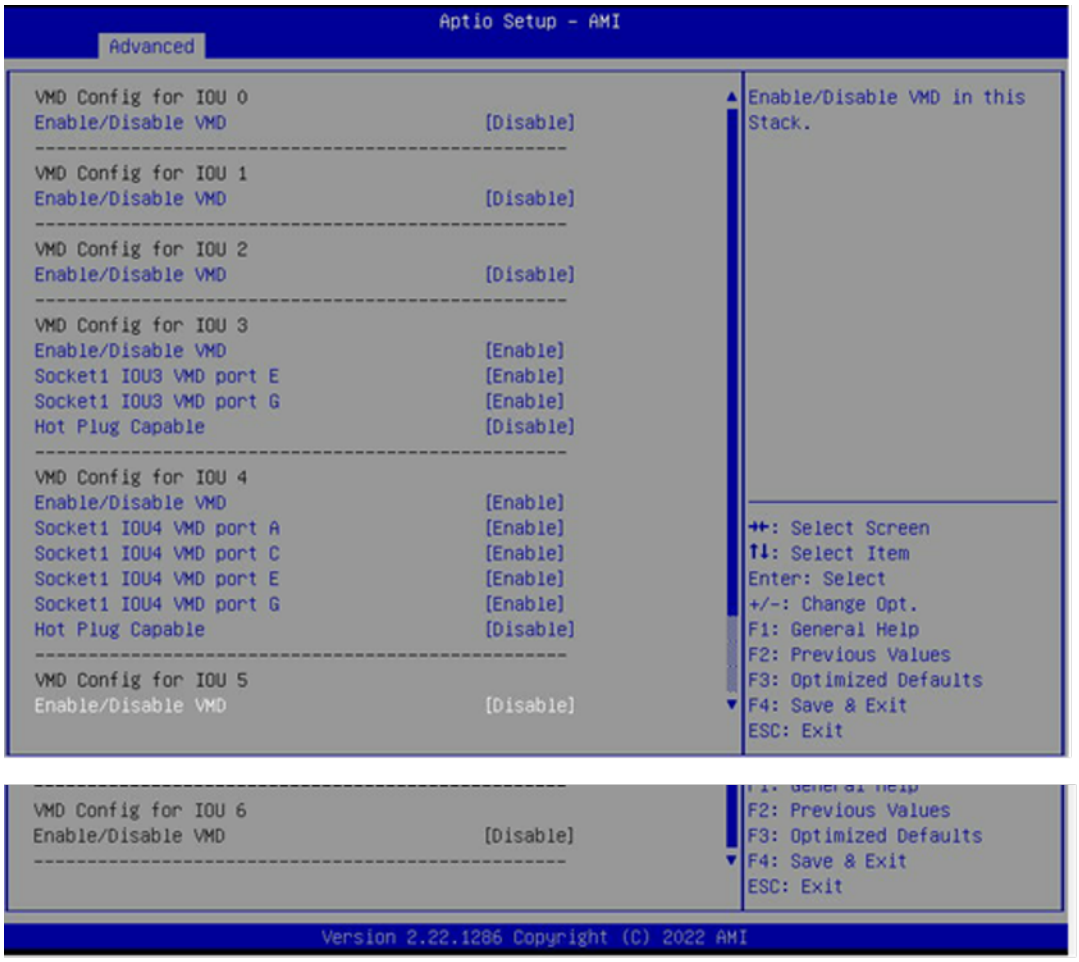


Figure 6-7. BIOS, Enabling Socket 1 Completed (Example)
(This example shows SYS-621H-TN12R with 12 NVMe. Other systems will look different.)

9. Press [F4] to save the configuration and reboot the system.

Creating NVMe RAID Configurations

1. Open Advanced > Intel(R) Virtual RAID on CPU > All Intel VMD Controllers > Create RAID Volume.

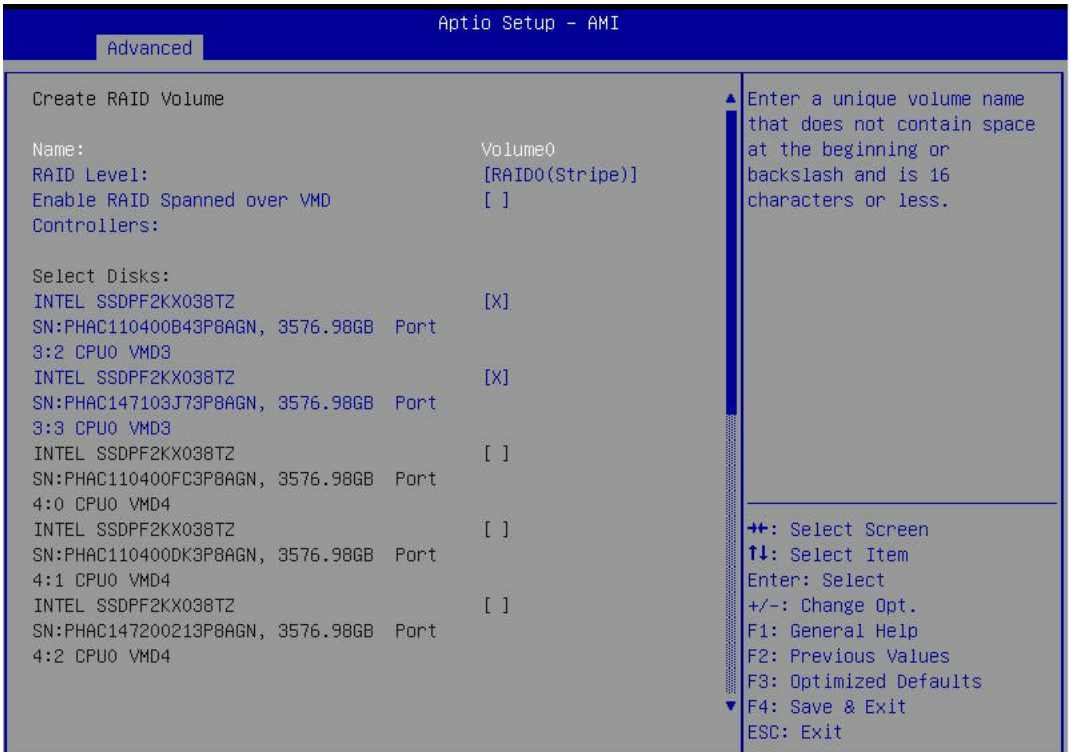


Figure 6-8. Creating Volume Without Enabling RAID Spanned over VMD Controller

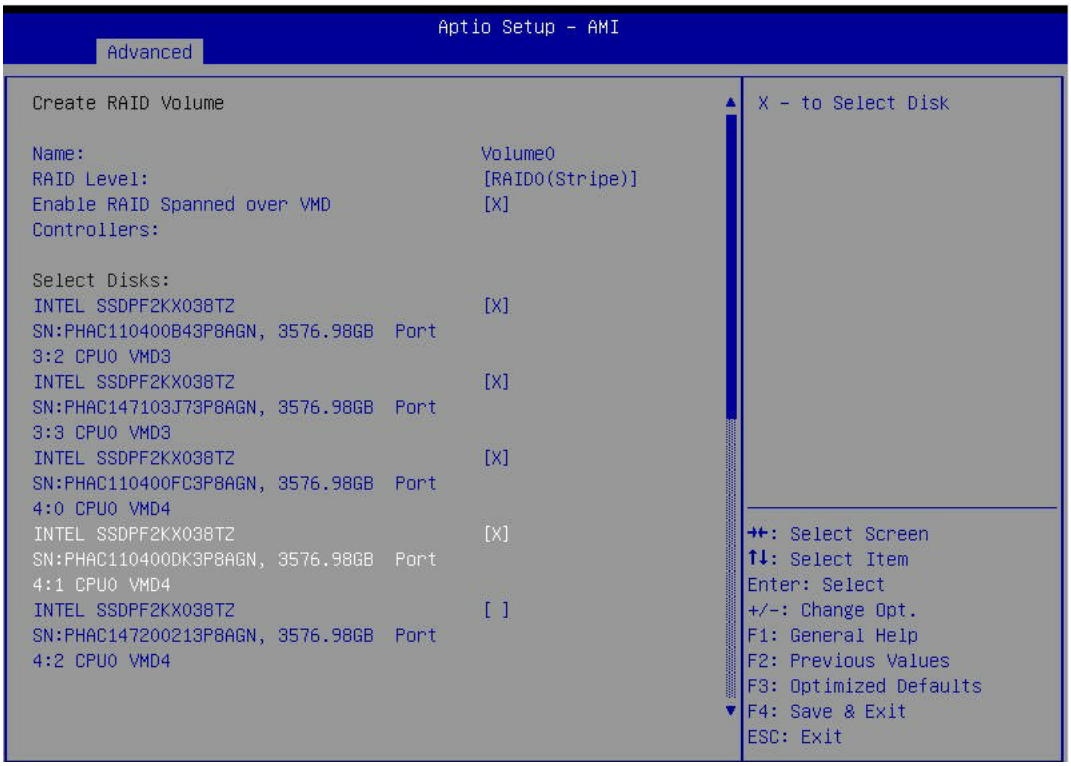


Figure 6-9. Creating Volume With Enabling RAID Spanned over VMD Controller

2. Set Name.
3. Set RAID Level.
4. If cross-controller RAID is required, select Enable RAID spanned over VMD Controller.
5. Select specific disks for RAID with an [X].
   - RAID0: Select at least two [2–24] disks
   - RAID1: Select only two disks
   - RAID5: Select at least three [3–24] disks
   - RAID10: Select only four disks
6. Select Strip Size (Default 64 KB).
7. Select Create Volume.
8. If another RAID is needed, start again at step 1.

Status Indications

An LED indicator on the drive carrier shows the RAID status of the drive.

Drive Carrier Status LED Indicator	
Status	**State (red)**
Normal function	Off
Locating	4 Hz blinking
Fault	Solid on
Rebuilding	1 Hz blinking
IBPI SFF 8489 Defined Status LED States	

Hot-Swap Drives

Intel VMD enables hot-plug and hot-unplug for NVMe SSDs, whether from Intel or other manufacturers. Under vSphere ESXi, several steps are necessary to avoid potential stability issues. See the information at link [1] below.

Hot-Unplug

1. Prevent devices from being re-detected during rescan:

   ```
   esxcli storage core claiming autoclaim --enabled=false
   ```

2. Unmount the VMFS volumes on the device. Check link [2] below for details.

3. Detach the device. Check link [3] below for details.
4. Physically remove the device.

Hot-Plug

- Physically install the device.

ESXi will automatically discover NVMe SSDs, but a manual scan may be required in some cases.

Related Information Links

1. https://kb.vmware.com/s/article/2151404
2. https://docs.vmware.com/en/VMware-vSphere/6.5/com.vmware.vsphere.storage.doc/GUID-1B56EF97-F60E-4F21-82A7-8F2A7294604D.html
3. https://docs.vmware.com/en/VMware-vSphere/6.5/com.vmware.vsphere.storage.doc/GUID-F2E75F67-740B-4406-9F0C-A2D99A698F2A.html

Chapter 7:

Troubleshooting and Support

The following content contains information on common issues and how to resolve them.

7.1 Online Resources **148**
7.2 Baseboard Management Controller (BMC) **149**
7.3 Troubleshooting Procedures **150**
Before Power On 150
No Power 150
No Video 150
System Boot Failure 150
Memory Errors 151
Losing the System's Setup Configuration 151
If the System Becomes Unstable 151
7.4 CMOS Clear **153**
7.5 Motherboard Battery **154**
7.6 Where to Get Replacement Components **155**
7.7 Technical Support Procedures **156**
Returning Merchandise for Service 156
7.8 Feedback **158**

7.1 Online Resources

A great deal of information is available on the Supermicro website. From the top menu of the Supermicro home page at https://www.supermicro.com:

- Specifications for servers and other hardware are available by clicking **Products**.
- The **Support** option offers downloads (manuals, BIOS/BMC, drivers, etc.), FAQs, RMA, warranty, and other service extensions.

Direct Links for the SYS-222C-TN System

- SYS-222C-TN specifications page
- X14DBHM motherboard page for links to the Quick Reference Guide, User Manual, validated storage drives, etc.

Direct Links for General Support and Information

- Frequently Asked Questions: https://www.supermicro.com/FAQ/index.php
- TPM User Guide: https://www.supermicro.com/manuals/other/AOM-TPM-9670V_9670H__X12_H12.pdf
- Product Resources page for validated memory details: https://www.supermicro.com/support/resources/mem.cfm
- Product Matrices page for links to tables summarizing specs for systems, motherboards, power supplies, riser cards, add-on cards, and more: https://www.supermicro.com/en/support/product-matrices
- Security Center for recent security notices: https://www.supermicro.com/en/support/security_center
- Supermicro Phone and Addresses: https://www.supermicro.com/en/about/contact

7.2 Baseboard Management Controller (BMC)

The SYS-222C-TN server supports the Baseboard Management Controller (BMC). BMC is used to provide remote access, monitoring, and management. There are several BIOS settings that are related to BMC.

For general documentation and information on BMC, visit our website at the following page:

https://www.supermicro.com/en/solutions/management-software/bmc-resources

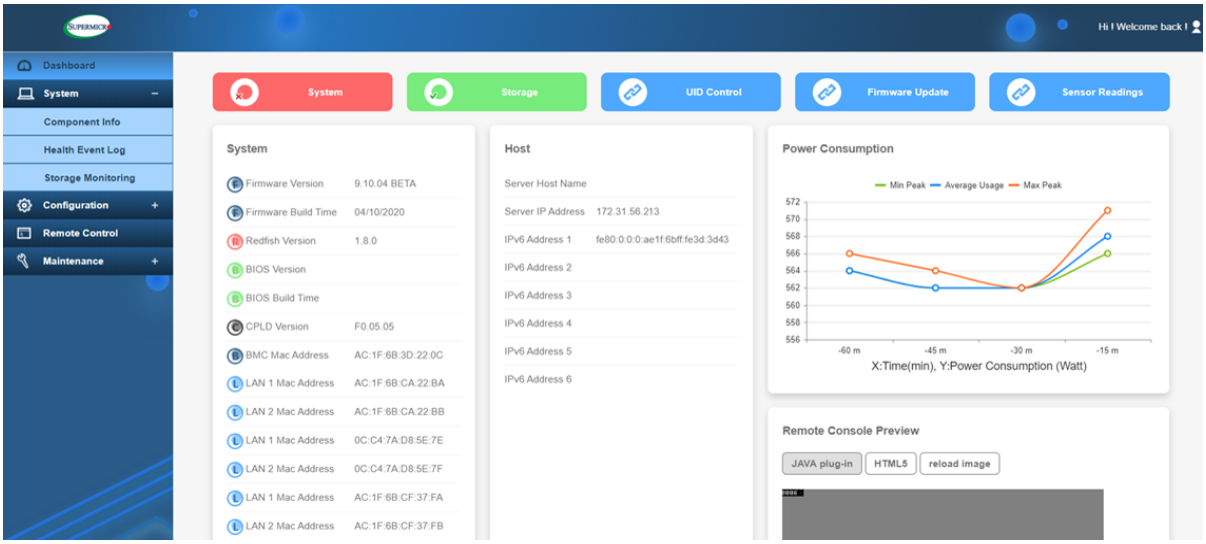


Figure 7-1. BMC Dashboard

7.3 Troubleshooting Procedures

Use the following procedures to troubleshoot your system. If you have followed all of the procedures below and still need assistance, refer to the "Technical Support Procedures" on page 156 section in this chapter. Always disconnect the AC power cord before adding, changing or installing any non hot-swap hardware components. If the below steps do not fix the setup configuration problem, contact your vendor for repairs.

Before Power On

1. Make sure that there are no short circuits between the motherboard and chassis.
2. Disconnect all ribbon/wire cables from the motherboard, including those for the keyboard and mouse.
3. Remove all add-on cards.
4. Install the processor (making sure it is fully seated) and connect the front panel connectors to the motherboard.

No Power

1. Make sure that there are no short circuits between the motherboard and the chassis.
2. The battery on your motherboard may be old. Check to verify that it still supplies approximately 3 VDC. If it does not, replace it with a new one.

No Video

1. If the power is on, but you do not have video, remove all add-on cards and cables.
2. Remove all memory modules and turn on the system (if the alarm is on, check the specs of memory modules, reset the memory, or try a different one).

System Boot Failure

If the system does not display Power-On-Self-Test (POST) or does not respond after the power is turned on, do the following:

1. Remove all components from the motherboard, especially the DIMMs. Power on the system and check if the power-on LED and the BMC Heartbeat LED are on, and system fans are spinning.

2. Turn on the system with only one DIMM installed. If the system boots, check for bad DIMMs or slots by following the Memory Errors Troubleshooting procedure in this chapter.

Memory Errors

When suspecting faulty memory is causing the system issue, check the following:

1. Make sure that the memory modules are compatible with the system and are properly installed. See "Maintenance and Component Installation" on page 51 for installation instructions. (For memory compatibility, refer to the "Tested Memory List" link on the motherboard's product page to see a list of supported memory.)
2. Check if different speeds of DIMMs have been installed. It is strongly recommended that you use the same RAM type and speed for all DIMMs in the system.
3. Make sure that you are using the correct type of DIMMs recommended by the manufacturer.
4. Check for bad DIMMs or slots by swapping a single module among all memory slots and check the results.

Losing the System's Setup Configuration

1. Make sure that you are using a high-quality power supply. A poor-quality power supply may cause the system to lose the CMOS setup information. Refer to "Introduction" on page 14 for details on recommended power supplies.
2. The battery on your motherboard may be old. Check to verify that it still supplies approximately 3 VDC. If it does not, replace it with a new one.

If the System Becomes Unstable

If the system becomes unstable during or after OS installation, check the following:

1. Processor/BIOS support: Make sure that your processor is supported and that you have the latest BIOS installed in your system.
2. Memory support: Make sure that the memory modules are supported. Refer to the product page on our website at https://www.supermicro.com. Test the modules using memtest86 or a similar utility.

   Note: Click on the "Tested Memory List" link on the motherboard's product page to see a list of supported memory.

3. Storage Drive support: Make sure that all storage drives work properly. Replace the failed storage drives with good ones.
4. System cooling: Check the system cooling to make sure that all heatsink fans and processor/system fans, etc., work properly. Check the hardware monitoring settings in the BMC to make sure that the processor and system temperatures are within the normal range. Also, check the front panel Overheat LED and make sure that it is not on.
5. Adequate power supply: Make sure that the power supply provides adequate power to the system. Make sure that all power connectors are connected. Refer to our website for more information on the minimum power requirements.
6. Proper software support: Make sure that the correct drivers are used.

If the system becomes unstable before or during OS installation, check the following:

1. Source of installation: Make sure that the devices used for installation are working properly, including boot devices such as a CD/Media drive.
2. Cable connection: Check to make sure that all cables are connected and working properly.
3. Use the minimum configuration for troubleshooting: Remove all unnecessary components (starting with add-on cards first), and use the minimum configuration (but with the processor and a memory module installed) to identify the trouble areas. Refer to the steps listed above in this section for proper troubleshooting procedures.
4. Identify bad components by isolating them: If necessary, remove a component in question from the chassis, and test it in isolation to make sure that it works properly. Replace a bad component with a good one.
5. Check and change one component at a time instead of changing several items at the same time. This will help isolate and identify the problem.
6. To find out if a component is good, swap this component with a new one to see if the system will work properly. If so, then the old component is bad. You can also install the component in question in another system. If the new system works, the component is good and the old system has problems.

7.4 CMOS Clear

JBT1 on the X14DBHM motherboard is used to clear CMOS, which will also clear any passwords. For information on clearing CMOS, refer to "CMOS Clear" on page 124 earlier in this manual.

7.5 Motherboard Battery

For information on removing, disposing of, and replacing the motherboard battery of your system, refer to "Motherboard Battery Removal and Installation" on page 84.

7.6 Where to Get Replacement Components

If you need replacement parts for your SYS-222C-TN server, to ensure the highest level of professional service and technical support, purchase exclusively from our Supermicro Authorized Distributors/System Integrators/Resellers. A list can be found on the Supermicro website:

https://www.supermicro.com

Under the "Buy" menu, click the "Where to Buy" link.

7.7 Technical Support Procedures

Before contacting Technical Support, take the following steps. Also, note that as a motherboard manufacturer, Supermicro also sells motherboards through its channels, so it is best to first check with your distributor or reseller for troubleshooting services. They should know of any possible problems with the specific system configuration that was sold to you.

1. Refer to "Troubleshooting Procedures" on page 150 or see the FAQs on our website (https://www.supermicro.com/FAQ/index.php) before contacting Technical Support.
2. BIOS upgrades can be downloaded from our website (https://www.supermicro.com/support/resources/bios_ipmi.php).
3. If you still cannot resolve the problem, include the following information when contacting Supermicro for technical support:
   - Motherboard model and PCB revision number
   - BIOS release date/version (This can be seen on the initial display when your system first boots up.)
   - System configuration
4. An example of a Technical Support form is on our website at https://webpr3.supermicro.com/SupportPortal.
5. Distributors: For immediate assistance, have your account number ready when placing a call to our Technical Support department. For Supermicro contact information, refer to "Contacting Supermicro" on page 13.

Returning Merchandise for Service

A receipt or copy of your invoice marked with the date of purchase is required before any warranty service will be rendered. You can obtain service by calling your vendor for a Returned Merchandise Authorization (RMA) number. When returning the server to the manufacturer, the RMA number should be prominently displayed on the outside of the shipping carton, and the shipping package is mailed prepaid or hand-carried. Shipping and handling charges will be applied for all orders that must be mailed when service is complete.

For faster service, RMA authorizations can be requested online at the following page:

https://www.supermicro.com/RmaForm

Whenever possible, repack the server in the original Supermicro carton, using the original packaging material. If these are no longer available, be sure to pack the server securely, using packaging material to surround the server so that it does not shift within the carton and become damaged during shipping.

This warranty only covers normal consumer use and does not cover damages incurred in shipping or from failure due to the alternation, misuse, abuse or improper maintenance of products.

During the warranty period, contact your distributor first for any product problems.

7.8 Feedback

Supermicro values your feedback as we strive to improve our customer experience in all facets of our business. Email us at Techwriterteam@supermicro.com to provide feedback on our manuals.

Chapter 8:

UEFI BIOS

The following content contains information on BIOS configuration with the SYS-222C-TN server.

8.1 Introduction **160**

8.2 Main Setup **162**

8.3 Advanced Setup Configurations **164**

8.4 Event Logs **202**

8.5 BMC **204**

8.6 Security **208**

8.7 Boot **213**

8.8 Save & Exit **215**

8.1 Introduction

This chapter describes the AMIBIOS™ Setup utility for the motherboard. The BIOS is stored on a chip and can be easily upgraded using the UEFI script (flash.nsh), the BMC WebUI, or the SuperServer Automation Assistant (SAA) utility.

Note: Due to periodic changes to the BIOS, some settings may have been added or deleted and might not yet be recorded in this manual. Refer to the Manual Download area of our website for any changes to BIOS that may not be reflected in this manual.

Updating BIOS

It is recommended that you do not upgrade your BIOS if you are not experiencing any problems with your system. Updated BIOS files are located on our website at the following page:

https://www.supermicro.com/support/resources/bios_ipmi.php

Check our BIOS warning message and the information on how to update your BIOS on our website. Select your motherboard model and download the BIOS file to your computer. Also, check the current BIOS revision to make sure that it is newer than your BIOS before downloading.

Important: Do not shut down or reset the system while updating the BIOS to prevent possible system boot failure! Read the motherboard README file carefully before you perform the BIOS update.

To update the BIOS under the UEFI Shell, unzip the BIOS file onto a bootable USB device and then boot into the built-in UEFI Shell. For motherboards with BMC support, type "flash.nsh <BIOS filename><BMC Username><BMC Password>" to start the BIOS update. The flash.nsh script will invoke the SAA (EFI) tool automatically to perform the BIOS update, beginning with uploading the BIOS image to BMC. After uploading the BIOS image, the system will reboot to continue the process. The BMC will take over and continue the BIOS update in the background. The process will take 3–5 minutes. Refer to the README file for more information.

Starting the Setup Utility

To enter the BIOS Setup utility, press the <Delete> key while the system is booting-up. In most cases, the <Delete> key is used to invoke the BIOS Setup screen. There are a few cases when other hot keys are used, such as <F1>, <F2>, etc. Each main BIOS menu option is described in this manual.

The Main BIOS screen has two main frames. The left frame displays all the options that can be configured. “Grayed-out” options cannot be configured. The right frame displays the key legend. Above the key legend is an area reserved for a text message. When a BIOS submenu or item is selected in the left frame, it is highlighted in white. Often a text message will accompany it. (Note that BIOS has default text messages built in. We retain the option to include, omit, or change any of these text messages.) Settings printed in Bold are the default values.

A "►" indicates a submenu. Highlighting such an item and pressing the <Enter> key open the list of settings within that submenu.

The BIOS Setup utility uses a key-based navigation system called hot keys. Most of these hot keys (<F1>, <F2>, <F3>, <F4>, <F5>, <F6>, <Enter>, <ESC>, the arrow keys, etc.) can be used at any time during the setup navigation process.

8.2 Main Setup

The Main setup screen appears when the AMI BIOS Setup utility is first entered. To return to the Main setup screen, select the Main tab at the top of the screen. The Main BIOS setup screen is shown below.

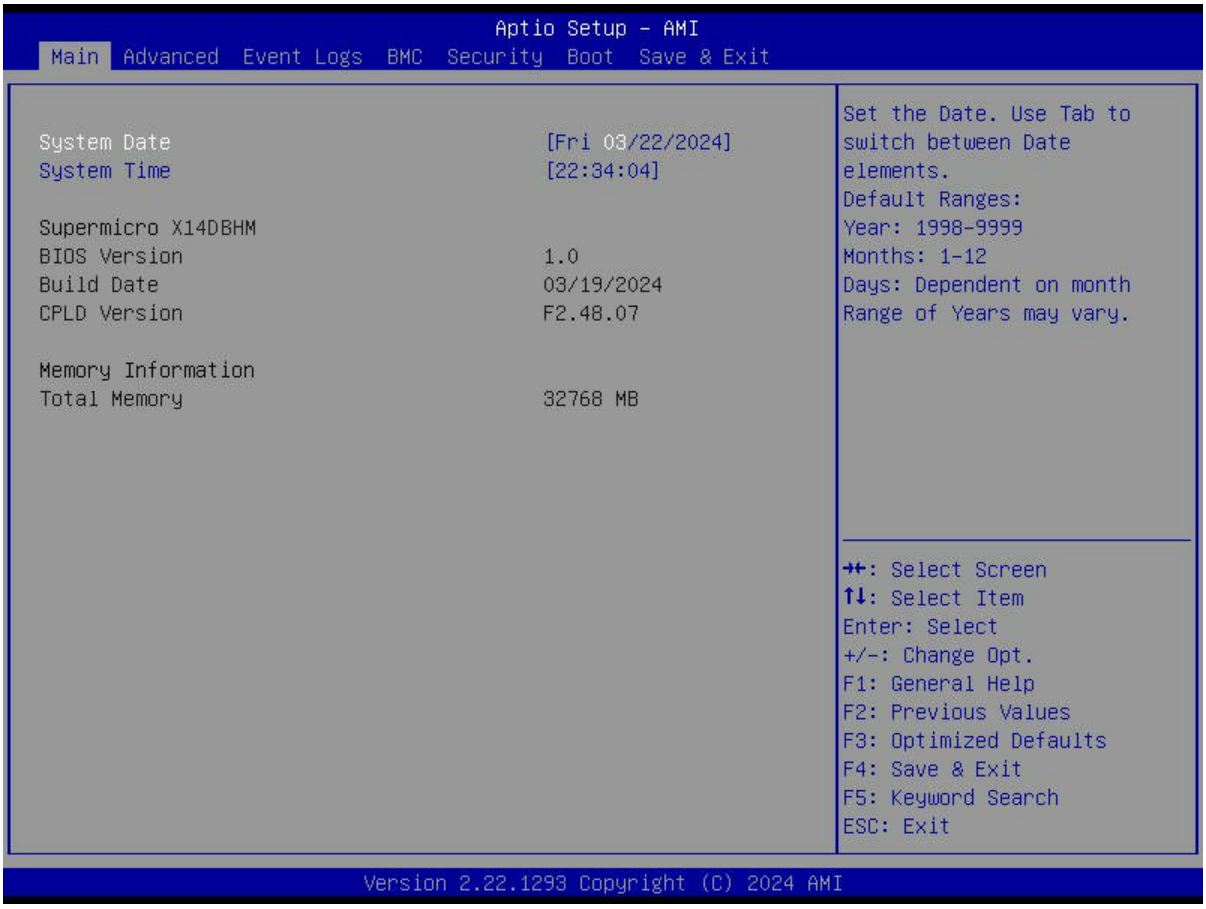


Figure 8-1. Main Setup Screen

System Date/System Time

Use the two features to change the system date and time. Highlight **System Date** or **System Time** using the arrow keys. Enter new values using the keyboard. Press the <Tab> key or the arrow keys to move between fields. The date must be entered in MM/DD/YYYY format. The time is entered in HH:MM:SS format.

Note: The time is in the 24-hour format. For example, 5:30 P.M. appears as 17:30:00.

Supermicro X14DBHM

BIOS Version

This feature displays the version of the BIOS ROM used in the system.

Build Date

This feature displays the date when the version of the BIOS ROM used in the system was built.

CPLD Version

This feature displays the version of the Complex-Programmable Logical Device (CPLD) used in the system.

Memory Information

Total Memory

This feature displays the total size of memory available in the system.

8.3 Advanced Setup Configurations

Use the arrow keys to select the Advanced submenu and press <Enter> to access the submenu items.

Important: Use caution when changing the Advanced settings. An incorrect value, an improper DRAM frequency, or a wrong BIOS timing setting may cause the system to malfunction. When this occurs, revert the settings to the default manufacturing settings.

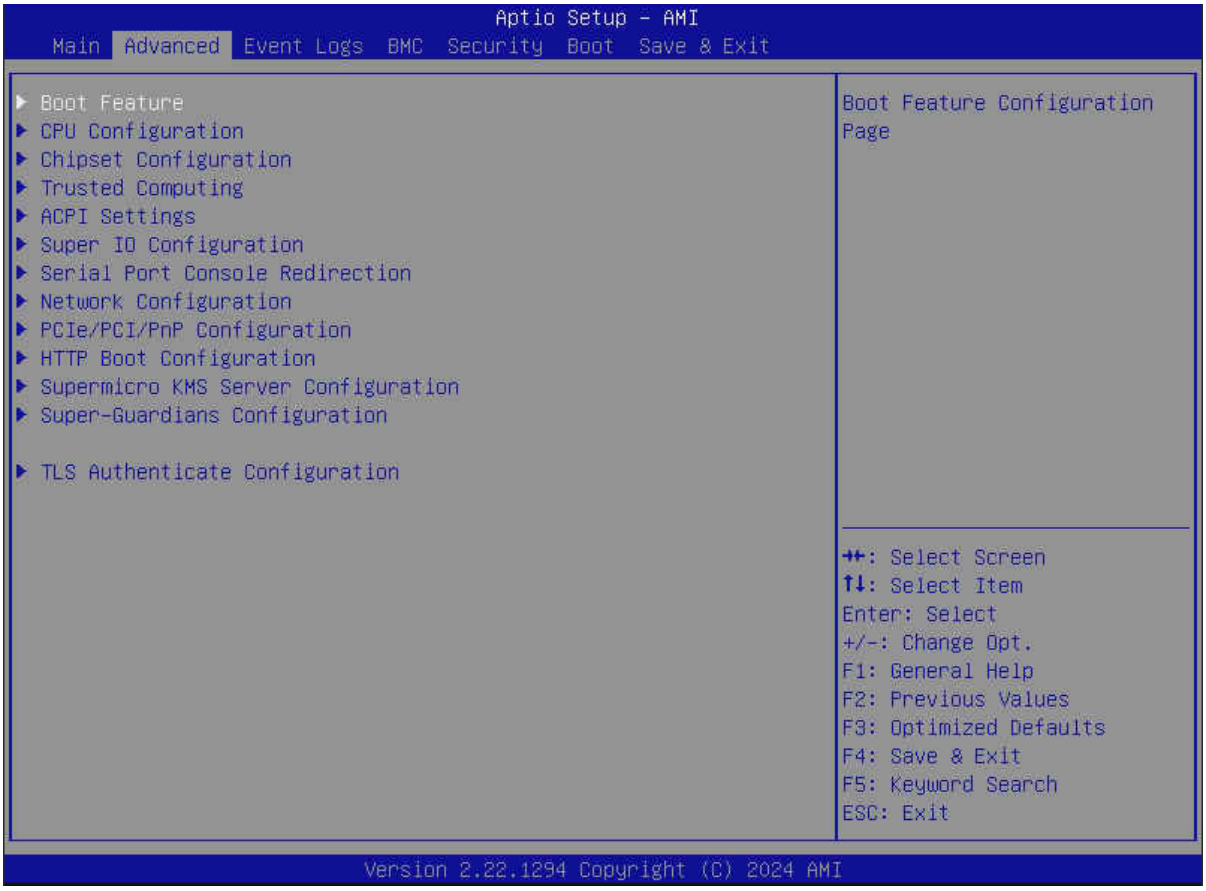


Figure 8-2. Advanced Screen

Boot Feature Menu

►Boot Feature

Quiet Boot

Use this feature to select the screen between displaying the Power-on Self Test (POST) messages or the OEM logo upon bootup. Select Disabled to display the POST messages. Select Enabled to display the OEM logo instead of the normal POST messages. The options

are Disabled and **Enabled**.

Note: BIOS POST messages are always displayed regardless of the setting of this feature.

Bootup NumLock State

Use this feature to set the power on state for the <Num Lock> key. The options are **On** and Off.

Wait For "F1" If Error

Select Enabled to force the system to wait until the <F1> key is pressed if an error occurs. The options are **Disabled** and Enabled.

Re-try Boot

If this feature is set to Enabled, the system BIOS will automatically reboot the system from an Extensible Firmware Interface (EFI) boot device after an initial boot failure. The options are **Disabled** and Enabled.

Power Configuration

Watch Dog Function

Select Enabled to allow the Watchdog timer to reboot the system when it is inactive for more than five minutes. The options are **Disabled** and Enabled.

Watch Dog Action (Available when "Watch Dog Function" is set to Enabled)

Use this feature to configure the Watchdog timeout setting. The options are **Reset** and NMI.

Restore on AC Power Loss

Use this feature to set the power state after a power outage. Select Stay Off for the system power to remain off after a power loss. Select Power On for the system power to be turned on after a power loss. Select Last State to allow the system to resume its last power state before a power loss. The options are Stay Off, Power On, and **Last State**.

Power Button Function

This feature controls how the system shuts down when the power button is pressed. Select 4 Seconds Override to power off the system after pressing and holding the power button for four seconds or longer. Select Instant Off to instantly power off the system as soon as you press the power button. The options are **Instant Off** and 4 Seconds Override.

CPU Configuration Menu

►CPU Configuration

Important: Setting the wrong values for the features included in the following sections may cause the system to malfunction.

The following processor information is displayed:

- Processor BSP Revision
- Processor Socket
- Processor ID
- Processor Frequency
- Processor Max Ratio
- Processor Min Ratio
- Microcode Revision
- L1 Cache RAM (Per Core)
- L2 Cache RAM (Per Core)
- L3 Cache RAM (Per Package)
- Processor 0 Version

Hardware Prefetcher

If this feature is set to Enabled, the hardware prefetcher will prefetch data from the main system memory to Level 2 cache to help expedite the data transaction to enhance memory performance. The options are **Enabled** and Disabled.

Note: This feature is NOT available when "Workload Profile" is set to HPC, I/O, or Virtualization.

Adjacent Cache Prefetch

Select Enabled for the CPU to prefetch both cache lines for 128 bytes as comprised. Select Disabled for the CPU to prefetch both cache lines for 64 bytes. The options are **Enabled** and Disabled.

Note: This feature is NOT available when "Workload Profile" is set to HPC, I/O, or Virtualization.

DCU Streamer Prefetcher (Available when "Workload Profile" is set to Disabled)

If this feature is set to Enabled, the Data Cache Unit (DCU) streamer prefetcher will prefetch data streams from the cache memory to the DCU to speed up data accessing and processing to enhance CPU performance. The options are Enabled, Disabled, and **Auto**.

DCU IP Prefetcher

This feature allows the system to use the sequential load history, which is based on the instruction pointer of previous loads, to determine whether the system will prefetch additional lines. The options are **Enabled** and Disabled.

Note: This feature is NOT available when "Workload Profile" is set to HPC, I/O, or Virtualization.

APIC Physical Mode

Use this feature to enable the APIC physical destination mode. The options are **Disabled** and Enabled. (APIC is the abbreviation for Extended Advanced Programmable Interrupt Controller.)

TXT Support

Select Enabled to enable Intel Trusted Execution Technology (TXT) support to enhance system integrity and data security. The options are **Disabled** and Enabled. This feature is CPU-dependent.

Notes:

- If this feature is set to Enabled, be sure to disable Device Function On-Hide (EV DFX) support when it is present in the BIOS for the system to work properly.
- For more information about the Trusted Platform Module (TPM), refer to AOM-TPM-9672SCM at https://www.supermicro.com.

Intel Virtualization Technology

Select Enabled to enable the Intel Vanderpool Technology for Virtualization platform support, which allows multiple operating systems to run simultaneously on the same computer to maximize system resources for performance enhancement. The options are Disabled and **Enabled**. Changes take effect after you save settings and reboot the system.

Notes:

- This feature is NOT available when "TXT Support" is set to Enabled.
- This feature is NOT available when "Workload Profile" is set to Virtualization.

Enable SMX

Select Enabled to support Safer Mode Extensions (SMX), which provides a programming interface for system software to establish a controlled environment to support the trusted platform configured by the end user and to verify a virtual machine monitor before it is allowed to run. The options are **Disabled** and Enabled.

Note: This feature is available when "TXT Support" is set to Disabled.

PPIN Control

Select Unlock/Enabled to use the Protected Processor Inventory Number (PPIN) in the system. The PPIN is a unique number set for tracking a given Intel Xeon server processor. The options are Lock/Disabled and **Unlock/Enabled**.

AES-NI

Select Enabled to use the Intel Advanced Encryption Standard (AES) New Instructions (NI) to ensure data security. The options are Disabled and **Enabled**.

Advanced Power Management Configuration Menu

►Advanced Power Management Configuration

Workload Profile

Use this feature to select a preconfigured workload profile, which is used to tune the resources in your server system. The options are **Disabled**, HPC, I/O, Virtualization, Telco NFVI, Telco NFVI-FP, and Telco FlexRAN.

Power Performance Tuning

This feature allows either operating system (OS) or BIOS to control the EPB. The options are **OS Controls EPB** and BIOS Controls EPB. (PECI is the abbreviation for Platform Environment Control Interface. EPB is the abbreviation for Intel Performance and Energy Bias Hint.)

Note: This feature is available when "Workload Profile" is set to Disabled.

ENERGY_PERF_BIAS_CFG Mode (ENERGY PERFORMANCE BIAS CONFIGURATION Mode)

Use this feature to configure the proper operation setting for your machine by achieving the desired system performance level and energy saving (efficiency) level at the same time. Select Maximum Performance to maximize system performance to its highest potential; however, this may consume maximal amount of power as energy is needed to fuel processor operation. Select Performance to enhance system performance; however, this may consume more power as energy is needed to fuel the processors for operation. The options are Extreme Performance, Maximum Performance, Performance, **Balanced Performance**, Balanced Power, Power, and Max Power Efficient. Note that the options of Extreme Performance and Max Power Efficient are motherboard-dependent.

Notes:

- This feature is available when "Power Performance Tuning" is set to BIOS Controls EPB.
- This feature is available when "Workload Profile" is set to Disabled.

CPU P State Control Menu

►CPU P State Control

Note: This submenu is available when “Power Performance Tuning” is set to BIOS Controls EPB.

AVX P1

Use this feature to set the appropriate TDP level for the system. The Intel Advanced Vector Extensions (Intel AVX) P1 feature allows you to set the base P1 ratio for Streaming SIMD Extensions (SSE) and AVX workloads. Each P1 ratio has the corresponding AVX Impressed Current Cathodic Protection (ICCP) pre-grant license level, which refers to the selection between different AVX ICCP transition levels. The options are **Nominal**, Level 1, and Level 2. This feature is CPU-dependent.

Notes:

- This feature is available when "SpeedStep (P-States)" is set to Enabled.
- This feature is NOT available when "Workload Profile" is set to Telco FlexRAN.

Intel SST-PP

Use this feature to choose from two additional Base-Frequency conditions maximum for CPU P State Control. The options are **Auto**, Level 0, Level 1, Level 2, Level 3, and Level 4. The options regarding SST-PP levels are CPU-dependent. (SST-PP is the abbreviation for Speed Select Technology-Performance Profile.)

Notes:

- This feature is available when "SpeedStep (P-States)" is set to Enabled and when the number of SST-PP levels supported by your CPU is no less than two.
- This feature is NOT available when "Workload Profile" is set to Telco NFVI, Telco NFVI-FP, or Telco FlexRAN.

Dynamic SST-PP

Use this feature to disable or enable the dynamic SST-PP. The options are **Disabled** and Enabled.

Notes:

- This feature is available when "SpeedStep (P-States)" is set to Enabled and when your CPU supports the Intel Speed Select function.
- This feature is available when "AVX P1" is set to Nominal.
- This feature is NOT available when "Hardware P-States" is set to Disabled or Out of Band Mode.
- This feature is NOT available when "Workload Profile" is set to HPC or Virtualization.

When "SpeedStep (P-States)" is set to Enabled, the information about SST-PP levels supported by your CPU is displayed.

- SST-PP Level
- Capable
- Core Count
- P1 Ratio
- Package TDP (W)
- DTS_Max

SpeedStep (P-States)

Enhanced Intel SpeedStep Technology (EIST) allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. Refer to Intel's website for detailed information. The options are Disabled and **Enabled**.

Note: This feature is available when "Workload Profile" is set to Disabled.

EIST PSD Function

This feature reduces the latency that occurs when one P-state changes to another, thus allowing the transitions to occur more frequently. This will allow for more demand-based P-state switching to occur based on the real-time energy needs of applications so that the power-to-performance balance can be optimized for energy efficiency. The options are **HW_ALL** and SW_ALL.

Notes:

- This feature is available when "SpeedStep (P-States)" is set to Enabled.
- This feature is NOT available when "Workload Profile" is set to Telco NFVI, Telco NFVI-FP, or Telco FlexRAN.

Turbo Mode

Select Enabled to allow the CPU to operate at the manufacturer-defined turbo speed by increasing CPU clock frequency. This feature is available when it is supported by the processors used in the system. The options are Disabled and **Enabled**.

Notes:

- This feature is available when "SpeedStep (P-States)" is set to Enabled.
- This feature is available when "Workload Profile" is set to Disabled.

Hardware PM State Control Menu

►Hardware PM State Control

Notes:

- This submenu is available when “Power Performance Tuning” is set to BIOS Controls EPB.
- This submenu is NOT available when “Workload Profile” is set to HPC or Virtualization.

Hardware P-States

If this feature is set to Disabled, system hardware will choose a P-state setting for the system based on an OS request. If this feature is set to Native Mode, system hardware will choose a P-state setting based on the OS guidance. If this feature is set to Native Mode with No Legacy Support, system hardware will choose a P-state setting independently without the OS guidance. The options are Disabled, **Native Mode**, Out of Band Mode, and Native Mode with No Legacy Support.

CPU C State Control Menu

►CPU C State Control

Note: This submenu is available when “Power Performance Tuning” is set to BIOS Controls EPB.

Monitor MWAIT

Select Enabled to support MONITOR and MWAIT, which are two instructions in Streaming SIMD Extension 3 (SSE3) to improve synchronization between multiple threads for CPU performance enhancement. The options are Disabled and **Enabled**.

Note: This feature is NOT available when "Workload Profile" is set to Telco NFVI, Telco NFVI-FP, or Telco FlexRAN.

ACPI C1 Enumeration

Use this feature to select the ACPI C1 state or the ACPI C1e state. The options are C1 and **C1e**. This feature is CPU-dependent. (ACPI is the abbreviation for Advanced Configuration and Power Interface.)

Note: This feature is available when "Workload Profile" is set to Disabled.

ACPI C6x Enumeration

Use this feature to configure C6 state or C6 P-state as ACPI C2 or ACPI C3 state. The options are Disabled, C6 as ACPI C2, C6 as ACPI C3, C6-P as ACPI C2, C6-P as ACPI C3, and **Auto**.

Note: This feature is available when "Workload Profile" is set to Disabled.

Package C State Control Menu

►Package C State Control

Note: This submenu is available when “Power Performance Tuning” is set to BIOS Controls EPB.

Package C State

Use this feature to optimize and reduce CPU package power consumption in the idle mode. Please note that the changes you've made in this setting will affect all CPU cores or the circuits of the entire system. The options are C0/C1 state, C2 state, C6 (non Retention) state, No Limit, and **Auto**.

Note: This feature is NOT available when "Workload Profile" is set to I/O.

LTR IIO Input

Use this feature to set the MSR 1FCh Bit[29]. The options are Take IIO LTR input and **Ignore IIO LTR input**.

CPU1 Core Disable Bitmap Menu

►CPU1 Core Disable Bitmap

Available Bitmap[0]:

This feature displays the available Bitmap[0]. This feature is CPU-dependent.

Available Bitmap[1]:

This feature displays the available Bitmap[1]. This feature is CPU-dependent.

CPU Core Count:

This feature displays the number of CPU cores that can be enabled.

CPU1 Cores Enable

Use this feature to set the number of CPU cores to be enabled. Enter 0 to enable all CPU cores. Note that it is required to enable at least one core per CPU. The default setting is **0**.

Chipset Configuration Menu

►Chipset Configuration

Important: Setting the wrong values in this section may cause the system to malfunction.

Uncore Configuration Menu

►Uncore Configuration

The following information is displayed.

- Number of CPU
- Current UPI Link Speed
- Current UPI Link Frequency
- Global MMIO Low Base / Limit
- Global MMIO High Base / Limit
- PCIe Configuration Base / Size

Degrade Precedence

Use this feature to select the degrading precedence option for Ultra Path Interconnect (UPI) connections. Select Topology Precedence to degrade UPI features if system options are in conflict. Select Feature Precedence to degrade UPI topology if system options are in conflict. The options are **Topology Precedence** and Feature Precedence.

Link L0p Enable

Select Enabled for the system BIOS to enable Link L0p support, which allows the CPU to reduce the UPI links from full width to half width in the event when the CPU's workload is low in an attempt to save power. This feature is available for the system that uses Intel processors with UPI technology support. The options are **Disabled**, Enabled, and Auto.

Note: You can change the performance settings for non-standard applications by using this parameter. It is recommended that the default settings be used for standard applications.

Link L1 Enable

Select Enabled for the BIOS to activate Link L1 support, which will power down the UPI links to save power when the system is idle. This feature is available for the system that uses Intel processors with UPI technology support. The options are **Disabled**, Enabled, and Auto.

Note: Link L1 is an excellent feature for an idle system. L1 is used during Package C-States when its latency is hidden by other components during a wakeup.

KTI Prefetch

Keizer Technology Interconnect (KTI) is also known as the Intel Ultra Path Interconnect (UPI) technology. Select Enabled for the KTI prefetcher to preload the L1 cache with data deemed relevant, which allows the memory read to start earlier on a DDR bus in an effort to reduce latency. Select Auto for the KTI prefetcher to automatically preload the L1 cache with relevant data whenever it is needed. The options are Disabled, Enabled, and **Auto**.

IO Directory Cache (IODC)

This feature allows the IODC to generate snoops instead of generating memory lockups for remote IIO (InvItoM) and/or WCiLF (Cores). Select Auto for the IODC to generate snoops (instead of memory lockups) for WCiLF (Cores). The options are Disabled, **Auto**, Enable for Remote InvItoM Hybrid Push, Enable for Remote InvItoM AllocFlow, Enable for Remote InvItoM Hybrid AllocNonAlloc, and Enable for Remote InvItoM and Remote WCiLF.

SNC

Sub NUMA Clustering (SNC) is a feature that breaks up the Last Level Cache (LLC) into clusters based on address range. Each cluster is connected to a subset of the memory controller. Enable this feature to improve average latency and reduce memory access

congestion for higher performance. The options are Disabled, Enabled, and **Auto**. This feature is CPU-dependent.

Note: This feature is NOT available when "Workload Profile" is set to I/O, Virtualization, or Telco FlexRAN.

XPT Prefetch

XPT Prefetch is a feature that speculatively makes a copy to the memory controller of a read request being sent to the LLC. If the read request maps to the local memory address and the recent memory reads are likely to miss the LLC, a speculative read is sent to the local memory controller. The options are Disabled, Enabled, and **Auto**.

Stale AtoS

The in-memory directory has three states: I, A, and S states. The I (-invalid) state indicates that the data is clean and does not exist in the cache of any other sockets. The A (-snoop All) state indicates that the data may exist in another socket in an exclusive or modified state. The S state (-Shared) indicates that the data is clean and may be shared in the caches across one or more sockets. When the system is performing "read" on the memory and if the directory line is in A state, we must snoop all other sockets because another socket may have the line in a modified state. If this is the case, a "snoop" will return the modified data. However, it may be the case that a line "reads" in an A state, and all the snoops come back with a "miss." This can happen if another socket reads the line earlier and then has silently dropped it from its cache without modifying it. If "Stale AtoS" is enabled, a line will transition to the S state when the line in the A state returns only snoop misses. That way, subsequent reads to the line will encounter it in the S state and will not have to snoop, saving the latency and snoop bandwidth. Stale "AtoS" may be beneficial in a workload where there are many cross-socket reads. The options are Disabled, Enabled, and **Auto**.

LLC Dead Line Alloc

Select Enabled to optimally fill the dead lines in the LLC. The options are Disabled, **Enabled**, and Auto.

Memory Configuration Menu

►Memory Configuration

This submenu is used to configure the Integrated Memory Controller (IMC) settings.

Enforce DDR Memory Frequency POR

Select Enforce POR to enforce Plan of Record (POR) restrictions for DDR memory frequency and voltage programming. The options are **Enforce POR**, Enforce Stretch Goals, and Disabled.

Host Memory Frequency

Use this feature to set the maximum memory frequency for onboard memory modules. The options are **Auto**, 4800, 5200, 5600, 6000, 6400, and 7200. Note that the available options are CPU-dependent.

Global Scrambling

Select Enabled to enable data scrambling to enhance system performance and data integrity. The options are Disabled and **Enabled**.

Memory Topology Menu

►Memory Topology

This submenu displays the information of onboard memory modules as detected by the BIOS, for example:

P1-DIMMA1: 5600MT/s Hynix SRx8 16GB RDIMM

Memory Map Menu

►Memory Map

Intel(R) Flat Memory Mode Support

Enable this feature to allow hardware-managed data movement between DDR5 and CXL memory, making total memory capacity visible to your system. The options are **Disabled** and Enabled.

DDR CXL Heterogeneous Interleave Support

Select Enabled to support heterogeneous interleaving for physical DDR5 and CXL memory. The options are **Disabled** and Enabled.

Memory RAS Configuration Menu

►Memory RAS Configuration

Use this submenu to configure the memory mirroring, Reliability Availability Serviceability (RAS) settings.

Mirror Mode

Use this feature to configure the mirror mode settings for all 1LM/2LM memory modules in the system to create a duplicate copy of data stored in the memory to increase memory security. It will reduce the memory capacity into half. The options are **Disabled** and Full Mirror Mode.

Note: This feature is available when "UEFI ARM Mirror" is set to Disabled.

Correctable Error Threshold

Use this feature to specify the threshold value for correctable memory-error logging, which sets a limit on the maximum number of events that can be logged in the memory error log at a given time. The default setting is **512**.

Note: This feature is available when "Memory PFA Support" is set to Disabled.

Leaky Bucket Low Bit

Use this feature to set the Low Bit value for the Leaky Bucket algorithm, which is used to check the data transmissions between CPU sockets and the memory controller. The default setting is **12**.

Leaky Bucket High Bit

Use this feature to set the High Bit value for the Leaky Bucket algorithm, which is used to check the data transmissions between CPU sockets and the memory controller. The default setting is **13**.

ADDDC Sparing (Available when populating 1Rx4, 2Rx4, and 4Rx4 DIMMs and when "Memory PFA Support" is set to Disabled)

Select Enabled for Adaptive Double Device Data Correction (ADDDC) support, which will not only provide memory error checking and correction but will also prevent the system from issuing a performance penalty before a device fails. Note that virtual lockstep mode will only start to work for ADDDC after a faulty DRAM module is spared. The options are Disabled and **Enabled**.

DDR PPR Type

Post Package Repair (PPR) is a new feature available for the DDR4/DDR5 technology. PPR provides additional spare capacity within a DDR4/DDR5 DRAM module that is used to replace faulty cell areas detected during system boot. PPR offers two types of memory repairs. Soft Post Package Repair (sPPR) provides a quick, temporary fix on a raw element in a bank group of a DDR4/DDR5 DRAM device, while hard Post Package Repair (hPPR) will take a longer time to provide a permanent repair on a raw element. The options are PPR Disabled, **Hard PPR**, and Soft PPR.

Note: This feature is available when "Memory PFA Support" is set to Disabled.

Enhanced PPR

Use this feature to set advanced memory test. Select Enabled to always execute for every boot. The options are **Disabled**, Enabled, and Persistent.

Memory PFA Support (Available when the DCMS key is activated)

Select Enabled to enable memory Predictive Failure Analysis (PFA) support. PFA can be used to avoid uncorrectable faults on the same memory page. The options are **Disabled** and Enabled.

Security Configuration Menu

►Security Configuration

Memory Encryption (TME) [Outputs]

The following information is displayed.

- MSE activation state
- MK-TME activation state
- CI activation state
- Cryptographic Algorithm configured

Memory Encryption (TME) [Inputs]

Memory Encryption (TME)

Select Enabled for Intel Total Memory Encryption (TME) support to enhance memory data security. The options are **Disabled** and Enabled.

Total Memory Encryption Multi-Tenant (TME-MT)

Use this feature to support tenant-provided (SW-provided) keys. The options are **Disabled** and Enabled.

Memory Integrity

Use this feature to enable TME-MT memory integrity protection for memory transactions. The options are **Disabled** and Enabled.

The following information is displayed.

- KEY stock amount
- TME-MT key ID bits

TME Encryption Algorithm

Use this feature to set the TME encryption algorithm. The options are AES-XTS-128 and **AES-XTS-256**.

Trust Domain Extensions (TDX) [Outputs]

The following information is displayed.

- TDX activation state

Trust Domain Extensions (TDX) [Inputs]

Trust Domain Extensions (TDX) (Available when your motherboard supports Intel TDX)

Use this feature to enable Intel Trust Domain Extensions (TDX) technology support to enhance control of data security. The options are **Disabled** and Enabled.

Note: To support TDX features, DIMM population must be symmetric across integrated Memory Controllers (IMCs) and at least DIMMs per socket. For each memory controller, populating the first slots (Px-DIMMX1 or DIMMX1 depending on the motherboard design) in all channels is required. Refer to memory population below for your motherboard.

TDX Secure Arbitration Mode Loader (SEAM Loader) (Available when your motherboard supports Intel TDX and when "Trust Domain Extensions (TDX)" is set to Enabled)

The SEAM Loader (SEAMLDR) is used to load and update Intel TDX modules into the SEAM memory range by verifying the digital signature. The options are **Disabled** and Enabled.

TME-MT/TDX Key Split (Available when "Trust Domain Extensions (TDX)" is set to Enabled)

Use this feature to set the number of bits for TDX. The other bits will be used by TME-MT. The default setting is **1**.

The following information is displayed when "Trust Domain Extensions (TDX)" is set to Enabled.

- TME-MT Keys:
- TDX Keys:

Processor Reserved Memory [Capabilities]

The following information is displayed.

- PRMRR Min Size per domain
- PRMRR Max Size per domain

Processor Reserved Memory [Outputs]

The following information is displayed.

- PRMRR Size per domain
- PRM Size per socket
- PRM Size per system

Software Guard Extensions (SGX) [Outputs]

The following information is displayed when your motherboard supports SGX.

- SGX activation state
- SGX error code [HEX]

Software Guard Extensions (SGX) [Inputs]

The following features are available when your motherboard supports SGX.

Note: To support SGX features, DIMM population must be symmetric across Integrated Memory Controllers (IMCs) and at least DIMMs per socket. For each memory controller, populating the first slots (Px-DIMMX1 or DIMMX1 depending on the motherboard design) in all channels is required. Refer to memory population below for your motherboard.

SGX Factory Reset

Use this feature to perform an SGX factory reset to delete all registration data and force an Initial Platform Establishment flow. Reboot the system for the changes to take effect. The options are **Disabled** and Enabled.

SW Guard Extensions (SGX)

Use this feature to enable Intel Software Guard Extensions (SGX) support. Intel SGX is a set of extensions that increases the security of application code and data by using enclaves in memory to protect sensitive information. The options are **Disabled** and Enabled.

SGX Package Info In-Band Access

Setting this feature to Enabled is required before the BIOS provides software with the key blobs, which are generated for each CPU package. The options are **Disabled** and Enabled.

SGX PRMRR Size Requested (Available when "SW Guard Extensions (SGX)" is set to Enabled)

Use this feature to set the Processor Reserved Memory Range Register (PRMRR) size. The options are **Auto**, 128M, 256M, 512M, 1G, 2G, 4G, 8G, 16G, 32G, 64G, 128G, 256G, and 512G. Note that the available options are based on your motherboard features, memory size, and memory map.

Select Owner EPOCH Input Type (Available when "SW Guard Extensions (SGX)" is set to Enabled)

Owner EPOCH is used as a parameter to add personal entropy into the key derivation process. A correct Owner EPOCH is required to have access to personal data previously sealed by other platform users. There are two Owner EPOCH modes. One is New Random Owner EPOCH, and the other is manually entered by the user. Each EPOCH is 64-bit. The options are **SGX Owner EPOCH deactivated**, Change to New Random Owner EPOCHs, and Manual User Defined Owner EPOCHs.

Note: Changing the Owner EPOCH value will lose the data in enclaves.

Software Guard Extensions Epoch 0

Use this feature to enter the EPOCH value. The default setting is **0**.

Note: This feature is available when "SW Guard Extensions (SGX)" is set to Enabled. This feature is NOT available when "Select Owner EPOCH Input Type" is set to SGX Owner EPOCH deactivated.

Software Guard Extensions Epoch 1

Use this feature to enter the EPOCH value. The default setting is **0**.

Note: This feature is available when "SW Guard Extensions (SGX)" is set to Enabled. This feature is NOT available when "Select Owner EPOCH Input Type" is set to SGX Owner EPOCH deactivated.

SGXLEPUBKEYHASHx Write Enable (Available when "SW Guard Extensions (SGX)" is set to Enabled)

Use this feature to enable writes to SGXLEPUBKEYHASH[3..0] from OS/SW. The options are Disabled and **Enabled**. Only those CPUs that support the Intel SGX Flexible Launch Control (FLC) feature have SGXLEPUBKEYHASH, which contains the hash of the public key for the SGX Launch Enclave (LE) to be signed with.

SGXLEPUBKEYHASH0 (Available when both "SW Guard Extensions (SGX)" and "SGXLEPUBKEYHASHx Write Enable" are set to Enabled)

Use this feature to enter the bytes 0–7 of SGX Launch Enclave Public Key Hash.

SGXLEPUBKEYHASH1 (Available when both "SW Guard Extensions (SGX)" and "SGXLEPUBKEYHASHx Write Enable" are set to Enabled)

Use this feature to enter the bytes 8–15 of SGX Launch Enclave Public Key Hash.

SGXLEPUBKEYHASH2 (Available when both "SW Guard Extensions (SGX)" and "SGXLEPUBKEYHASHx Write Enable" are set to Enabled)

Use this feature to enter the bytes 16–23 of SGX Launch Enclave Public Key Hash.

SGXLEPUBKEYHASH3 (Available when both "SW Guard Extensions (SGX)" and "SGXLEPUBKEYHASHx Write Enable" are set to Enabled)

Use this feature to enter the bytes 24–31 of SGX Launch Enclave Public Key Hash.

SGX Auto MP Registration (Available when "SW Guard Extensions (SGX)" is set to Enabled)

Use this feature to enable/disable SGX Auto Multi-Package Registration Agent (MPA) running automatically at boot time. The options are **Disabled** and Enabled.

IIO Configuration Menu

►IIO Configuration

PCIe Completion Timeout

Use this feature to set the PCIe completion timeout. The options are 50us to 50ms, 50us to 100us, 1ms to 10ms, 16ms to 55ms, 65ms to 210ms, **260ms to 900ms**, 1s to 3.5s, and Disabled.

PCIe ASPM Support (Global)

Use this feature to disable the Active State Power Management (ASPM) support for all PCIe root ports. The options are **Disabled** and Auto.

PRM Feature Control

Use this feature to enable the Platform Runtime Mechanism (PRM). The PRM is a mechanism to reduce the System Management Mode (SMM) usages and to provide an alternate means to invoke native code through the Advanced Configuration and Power Interface (ACPI) context of runtime events. The options are **Disabled** and Enabled.

Equalization Bypass To Highest Rate

Set this feature to Enabled to reduce the link training time for PCIe 5.0 device by skipping equalization of intermediate data rates. The options are Disabled and **Enabled**.

NVMe Mode Switch

When this feature is set to Auto, VMD support will be automatically enabled when a VROC key is detected by the BIOS. The options are Manual, VMD, and **Auto**.

PCIe PLL SSC

Select Enabled for PCIe Spread Spectrum Clocking (SSC) support, which allows the BIOS to monitor and attempt to reduce the level of electromagnetic interference caused by the components whenever needed. The options are **Disabled** and Enabled.

CPU1 Configuration Menu

►CPU1 Configuration

►PCI Express 0 / PCI Express 1 / PCI Express 2 / PCI Express 3 / PCI Express 4 / PCI Express 5

Note: The number of PCIe slots and the slot naming can differ depending on the PCIe devices connected to your motherboard.

Bifurcation

This feature is CPU-dependent. Use this feature to configure the PCIe Bifurcation setting for the PCIe port you specified. The options are **Auto**, x4x4x4x4, x4x4x8, x8x4x4, x8x8, and x16.

►Intel VMD Technology

Note: After you've enabled VMD in the BIOS on a PCIe slot, this PCIe slot will be dedicated for VMD use only, and it will no longer support any PCIe device. To re-activate this slot for PCIe use, disable VMD in the BIOS.

Intel VMD Technology

When this feature is set to Enabled, VMD support will be automatically enabled when a VROC key is detected by the BIOS. The options are **Disabled** and Enabled.

►PCI Express 1 JM2_1 PCIe 5.0 X2 SLOT / PCI Express 1 JM2_2 PCIe 5.0 X2 SLOT / PCI Express 3 JAIOM1 PCIe 5.0 X15 SLOT / PCI Express 3 JAIOM2 PCIe 5.0 X16 SLOT

Note: The number of PCIe slots and the slot naming can differ depending on the PCIe devices connected to your motherboard.

Requested Link Speed

Use this feature to configure the link speed of the PCIe port you specified. The options are **Auto**, Gen 1 (2.5 GT/s), Gen 2 (5 GT/s), Gen 3 (8 GT/s), Gen 4 (16 GT/s), and Gen 5 (32 GT/s).

The following information is displayed.

- Max Link Width
- Current Link Width
- Current Link Speed

PCIe Port Max Payload Size

Use this feature to configure the maximum payload size supported in Direct Media Interface (DMI) device capabilities register for the device installed in the PCIe port. The options are 128B, 256B, 512B, and **Auto**.

MCTP

Enable this feature, Management Component Transport Protocol (MCTP), to support communications between devices in a platform management subsystem. MCTP's underlying device buses include SMBus/I^2C, serial links, PCIe, and USB. The options are Disabled and **Enabled**.

Intel VMD Technology

When this feature is set to Enabled, VMD support will be automatically enabled when a VROC key is detected by the BIOS. The options are **Disabled** and Enabled.

Intel VT for Directed I/O (VT-d) Menu

►Intel VT for Directed I/O (VT-d)

Note: This submenu is NOT available when "Workload Profile" is set to Virtualization.

Pre-boot DMA Protection

Select Enabled to establish DMA protection during pre-boot processing by setting DMA_CTRL_PLATFORM_OPT_IN_FLAG in the DMAR ACPI table. The options are **Enabled** and Disabled. (DMA is the abbreviation for Direct Memory Access. DMAR is the abbreviation for DMA Remapping Reporting.)

PCIe ACSCTL

Select Enabled to program ACS control to Chipset PCIe Root Port bridges. Select Disabled to program ACS control to all PCIe Root Port bridges. The options are Enabled and **Disabled**.

PCIe Leaky Bucket Configuration Menu

►PCIe Leaky Bucket Configuration

Gen2 Link Degradation

Use this feature to enable PCIe Gen2 link degradation. The options are Disabled and **Enabled**.

Note: The default setting is Enabled when your motherboard supports PCIe Gen2 link. Otherwise, the default setting is Disabled.

Gen3 Link Degradation

Use this feature to enable PCIe Gen3 link degradation. The options are Disabled and **Enabled**.

Note: The default setting is Enabled when your motherboard supports PCIe Gen3 link. Otherwise, the default setting is Disabled.

Gen4 Link Degradation

Use this feature to enable PCIe Gen4 link degradation. The options are Disabled and **Enabled**.

Note: The default setting is Enabled when your motherboard supports PCIe Gen4 link. Otherwise, the default setting is Disabled.

Gen5 Link Degradation

Use this feature to enable PCIe Gen5 link degradation. The options are Disabled and **Enabled**.

Note: The default setting is Enabled when your motherboard supports PCIe Gen5 link. Otherwise, the default setting is Disabled.

Trusted Computing Menu

►Trusted Computing

When the TPM 2.0 (either onboard or external) is detected by your system, the following information is displayed.

- TPM 2.0 Device Found
- Firmware Version:
- Vendor:

Note: This submenu is available when the TPM 2.0 (either onboard or external) is detected by the BIOS.

Security Device Support

Select Enabled to enable BIOS support for onboard security devices, which are not displayed in the OS. If this feature is set to Enabled, TCG EFI protocol and INT1A interface will not be available. The options are Disabled and **Enabled**.

When "Security Device Support" is set to Enabled and the TPM 2.0 (either onboard or external) is detected by the BIOS, the following information is displayed.

- Active PCR banks
- Available PCR banks

Note: The following features are available when the TPM 2.0 (either onboard or external) is detected by the BIOS.

SHA-1 PCR Bank (Available when "Security Device Support" is set to Enabled)

Select Enabled to enable SHA-1 PCR Bank support to enhance system integrity and data security. The options are Disabled and **Enabled**.

SHA256 PCR Bank (Available when "Security Device Support" is set to Enabled)

Select Enabled to enable SHA256 PCR Bank support to enhance system integrity and data security. The options are Disabled and **Enabled**.

SHA384 PCR Bank (Available when "Security Device Support" is set to Enabled)

Select Enabled to enable SHA384 PCR Bank support to enhance system integrity and data security. The options are **Disabled** and Enabled.

Pending Operation (Available when "Security Device Support" is set to Enabled)

Use this feature to schedule a TPM-related operation to be performed by the security TPM (either onboard or external) at the next system boot to enhance system data integrity. The options are **None** and TPM Clear.

Note: If this feature is used, your system will reboot to carry out a pending TPM operation.

Platform Hierarchy (Available when "Security Device Support" is set to Enabled)

Select Enabled for TPM Platform Hierarchy support, which allows the manufacturer to utilize the cryptographic algorithm to define a constant key or a fixed set of keys to be used for initial system boot. These early boot codes are shipped with the platform and are included in the list of "public keys." During system boot, the platform firmware uses the trusted public keys to verify a digital signature in an attempt to manage and control the security of the platform firmware used in a host system via the TPM (either onboard or external). The options are Disabled and **Enabled**.

Storage Hierarchy (Available when "Security Device Support" is set to Enabled)

Select Enabled for TPM Storage Hierarchy support that is intended to be used for non-privacy-sensitive operations by a platform owner such as an IT professional or the end user. Storage Hierarchy has an owner policy and an authorization value, both of which can be set and are held constant (-rarely changed) through reboots. This hierarchy can be cleared or changed independently of the other hierarchies. The options are Disabled and **Enabled**.

Endorsement Hierarchy (Available when "Security Device Support" is set to Enabled)

Select Enabled for Endorsement Hierarchy support, which contains separate controls to address the user's privacy concerns because the primary keys in the hierarchy are certified by the TPM key or by a manufacturer with restrictions on how an authentic TPM (either onboard or external) that is attached to an authentic platform can be accessed and used. A primary key can be encrypted and certified with a certificate created by using TPM2_ActivateCredential, which allows the user to independently enable "flag, policy, and authorization values" without involving other hierarchies. A user with privacy concerns can disable the endorsement hierarchy while still using the storage hierarchy for TPM applications, permitting the platform software to use the TPM. The options are Disabled and **Enabled**.

PH Randomization

Select Enabled for Platform Hierarchy (PH) Randomization support, which is used only during the platform developmental stage. This feature cannot be enabled in the production platforms. The options are **Disabled** and Enabled.

Supermicro BIOS-Based TPM Provision Support

Set this feature to Enabled to unlock the TPM. Save settings and exit the BIOS Setup utility. The Non-volatile (NV) indexes can be deleted after the system reboot. The options are **Disabled** and Enabled.

ACPI Settings Menu

►ACPI Settings

NUMA

Use this feature to enable Non-Uniform Memory Access (NUMA) support to minimize memory access latencies. The options are Disabled and **Enabled**. This feature is CPU-dependent.

Virtual NUMA

Enable this feature to optimize the memory-access performance for VMware virtual machines. The options are **Disabled** and Enabled.

Note: This feature is NOT available when "Workload Profile" is set to Telco NFVI, Telco NFVI-FP, or Telco FlexRAN.

Number of Virtual NUMA Nodes (Available when "Virtual NUMA" is set to Enabled)

This feature displays the number of virtual NUMA nodes. A NUMA architecture divides hardware resources (including processors, memory, and I/O buses) into groups, called NUMA nodes. This feature indicates the available number of virtual NUMA nodes that can be assigned to the virtual machine. By default, this setting is automatically adjusted to match the physical NUMA topology.

WHEA Support

Select Enabled to support the Windows Hardware Error Architecture (WHEA) platform and provide a common infrastructure for the system to handle hardware errors within the Windows OS environment to reduce system crashes and to enhance system recovery and health monitoring. The options are Disabled and **Enabled**.

Super IO Configuration Menu

►Super IO Configuration

The following information is displayed.

- Super IO Chip

Note: This submenu is available when your system supports this feature.

Serial Port 1 Configuration Menu

►Serial Port 1 Configuration

Serial Port 1

Select Enabled to enable serial port 1. The options are Disabled and **Enabled**.

Device Settings (Available when "Serial Port 1" above is set to Enabled)

This feature displays the base I/O port address and the Interrupt Request address of serial port 1.

Change Settings (Available when "Serial Port 1" above is set to Enabled)

Use this feature to specify the base I/O port address and the Interrupt Request address of serial port 1. Select Auto for the BIOS to automatically assign the base I/O and IRQ address to serial port 1. The options are **Auto**, (IO=3F8h; IRQ=4;), (IO=3F8h; IRQ=3,4,5,6,7,9,10,11,12;), (IO=2F8h; IRQ=3,4,5,6,7,9,10,11,12;), (IO=3E8h; IRQ=3,4,5,6,7,9,10,11,12;), and (IO=2E8h; IRQ=3,4,5,6,7,9,10,11,12;).

Serial Port 2 Configuration Menu

►Serial Port 2 Configuration

Note: It can be "Serial Port 2 Configuration" or "SOL Configuration" based on your system support.

Serial Port 2/SOL ("Serial Port 2" or "SOL" based on your system support)

Select Enabled to enable serial port 2 (or SOL). The options are Disabled and **Enabled**.

Device Settings (Available when "Serial Port 2/SOL" above is set to Enabled)

This feature displays the base I/O port address and the Interrupt Request address of serial port 2 (or SOL).

Change Settings (Available when "Serial Port 2/SOL" above is set to Enabled)

Use this feature to specify the base I/O port address and the Interrupt Request address of serial port 2 (or SOL). Select Auto for the BIOS to automatically assign the base I/O and IRQ address to serial port 2 (or SOL).

The options are **Auto**, (IO=2F8h; IRQ=3;), (IO=3F8h; IRQ=3,4,5,6,7,9,10,11,12;), (IO=2F8h; IRQ=3,4,5,6,7,9,10,11,12;), (IO=3E8h; IRQ=3,4,5,6,7,9,10,11,12;), and (IO=2E8h; IRQ=3,4,5,6,7,9,10,11,12;).

Serial Port 2 Attribute (Available for Serial Port 2 only)

Select SOL to use serial port 2 as a Serial Over LAN (SOL) port for console redirection. The options are **SOL** and COM.

Serial Port Console Redirection Menu

►Serial Port Console Redirection

COM1 (Available when your system supports the serial port of COM1)

Console Redirection

Select Enabled to enable COM port 1 for Console Redirection, which allows a client machine to be connected to a host machine at a remote site for networking. The options are **Disabled** and Enabled.

Note: This feature will be set to Enabled if there is no BMC support.

SOL/COM2

Note: This feature is available when your system supports serial port of SOL and/or COM2. The "SOL/COM2" here indicates a shared serial port, and SOL is used as the default.

Console Redirection

Select Enabled to use the SOL/COM2 port for Console Redirection. The options are Disabled and **Enabled**.

►Console Redirection Settings

Note: This submenu is available when "Console Redirection" for COM1 or SOL/COM2 is set to Enabled.

Terminal Type

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII character set. Select VT100+ to add color and function key support. Select ANSI to use the extended ASCII character set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are VT100, **VT100+**, VT-UTF8, and ANSI.

Bits Per Second

Use this feature to set the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 38400, 57600, and **115200** (bits per second).

Data Bits

Use this feature to set the data transmission size for Console Redirection. The options are 7 and **8** (bits).

Parity

A parity bit can be sent along with regular data bits to detect data transmission errors. Select Even if the parity bit is set to 0 and the number of 1s in data bits is even. Select Odd if the parity bit is set to 0 and the number of 1s in data bits is odd. Select None if you do not want to send a parity bit with your data bits in transmission. Select Mark to add a mark as a parity bit to be sent along with the data bits. Select Space to add a space as a parity bit to be sent with your data bits. The options are **None**, Even, Odd, Mark, and Space.

Stop Bits

A stop bit indicates the end of a serial data packet. Select 1 (stop bit) for standard serial data communication. Select 2 (stop bits) if slower devices are used. The options are **1** and 2.

Flow Control

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop sending data when the receiving buffer is full. Send a "Start" signal to start sending data when the receiving buffer is empty. The options are **None** and Hardware RTS/CTS.

VT-UTF8 Combo Key Support

Select Enabled to enable VT-UTF8 Combination Key support for ANSI/VT100 terminals. The options are Disabled and **Enabled**.

Recorder Mode

Select Enabled to capture the data displayed on a terminal and send it as text messages to a remote server. The options are **Disabled** and Enabled.

Resolution 100x31

Select Enabled for extended-terminal resolution support. The options are Disabled and **Enabled**.

Putty KeyPad

Use this feature to select function key and keypad settings on Putty, which is a terminal emulator designed for the Windows OS. The options are **VT100**, LINUX, XTERMR6, SCO, ESCN, and VT400.

Serial Port for Out-of-Band Management/Windows Emergency Management Services (EMS)

Use the features below to configure Console Redirection settings to support Out-of-Band Serial Port management.

Console Redirection EMS

Select Enabled to use the SOL port for Console Redirection. The options are **Disabled** and Enabled.

►Console Redirection Settings

Note: This submenu is available when "Console Redirection EMS" is set to Enabled.

Out-of-Band Mgmt Port

The feature selects a serial port in a client server to be used by the Microsoft Windows Emergency Management Services (EMS) to communicate with a remote host server. The options are **COM1** and SOL/COM2. Please note that the option of SOL/COM2 indicates a shared serial port. SOL is available with BMC support.

Terminal Type EMS

Use this feature to select the target terminal emulation type for Console Redirection. Select VT100 to use the ASCII character set. Select VT100+ to add color and function key support. Select ANSI to use the extended ASCII character set. Select VT-UTF8 to use UTF8 encoding to map Unicode characters into one or more bytes. The options are VT100, VT100+, **VT-UTF8**, and ANSI.

Bits Per Second EMS

This feature sets the transmission speed for a serial port used in Console Redirection. Make sure that the same speed is used in the host computer and the client computer. A lower transmission speed may be required for long and busy lines. The options are 9600, 19200, 57600, and **115200** (bits per second).

Flow Control EMS

Use this feature to set the flow control for Console Redirection to prevent data loss caused by buffer overflow. Send a "Stop" signal to stop sending data when the receiving buffer is full. Send a "Start" signal to start sending data when the receiving buffer is empty. The options

are **None**, Hardware RTS/CTS, and Software Xon/Xoff.

The following information is displayed.

- **Data Bits EMS**
- **Parity EMS**
- **Stop Bits EMS**

Network Stack Configuration Menu

►Network Stack Configuration

Network Stack

Select Enabled to enable Preboot Execution Environment (PXE) or Unified Extensible Firmware Interface (UEFI) for network stack support. The options are Disabled and **Enabled**.

IPv4 PXE Support (Available when "Network Stack" is set to Enabled)

Select Enabled to enable IPv4 PXE boot support. If this feature is disabled, it will not create the IPv4 PXE boot option. The options are Disabled and **Enabled**.

IPv4 HTTP Support (Available when "Network Stack" is set to Enabled)

Select Enabled to enable IPv4 HTTP boot support. If this feature is disabled, it will not create the IPv4 HTTP boot option. The options are **Disabled** and Enabled.

IPv6 PXE Support (Available when "Network Stack" is set to Enabled)

Select Enabled to enable IPv6 PXE boot support. If this feature is disabled, it will not create the IPv6 PXE boot option. The options are Disabled and **Enabled**.

IPv6 HTTP Support (Available when "Network Stack" is set to Enabled)

Select Enabled to enable IPv6 HTTP boot support. If this feature is disabled, it will not create the IPv6 HTTP boot option. The options are **Disabled** and Enabled.

PXE Boot Wait Time (Available when "Network Stack" is set to Enabled)

Use this feature to set the wait time (in seconds) upon which the system BIOS will wait for you to press the <ESC> key to abort PXE boot instead of proceeding with PXE boot by connecting to a network server immediately. Press the <+> or <-> key on your keyboard to change the value. The default setting is **0**.

Media Detect Count (Available when "Network Stack" is set to Enabled)

Use this feature to set the wait time (in seconds) for the BIOS ROM to detect the presence of a LAN media either via the Internet connection or via a LAN port. Press the <+> or <-> key on your keyboard to change the value. The default setting is **1**.

PCIe/PCI/PnP Configuration Menu

►PCIe/PCI/PnP Configuration

The following information is displayed.

- PCI Bus Driver Version

PCI Devices Common Settings:

Re-Size BAR Support

Use this feature to enable the Resizable BAR support. Resizable BAR is a PCIe interface technology that allows the CPU to access the entire frame buffer. With this technology, your system will be able to handle multiple CPU to GPU transfers simultaneously rather than queuing, which can improve the frame rate performance. The options are **Disabled** and Enabled.

SR-IOV Support (Unavailable when "Workload Profile" is set to Virtualization)

Select Enabled for Single- Root IO Virtualization support. The options are Disabled and **Enabled**.

ARI Support

Select Enabled for Alternative Routing- ID Interpretation (ARI) support. The options are Disabled and **Enabled**.

MMCFG Base

This feature determines how the lowest Memory Mapped Configuration (MMCFG) base is assigned to onboard PCI devices. The options are 1 G, 1.5 G, 1.75 G, 2 G, 2.25 G, 3 G, and **Auto**. The options of 2 G and 2.25 G are not available when the MMCFG size is 2 G. The option of 3 G is not available when the MMCFG size is 1 G or 2 G.

MMCFG Size

Use this feature to set the MMCFG size. The options are 64 M, 128 M, 256 M, 512 M, 1 G, 2 G, and **Auto**.

Note: The options shown here depend on your memory size.

MMIO High Base

Use this feature to select the base memory size according to memory-address mapping for the I/O hub. The options are 248T, 120T, 88T, 60T, 30T, 56T, 40T, 32T, 24T, 16T, 4T, 2T, 1T, 512G, 3584T, and **Auto**. The options of 248T, 120T, 88T, 60T, 30T, and 3584T are CPU-dependent.

MMIO High Granularity Size

Use this feature to select the high memory size according to memory-address mapping for the I/O hub. The options are 1G, 4G, 16G, 32G, 64G, 256G, and **1024G**. This feature is motherboard-dependent.

Bus Master Enable

If this feature is set to Enabled, the PCI Bus Driver will enable the Bus Master Attribute for DMA transactions. If this feature is set to Disabled, the PCI Bus Driver will disable the Bus Master Attribute for Pre-Boot DMA protection. The options are Disabled and **Enabled**.

NVMe Firmware Source

Use this feature to select the NVMe firmware to support system boot. The options are Vendor Defined Firmware and **AMI Native Support**. The option of Vendor Defined Firmware is pre-installed on the drive and may resolve errata or enable innovative functions for the drive. The default option, AMI Native Support, is offered by the BIOS with a generic method.

VGA Priority

Use this feature to select the graphics device to be used as the primary video display for system boot. The options are **Onboard** and Offboard.

Onboard Video Option ROM

Select EFI to boot the computer using the Extensible Firmware Interface (EFI) device installed on the onboard video port. The options are Disabled and **EFI**.

JAIOM 1 PCIe 5.0 X16 OPROM / JAIOM2 PCIe 5.0 X16 OPROM / JM2_1 PCIe 5.0 X2 OPROM / JM2_2 PCIe 5.0 X2 OPROM

Select EFI to allow you to boot the computer using the EFI device installed on the PCIe slot specified. The options are Disabled and **EFI**.

Note: The number of slots and slot naming vary based on your motherboard features.

HTTP Boot Configuration Menu

►HTTP Boot Configuration

HTTP Boot Policy

Use this feature to set the HTTP boot policy. The options are Apply to all LANs, **Apply to each LAN**, and Boot Priority #1 instantly.

HTTPS Boot Checks Hostname

Important: Disabling "HTTPS Boot Checks Hostname" is a violation of RFC 6125 and may expose you to Man-in-the-Middle Attacks. Supermicro is not responsible for any and all security risks incurred by you disabling this feature.

Enable this feature for HTTPS boot to check the hostname of the TLS certificates to see if it matches the host name provided by the remote server. The options are **Enabled** and Disabled (WARNING: Security Risk!!).

Priority of HTTP Boot

Instance of Priority 1: (Available when your motherboard supports this feature)

This feature sets the rank target port. The default setting is **1**.

Select IPv4 or IPv6

This feature specifies which connection the target LAN port should boot from. The options are **IPv4** and IPv6.

Boot Description

Use this feature to enter a boot description, which cannot be longer than 75 characters. Please be sure to enter a boot description; otherwise, the boot option for the URI cannot be created.

Boot URI

Enter a Boot Uniform Research Identifier (URI) with 128 characters or shorter. This Boot URI determines how IPv4 Boot Option and IPv6 Boot Option will be created.

Instance of Priority 2: (Available when your motherboard supports this feature)

This feature sets the rank target port. The default setting is **0**.

Select IPv4 or IPv6 (Unavailable when "Instance of Priority 2:" above is set to 0)

This feature specifies which connection the target LAN port should boot from. The options are **IPv4** and IPv6.

Boot Description (Unavailable when "Instance of Priority 2:" above is set to 0)

Use this feature to enter a boot description, which cannot be longer than 75 characters. Please be sure to enter a boot description; otherwise, the boot option for the URI cannot be created.

Boot URI (Unavailable when "Instance of Priority 2:" above is set to 0)

Enter a Boot URI with 128 characters or shorter. This Boot URI determines how IPv4 Boot Option and IPv6 Boot Option will be created.

Supermicro KMS Server Configuration Menu

►Supermicro KMS Server Configuration

Note: Be sure to configure all the features in the submenu of Supermicro KMS Server Configuration and the feature of "KMS Security Policy" in the submenu of Super-Guardians Configuration so that your system can communicate with the KMS server.

Supermicro KMS Server IP address

Use this feature to set the Supermicro Key Management Service (KMS) server IPv4 address in dotted-decimal notation.

Second Supermicro KMS Server IP address

Use this feature to set the second Supermicro KMS server IPv4 address in dotted-decimal notation.

Supermicro KMS TCP Port number

Use this feature to set the TCP port number used in the Supermicro KMS server. The valid range is 100–9999. The default setting is **5696**. Do not change the default setting unless a different TCP port number has been specified and used in the Supermicro KMS server.

KMS Time Out

Use this feature to enter the KMS server connecting time-out (in seconds). The default setting is **5** (seconds).

TimeZone

Use this feature to set the correct time zone. The default setting is **0** (not specified).

Client UserName

Press <Enter> to set the client identity (UserName). The length is 0–63 characters.

Client Password

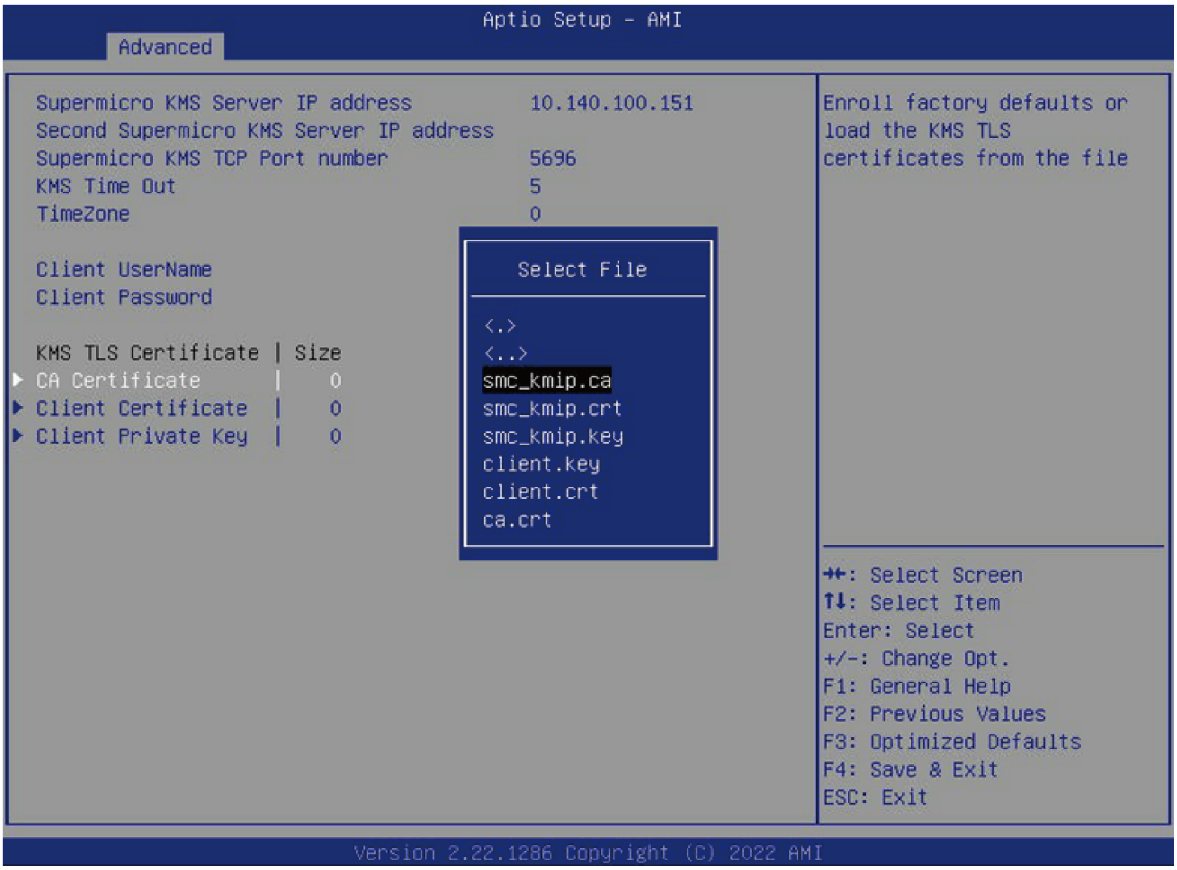
Press <Enter> to set the client identity (Password). The length is 0–31 characters.

►CA Certificate

►Client Certificate

►Client Private Key

Use the three features above to enroll factory defaults or load the KMS Transport Layer Security (TLS) certificates, which are generated by the KMS server, from the file stored in the USB flash drive as shown below.



Private Key Password (Available when "Client Private Key" above has been set)

Use this feature to change the private key password.

Super-Guardians Configuration Menu

►Super-Guardians Configuration

Super-Guardians Protection Policy

Use this feature to enable the Super-Guardians Protection Policy. The options are **Storage**, System, and System and Storage. Set this feature to Storage to protect and have secure access to the Trusted Computing Group (TCG) NVMe devices with the Authentication-Key (AK). Set this feature to System to protect and have secure access to your system/motherboard with the AK. Set this feature to System and Storage to protect and have secure access to your system/motherboard/storage devices with the AK.

KMS Security Policy (Available when "TPM Security Policy" and "USB Security Policy" are set to Disabled)

Set this feature to Enabled to enable the KMS Security Policy. When this feature has not previously been set to Enabled, the options are **Disabled** and Enabled. Changes take effect after you save settings and reboot the system.

When this feature has previously been set to Enabled, the options are **Enabled**, Reset, and Key Rotation. Set this feature to Key Rotation to obtain an existing AK from the KMS server and create a new AK. To disable the KMS Security Policy, set this feature to Reset. When this feature is set to Reset, the system and TCG NVMe devices chosen in "Super-Guardians Protection Policy" will be in the unprotected mode.

Notes:

- Be sure that the KMS server is ready before configuring this feature.
- Use the professional KMS server solutions (e.g., Thales Server) or the Supermicro PyKMIP Software Package to establish the KMS server.

KMS Server Retry Count (Available when "TPM Security Policy" and "USB Security Policy" are set to Disabled)

Use this feature to specify how many times the system will attempt reconnecting to the KMS server. The valid range is 0–10. Press the <+> or <-> key on your keyboard to change the value. The default setting is **5**. If the value is 0, the system will retry infinitely.

TPM Security Policy (Available when "KMS Security Policy" and "USB Security Policy" are set to Disabled)

Set this feature to Enabled to enable the TPM Security Policy. When this feature has not previously been set to Enabled, the options are **Disabled** and Enabled. Changes take effect after you save settings and reboot the system.

When this feature has previously been set to Enabled, the options are **Enabled** and Reset. To disable the TPM Security Policy, set this feature to Reset. When this feature is set to Reset, the system and TCG NVMe devices chosen in "Super-Guardians Protection Policy" will be in the unprotected mode.

Load Authentication-Key (Available when "KMS Security Policy," "TPM Security Policy," and "USB Security Policy" are set to Disabled)

The options are **Disabled** and Enabled. Set this feature to Enabled. Changes take effect after you save settings and reboot the system. While booting, the BIOS will automatically load the Authentication-Key (filename: TPMAuth.bin) from the USB flash drive. Afterwards, the default setting will be set to Disabled by the BIOS.

Notes:

- Be sure to connect a USB flash drive with the Authentication-Key (filename: TPMAuth.bin) to your system before the system reboot.
- Be sure to save the Authentication-Key (filename: TPMAuth.bin) to the USB flash drive and keep a backup. Load the Authentication-Key (filename: TPMAuth.bin) after the TPM (either onboard or external) is detected by your system. Otherwise, the TPM function can not work properly.

Save Authentication-Key (Available when "TPM Security Policy" is set to Enabled)

The options are **Disabled** and Enabled. Set this feature to Enabled. Changes take effect after you save settings and reboot the system. While booting, the BIOS will automatically save the Authentication-Key (filename: TPMAuth.bin) to the USB flash drive. Afterwards, the default setting will be set to Disabled by the BIOS.

Note: Be sure to connect a USB flash drive to your system before the system reboot.

USB Security Policy (Available when "KMS Security Policy" and "TPM Security Policy" are set to Disabled)

Use this feature to enable the USB Security Policy. The options are **Disabled** and Enabled. Set this feature to Enabled. Changes take effect after you save settings and reboot the system. Connect a USB flash drive to your system before the system reboot. While booting, the BIOS will automatically create the USB Authentication-Key (filename: USBAuth.bin) and save it to the USB flash drive.

When this feature has been previously set to Enabled, the options are **Enabled** and Reset. To disable the USB Security Policy, set this feature to Reset. When this feature is set to Reset, the system and TCG NVMe devices chosen in "Super-Guardians Protection Policy" will be in the unprotected mode.

Note: Be sure to connect a USB flash drive to your system before configuring this feature. Save the USB Authentication-Key (filename: USBAuth.bin) to the USB flash drive and keep a backup.

TLS Authenticate Configuration Menu

►TLS Authenticate Configuration

Use this submenu to configure Transport Layer Security (TLS) settings.

►Server CA Configuration

Use this feature to configure the client certificate that is to be used by the server.

►Enroll Certification

Use this feature to enroll the certificate in the system.

►Enroll Certification Using File

Use this feature to enroll the security certificate in the system by using a file.

►Commit Changes and Exit

Use this feature to save all changes and exit TLS settings.

►Discard Changes and Exit

Use this feature to discard all changes and exit TLS settings.

►Delete Certification

Use this feature to delete the certificate if a certificate has been enrolled in the system.

►Client Certification Configuration

8.4 Event Logs

Use this menu to configure Event Logs settings.

Note: After making any changes in this section, please be sure to reboot the system for the changes to take effect.

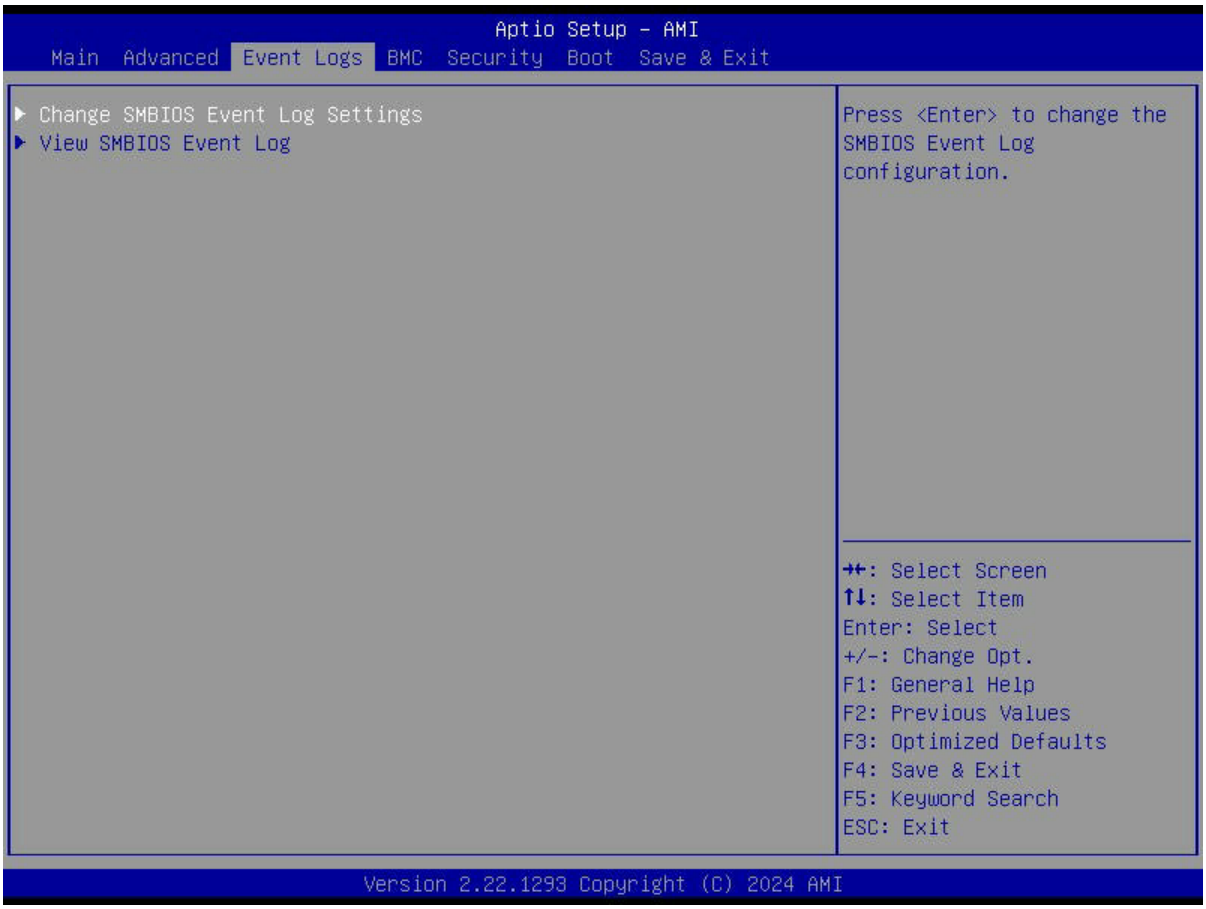


Figure 8-3. Event Logs Screen

►Change SMBIOS Event Log Settings

Note: Reboot the system for the changes in this section to take effect.

Enabling/Disabling Options

SMBIOS Event Log

Select Enabled to enable System Management BIOS (SMBIOS) Event Logging during system boot. The options are Disabled and **Enabled**.

Erasing Settings

Erase Event Log (Available when "SMBIOS Event Log" is set to Enabled)

Select No to keep the event log without erasing it upon next system bootup. Select (Yes, Next reset) to erase the event log upon next system reboot. The options are **No**, (Yes, Next reset), and (Yes, Every reset).

When Log is Full (Available when "SMBIOS Event Log" is set to Enabled)

Select Erase Immediately to immediately erase all errors in the SMBIOS event log when the event log is full. Select Do Nothing for the system to do nothing when the SMBIOS event log is full. The options are **Do Nothing** and Erase Immediately.

SMBIOS Event Log Standard Settings

Log System Boot Event (Available when "SMBIOS Event Log" is set to Enabled)

Select Enabled to log system boot events. The options are Enabled and **Disabled**.

MECI (Available when "SMBIOS Event Log" is set to Enabled)

Enter the increment value for the multiple event counter. Enter a number between 1 and 255. The default setting is **1**. (MECI is the abbreviation for Multiple Event Count Increment.)

METW (Available when "SMBIOS Event Log" is set to Enabled)

Use this feature to determine how long (in minutes) should the multiple event counter wait before generating a new event log. Enter a number between 0 and 99. The default value is **60**. (METW is the abbreviation for Multiple Event Count Time Window.)

►View SMBIOS Event Log

Use this feature to view the events in the system event log. Select this feature and press <Enter> to view the status of an event in the log. The following information is displayed: DATE / TIME / ERROR CODE / SEVERITY.

8.5 BMC

Use this menu to configure Baseboard Management Console (BMC) settings.



Figure 8-4. BMC Screen

BMC Firmware Revision

This feature indicates the BMC firmware revision used in this system.

BMC STATUS

This feature indicates the status of the BMC firmware installed in this system.

System Event Log Menu

►System Event Log

Note: All values changed in this submenu do not take effect until computer is restarted.

Enabling/Disabling Options

SEL Components

Select Enabled to enable all system event logging upon system boot. The options are Disabled and **Enabled**.

Erasing Settings

Erase SEL (Available when "SEL Components" is set to Enabled)

Select (Yes, On next reset) to erase all system event logs upon next system boot. Select (Yes, On every reset) to erase all system event logs upon each system reboot. Select No to keep all system event logs after each system reboot. The options are **No**, (Yes, On next reset), and (Yes, On every reset).

When SEL is Full (Available when "SEL Components" is set to Enabled)

This feature defines what the BIOS should do when the system event log is full. Select Erase Immediately to erase all events in the log when the system event log is full. The options are **Do Nothing** and Erase Immediately.

BMC Network Configuration Menu

►BMC Network Configuration

Update BMC LAN Configuration

Select Yes for the BIOS to implement all IP/MAC address changes upon next system boot. The options are **No** and Yes.

****

Configure IPv4 Support

****

BMC LAN Selection

This feature displays the type of the BMC LAN.

BMC Network Link Status:

This feature displays the status of the BMC network link for this system.

Configuration Address Source (Available when "Update BMC LAN Configuration" is set to Yes)

Use this feature to select the source of the IPv4 connection. If Static is selected, note the IP address of the IPv4 connection and enter it to the system manually in the field. If DHCP is

selected, the BIOS will search for a Dynamic Host Configuration Protocol (DHCP) server in the network that is attached to and request the next available IP address for this computer. The options are Static and **DHCP**.

Station IP Address

This feature displays the Station IP address in decimal and in dotted quad form (i.e., 172.29.176.131). It is available for configuration when "Configuration Address Source" above is set to Static.

Subnet Mask

This feature displays the sub- network that this computer belongs to. It is available for configuration when "Configuration Address Source" above is set to Static.

Station MAC Address

This feature displays the Station MAC address for this computer. MAC addresses are six two-digit hexadecimal numbers.

Gateway IP Address

This feature displays the Gateway IP address for this computer. This should be in decimal and in dotted quad form (i.e., 172.29.0.1). It is available for configuration when "Configuration Address Source" above is set to Static.

****

Configure IPv6 Support

****

IPv6 Address Status

This feature displays the status of the IPv6 address.

IPv6 Support (Available when "Update BMC LAN Configuration" is set to Yes)

Use this feature to enable IPv6 support. The options are **Enabled** and Disabled.

Configuration Address Source (Available when "IPv6 Support" is set to Enabled)

Use this feature to select the source of the IPv6 connection. If Static Configuration is selected, note the IP address of IPv6 connection and enter it to the system manually in the field. If the other two options are selected, the BIOS will search for a DHCP server in the network that is attached to and request the next available IP address for this computer. The options are Static Configuration, **DHCPv6 Stateless**, and DHCPv6 Stateful.

IPv6 Address ("Static," "DHCPv6 Stateless," or "DHCPv6 Stateful," depending on the option you selected for "Configuration Address Source" above)

This feature displays the station IPv6 address.

Prefix Length

This feature displays the prefix length. It is available for configuration when "Configuration Address Source" above is set to Static Configuration.

Gateway IP

This feature displays the IPv6 gateway IP address. It is available for configuration when "Configuration Address Source" above is set to Static Configuration.

Advanced Settings (Available when "Configuration Address Source" is set to DHCPv6 Stateless)

Use this feature to set the DNS server IP. The default setting allows this system to obtain the DNS server IP automatically. The options are **Auto obtain DNS server IP** and Manually obtain DNS server IP.

Preferred DNS server IP (Available when "Advanced Settings" above is set to Manually obtain DNS server IP)

This feature displays the preferred DNS server IP. It can be configured via Redfish.

Alternative DNS server IP (Available when "Advanced Settings" above is set to Manually obtain DNS server IP)

This feature displays the alternative DNS server IP. It can be configured via Redfish.

****

Configure VLAN Support

****

VLAN Support (Available when "Update BMC LAN Configuration" is set to Yes)

Use this feature to enable the virtual LAN (VLAN) support. The options are Enabled and **Disabled**.

VLAN ID (Available when "VLAN Support" is set to Enabled)

Use this feature to create a new VLAN ID. The valid range is 1–4094. The default setting is **1**.

8.6 Security

Use this menu to configure the following security settings for the system.

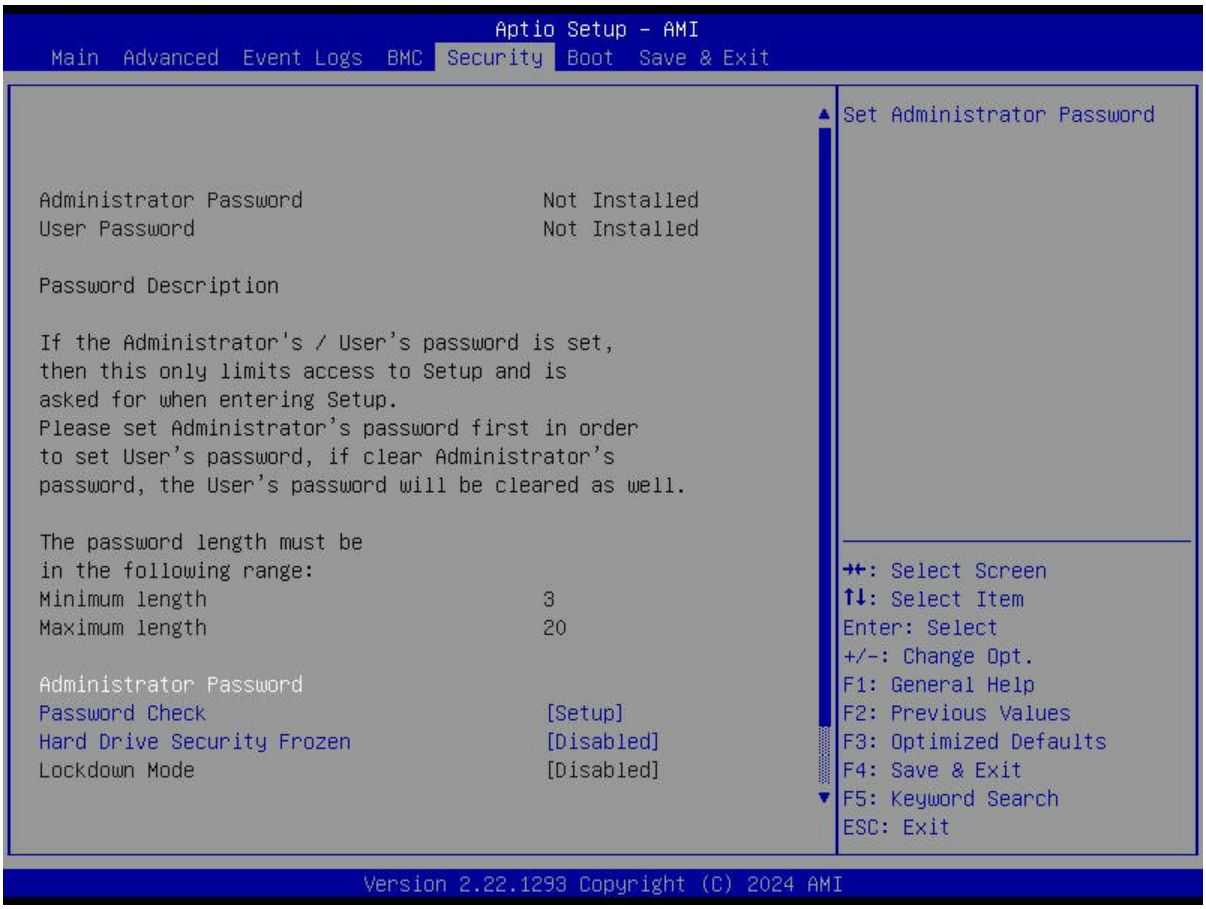


Figure 8-5. Security Screen

Disable Block Sid and Freeze Lock (Available when your storage devices support TCG)

Select Enabled to allow SID authentication to be performed in TCG storage devices. The options are **Disabled** and Enabled.

The following information is displayed:

- Administrator Password
- User Password
- Password Description

Administrator Password

This feature indicates if an administrator password has been installed. Use this feature to set the administrator password, which is required to enter the BIOS Setup utility. The length of the password can be between three and 20 characters long.

User Password (Available when "Administrator Password" has been set)

This feature indicates if a user password has been installed. Use this feature to set the user password which is required to enter the BIOS Setup utility. The length of the password can be between three and 20 characters long.

Password Check

Select Setup for the system to check for a password upon entering the BIOS Setup utility. Select Always for the system to check for the passwords needed at bootup and upon entering the BIOS Setup utility. The options are **Setup** and Always.

Hard Drive Security Frozen

Select Enabled to freeze the Lock Security feature for HDD to protect key data in hard drives from being altered. The options are **Disabled** and Enabled.

Lockdown Mode (Available when the DCMS key is activated)

Select Enabled to support the Lockdown Mode, which prevents the existing data or keys stored in the system from being altered or changed in an effort to preserve system integrity and security. The options are **Disabled** and Enabled.

Secure Boot Menu

►Secure Boot

The following information is displayed:

- System Mode
- Secure Boot

Note: For detailed instructions on configuring Security Boot settings, refer to the Security Boot Configuration User's Guide at https://www.supermicro.com/support/manuals.

Secure Boot

Select Enabled to configure Secure Boot settings. The options are **Disabled** and Enabled.

Secure Boot Mode

Use this feature to select the desired secure boot mode for the system. The options are Standard and **Custom**.

►Enter Audit Mode

Select Ok to enter the Audit Mode workflow. It will result in erasing the Platform Key (PK) variables and resetting the system to the Setup/Audit Mode.

Note: This submenu is available when "Secure Boot Mode" is set to Custom.

►Enter Deployed Mode / Exit Deployed Mode

Select Ok to reset system to the User Mode or to the Deployed Mode.

Note: This submenu is available when "Secure Boot Mode" is set to Custom.

►Key Management

The following information is displayed:

- Vendor Keys

Note: This submenu is available when "Secure Boot Mode" is set to Custom.

Provision Factory Defaults

Select Enabled to install the default secure boot keys when the system is in the Setup Mode. Changes take effect after you save settings and reboot the system. The options are **Disabled** and Enabled.

►Restore Factory Keys

Select Yes to restore manufacturer default keys to ensure system security. The options are **Yes** and No. Selecting Yes will reset the system to the User Mode.

Note: This submenu is available when any secure keys have been installed.

►Reset To Setup Mode

This feature resets the system to the Setup Mode. The options are **Yes** and No.

Note: This submenu is available when any secure keys have been installed.

►Enroll Efi Image

This feature allows the Efi image to run in the secure boot mode and enroll the SHA256 Hash certificate of a PE image into the Authorized Signature Database (DB).

►Export Secure Boot Variables

This feature exports the NVRAM contents of secure boot variables to a storage device. The options are **Yes** and No.

Note: This submenu is available when any secure keys have been installed.

Secure Boot variable / Size / Keys / Key Source

►Platform Key (PK)

Use this feature to enter and configure a set of values to be used as platform firmware keys for the system. These values also indicate the sizes, key numbers, and the sources of the authorized signatures. Select Update to update the platform key.

►Key Exchange Keys (KEK)

Use this feature to enter and configure a set of values to be used as Key Exchange Keys for the system. These values also indicate the sizes, key numbers, and the sources of the authorized signatures. Select Update to update the Key Exchange Keys. Select Append to append the Key Exchange Keys.

►Authorized Signatures (db)

Use this feature to enter and configure a set of values to be used as Authorized Signatures for the system. These values also indicate the sizes, key numbers, and sources of the authorized signatures. Select Update to update the Authorized Signatures. Select Append to append the new Authorized Signatures.

►Forbidden Signatures (dbx)

Use this feature to enter and configure a set of values to be used as Forbidden Signatures for the system. These values also indicate sizes, key numbers, and key sources of the forbidden signatures. Select Update to update the Forbidden Signatures. Select Append to append the Forbidden Signature.

►Authorized TimeStamps (dbt)

Use this feature to set and save the timestamps for the Authorized Signatures, which will indicate the time when these signatures are entered into the system. These values also indicate sizes, keys, and key sources of the authorized timestamps. Select Update to update the Authorized TimeStamps. Select Append to append the Authorized TimeStamps.

►OsRecovery Signatures (dbr)

Use this feature to set and save the Authorized Signatures used for OS recovery. Select Update to update the OsRecovery Signatures. These values also indicate sizes, keys, and key sources of the OsRecovery Signatures. Select Append to append the OsRecovery Signatures.

8.7 Boot

Use this menu to configure Boot settings.

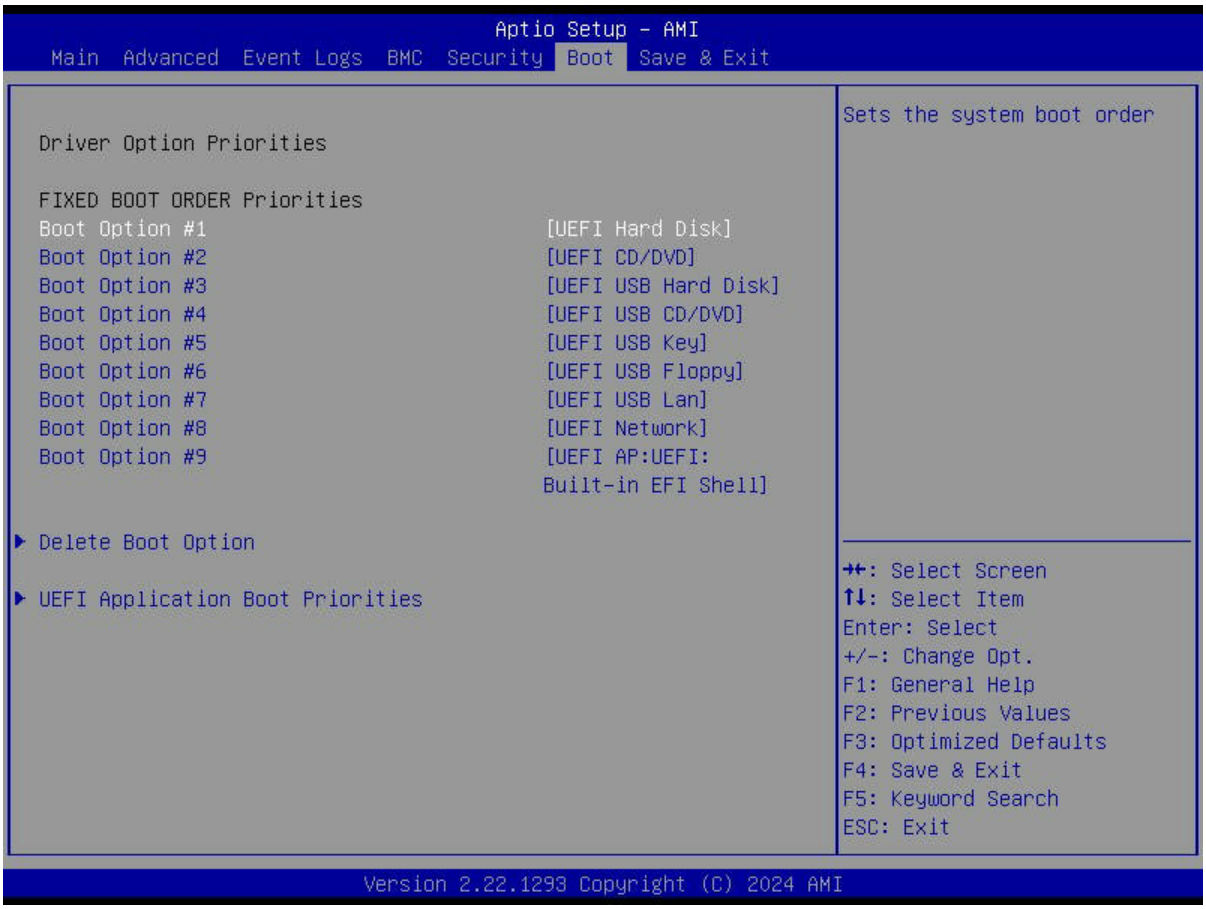


Figure 8-6. Boot Screen

FIXED BOOT ORDER Priorities

Use this feature to prioritize the order of a bootable device from which the system will boot. Press <Enter> on each item sequentially to select the device.

- Boot Option #1 – Boot Option #9

►Add New Boot Option

Use this feature to add a new boot option to the boot priority features for system boot.

Note: This submenu is available when any storage device is detected by the BIOS.

Add boot option

Use this feature to specify the name for the new boot option.

Path for boot option

Use this feature to enter the path for the new boot option in the format fsx:\path\filename.efi.

Boot option File Path

Use this feature to specify the file path for the new boot option.

Create

After setting the name and the file path for the boot option, press <Enter> to create the new boot option in the boot priority list.

►Delete Boot Option

Use this feature to select a boot device to delete from the boot priority list.

Delete Boot Option

Use this feature to remove an EFI boot option from the boot priority list.

►UEFI Application Boot Priorities

Use this feature to set the system boot order of detected devices.

8.8 Save & Exit

Select Save & Exit from the BIOS Setup screen to configure the settings below.

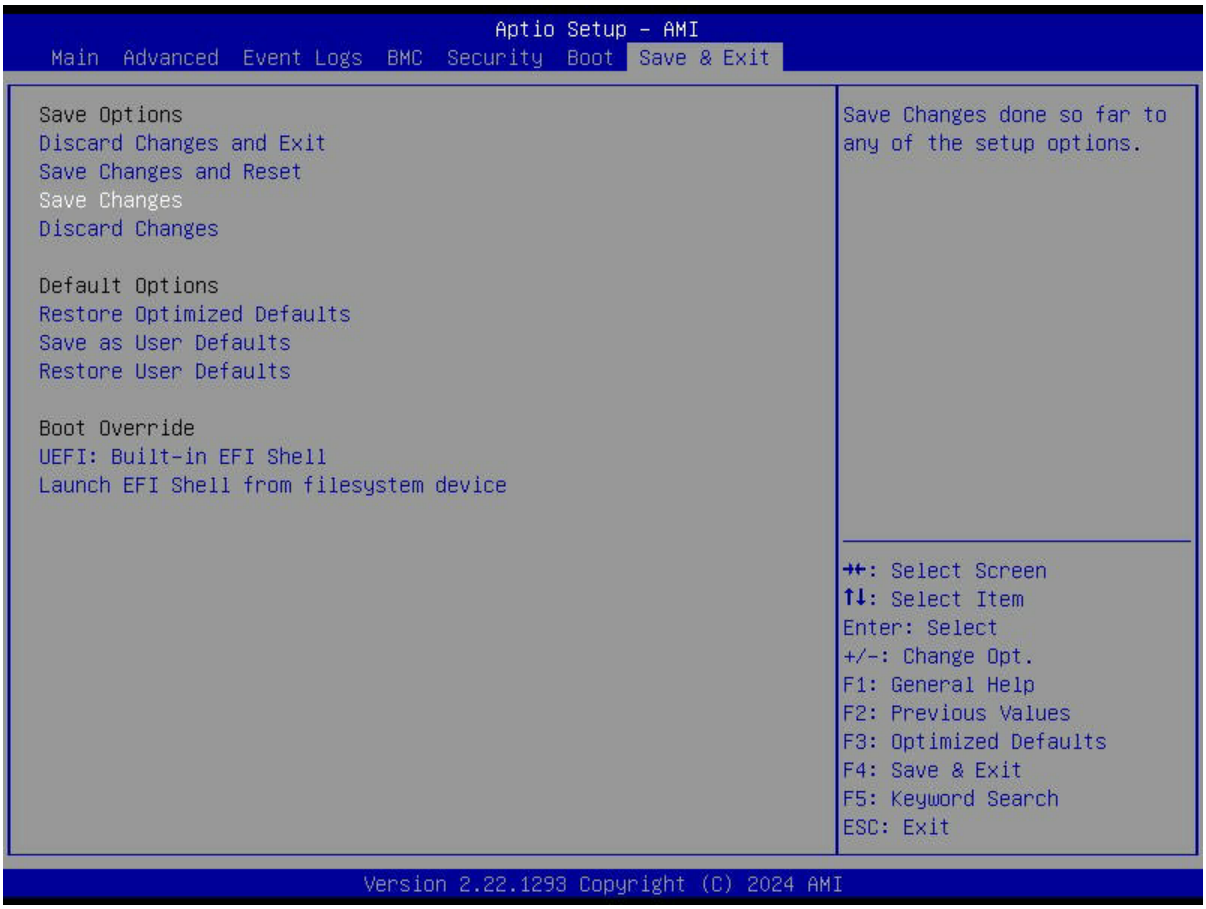


Figure 8-7. Save & Exit Screen

Save Options

Discard Changes and Exit

Use this feature to exit from the BIOS Setup utility without making any permanent changes to the system configuration and reboot the computer.

Save Changes and Reset

On completing the system configuration changes, use this feature to exit the BIOS Setup utility and reboot the computer for the new system configuration parameters to take effect.

Save Changes

On completing the system configuration changes, use this feature to save all changes made. This will not reset (reboot) the system.

Discard Changes

Select this feature and press <Enter> to discard all changes made and return to the BIOS Setup utility.

Default Options

Restore Optimized Defaults

Select this feature and press <Enter> to load manufacturer optimized default settings, which are intended for maximum system performance but not for maximum stability.

Note: Reboot the system for the changes to take effect to ensure that the system has the optimized default settings.

Save as User Defaults

Select this feature and press <Enter> to save all changes as the default values specified to the BIOS Setup utility for future use.

Restore User Defaults

Select this feature and press <Enter> to retrieve user-defined default settings that have been saved previously.

Boot Override

Note: Use this section to override the Boot priorities sequence in the Boot menu, and immediately boot the system with a device specified here instead of the one specified in the boot list. This is a one-time boot override.

UEFI: Built-in EFI Shell

Use this feature to launch the built-in EFI shell environment.

Launch EFI Shell from filesystem device

Use this feature to launch the EFI shell application (Shell.efi) from one of the available filesystem devices. A filesystem is a virtual, logical, or physical system for organizing, managing, and accessing the files and directories on devices such as SSDs, HDDs, or other storage devices.

Appendix A:

BIOS Codes

For information about BIOS codes for the SYS-222C-TN server, refer to the following content.

BIOS Error POST (Beep) Codes

During the Power-On Self-Test (POST) routines, which are performed each time the system is powered on, errors may occur.

Non-fatal errors are those which, in most cases, allow the system to continue the boot up process. The error messages normally appear on the screen.

Fatal errors are those which will not allow the system to continue the boot up process. If a fatal error occurs, you should consult with your system manufacturer for possible repairs.

These fatal errors are usually communicated through a series of audible beeps that can be heard on an external buzzer connected to JD1. The table shown below lists some common errors and their corresponding beep codes encountered by users.

BIOS Beep (POST) Codes		
Beep Code	**Error Message**	**Description**
1 beep	Refresh	Circuits have been reset (Ready to power up)
5 short, 1 long	Memory error	No memory detected in system
5 short, 2 long	Display memory read/write error	Video adapter missing or with faulty memory
1 long continuous	System OH	System overheat condition

Additional BIOS POST Codes

The AMI BIOS supplies additional checkpoint codes, which are documented online at https://www.supermicro.com/support/manuals ("AMI BIOS POST Codes User's Guide").

For information on AMI updates, refer to https://www.ami.com/products.

Appendix B:

Standardized Warning Statements for AC Systems

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this section in its entirety before installing or configuring components in the Supermicro SYS-222C-TN server.

These warnings may also be found on our website at the following page:

https://www.supermicro.com/about/policies/safety_information.cfm

Warning Definition



Warning! This warning symbol means danger. You are in a situation that could cause bodily injury. Before you work on any equipment, be aware of the hazards involved with electrical circuitry and be familiar with standard practices for preventing accidents.

警告の定義

この警告サインは危険を意味します。

人身事故につながる可能性がありますので、いずれの機器でも動作させる前に、

電気回路に含まれる危険性に注意して、標準的な事故防止策に精通して下さい。

此警告符号代表危险。

您正处于可能受到严重伤害的工作环境中。在您使用设备开始工作之前，必须充分意识到触电的危险，并熟练掌握防止事故发生的标准工作程序。请根据每项警告结尾的声明号码找到此设备的安全性警告说明的翻译文本。

此警告符號代表危險。

您正處於可能身體可能會受損傷的工作環境中。在您使用任何設備之前，請注意觸電的危險，並且要熟悉預防事故發生的標準工作程序。請依照每一注意事項後的號碼找到相關的翻譯說明內容。

Warnung

WICHTIGE SICHERHEITSHINWEISE

Dieses Warnsymbol bedeutet Gefahr. Sie befinden sich in einer Situation, die zu Verletzungen führen kann. Machen Sie sich vor der Arbeit mit Geräten mit den Gefahren elektrischer Schaltungen und den üblichen Verfahren zur Vorbeugung vor Unfällen vertraut. Suchen Sie mit der am Ende jeder Warnung angegebenen Anweisungsnummer nach der jeweiligen Übersetzung in den übersetzten Sicherheitshinweisen, die zusammen mit diesem Gerät ausgeliefert wurden.

BEWAHREN SIE DIESE HINWEISE GUT AUF.

INSTRUCCIONES IMPORTANTES DE SEGURIDAD

Este símbolo de aviso indica peligro. Existe riesgo para su integridad física. Antes de manipular cualquier equipo, considere los riesgos de la corriente eléctrica y familiarícese con los procedimientos estándar de prevención de accidentes. Al final de cada advertencia encontrará el número que le ayudará a encontrar el texto traducido en el apartado de traducciones que acompaña a este dispositivo.

GUARDE ESTAS INSTRUCCIONES.

IMPORTANTES INFORMATIONS DE SÉCURITÉ

Ce symbole d'avertissement indique un danger. Vous vous trouvez dans une situation pouvant entraîner des blessures ou des dommages corporels. Avant de travailler sur un équipement, soyez conscient des dangers liés aux circuits électriques et familiarisez-vous avec les procédures couramment utilisées pour éviter les accidents. Pour prendre connaissance des traductions des avertissements figurant dans les consignes de sécurité traduites qui accompagnent cet appareil, référez-vous au numéro de l'instruction situé à la fin de chaque avertissement.

CONSERVEZ CES INFORMATIONS.

תקנון הצהרות אזהרה

הצהרות הבאות הן אזהרות על פי תקני התעשייה, על מנת להזהיר את המשתמש מפני חבלה

פיזית אפשרית. במידה ויש שאלות או היתקלות בבעיה כלשהי, יש ליצור קשר עם מחלקת תמיכה

טכנית של סופרמיקרו. טכנאים מוסמכים בלבד רשאים להתקין או להגדיר את הרכיבים.

יש לקרוא את הנספח במלואו לפני התקנת או הגדרת הרכיבים במארזי סופרמיקרו.

ا كً ف حالة وٌكي أى تتسبب ف اصابة جسذ ةٌ هذا الز هز عٌ خطز !تحذ زٌ.

قبل أى تعول على أي هعذات،كي على علن بالوخاطز ال اجٌوة عي الذوائز

الكهزبائ ةٍ

وكي على درا ةٌ بالووارسات النقائ ةٍ لو عٌ وقنع أي حادث

استخذم رقن الب إى الو صٌنص ف هًا ةٌ كل تحذ زٌ للعثٌر تزجوتها

안전을 위한 주의사항

경고!

이 경고 기호는 위험이 있음을 알려 줍니다. 작업자의 신체에 부상을 야기 할 수 있는 상태에 있게 됩니다. 모든 장비에 대한 작업을 수행하기 전에 전기회로와 관련된 위험요소들을 확인하시고 사전에 사고를 방지할 수 있도록 표준 작업절차를 준수해 주시기 바랍니다.

해당 번역문을 찾기 위해 각 경고의 마지막 부분에 제공된 경고문 번호를 참조하십시오

BELANGRIJKE VEILIGHEIDSINSTRUCTIES

Dit waarschuwings symbool betekent gevaar. U verkeert in een situatie die lichamelijk letsel kan veroorzaken. Voordat u aan enige apparatuur gaat werken, dient u zich bewust te zijn van de bij een elektrische installatie betrokken risico's en dient u op de hoogte te zijn van de standaard procedures om ongelukken te voorkomen. Gebruik de nummers aan het eind van elke waarschuwing om deze te herleiden naar de desbetreffende locatie.

BEWAAR DEZE INSTRUCTIES

Installation Instructions

Warning! Read the installation instructions before connecting the system to the power source.

設置手順書

システムを電源に接続する前に、設置手順書をお読み下さい。

警告

将此系统连接电源前,请先阅读安装说明。

警告

將系統與電源連接前,請先閱讀安裝說明。

Warnung

Vor dem Anschließen des Systems an die Stromquelle die Installationsanweisungen lesen.

¡Advertencia!

Lea las instrucciones de instalación antes de conectar el sistema a la red de alimentación.

Attention

Avant de brancher le système sur la source d'alimentation, consulter les directives d'installation.

יש לקרוא את הוראות התקנה לפני חיבור המערכת למקור מתח.

اقر إرشادات التركيب قبل توصيل النظام إلى مصدر للطاقة

시스템을 전원에 연결하기 전에 설치 안내를 읽어주십시오.

Waarschuwing

Raadpleeg de installatie-instructies voordat u het systeem op de voedingsbron aansluit.

Circuit Breaker

Warning! This product relies on the building's installation for short-circuit (overcurrent) protection. Ensure that the protective device is rated not greater than: 250 V, 20 A.

サーキット・ブレーカー

この製品は、短絡(過電流)保護装置がある建物での設置を前提としています。

保護装置の定格が250 V、20 Aを超えないことを確認下さい。

警告

此产品的短路(过载电流)保护由建筑物的供电系统提供,确保短路保护设备的额定电流不大于 250V,20A。

警告

此產品的短路(過載電流)保護由建築物的供電系統提供,確保短路保護設備的額定電流不大於 250V,20A。

Warnung

Dieses Produkt ist darauf angewiesen, dass im Gebäude ein Kurzschluss- bzw. Überstromschutz installiert ist. Stellen Sie sicher, dass der Nennwert der Schutzvorrichtung nicht mehr als: 250 V, 20 A beträgt.

¡Advertencia!

Este equipo utiliza el sistema de protección contra cortocircuitos (o sobrecorrientes) del edificio. Asegúrese de que el dispositivo de protección no sea superior a: 250 V, 20 A.

Attention

Pour ce qui est de la protection contre les courts-circuits (surtension), ce produit dépend de l'installation électrique du local. Vérifiez que le courant nominal du dispositif de protection n'est pas supérieur à :250 V, 20 A.

מוצר זה מסתמך על הגנה המותקנת במבנים למניעת קצר חשמלי. יש לוודא כי

המכשיר המגן מפני הקצר החשמלי הוא לא יותר מ-250V, 20A

هذا المنتج يعتمد على معداث الحمايت مه الدوائر القصيرة التي تم تثبيتها في

المبنى

تأكد من أن تقييم الجهاز الوقائي ليس أكثر من : 20A, 250V

경고!

이 제품은 전원의 단락(과전류)방지에 대해서 전적으로 건물의 관련 설비에 의존합니다. 보호장치의 정격이 반드시 250V(볼트), 20A(암페어)를 초과하지 않도록 해야 합니다.

Waarschuwing

Dit product is afhankelijk van de kortsluitbeveiliging (overspanning) van uw electrische installatie. Controleer of het beveiligde aparaat niet groter gedimensioneerd is dan 250V, 20A.

Power Disconnection Warning



Warning! The system must be disconnected from all sources of power and the power cord removed from the power supply module(s) before accessing the chassis interior to install or remove system components (except for hot-swap components).

電源切断の警告

システムコンポーネントの取り付けまたは取り外しのために、シャーシー内部にアクセスするには、

システムの電源はすべてのソースから切断され、電源コードは電源モジュールから取り外す必要があります。

警告

在你打开机箱并安装或移除内部器件前,必须将系统完全断电,并移除电源线。

警告

在您打開機殼安裝或移除內部元件前,必須將系統完全斷電,並移除電源線。

Warnung

Das System muss von allen Quellen der Energie und vom Netzanschlusskabel getrennt sein, das von den Spg.Versorgungsteilmodulen entfernt wird, bevor es auf den Chassisinnenraum zurückgreift, um Systemsbestandteile anzubringen oder zu entfernen.

¡Advertencia!

El sistema debe ser disconnected de todas las fuentes de energía y del cable eléctrico quitado de los módulos de fuente de alimentación antes de tener acceso el interior del chasis para instalar o para quitar componentes de sistema.

Attention

Le système doit être débranché de toutes les sources de puissance ainsi que de son cordon d'alimentation secteur avant d'accéder à l'intérieur du chassis pour installer ou enlever des composants de systéme.

אזהרה מפני ניתוק חשמלי

אזהרה!

יש לנתק את המערכת מכל מקורות החשמל ויש להסיר את כבל החשמלי מהספק

לפני גישה לחלק הפנימי של המארז לצורך התקנת או הסרת רכיבים.

يجب فصم انظاو من جميع مصادر انطاقت وإزانت سهك انكهرباء من وحدة امداد

انطاقت قبم

انصل إنى انمناطق انداخهيت نههيكم نتثبيج أو إزانت مكنناث الجهاز

경고!

시스템에 부품들을 장착하거나 제거하기 위해서는 섀시 내부에 접근하기 전에 반드시 전원 공급장치로부터 연결되어있는 모든 전원과 전기코드를 분리해주어야 합니다.

Waarschuwing

Voordat u toegang neemt tot het binnenwerk van de behuizing voor het installeren of verwijderen van systeem onderdelen, dient u alle spanningsbronnen en alle stroomkabels aangesloten op de voeding(en) van de behuizing te verwijderen

Equipment Installation

Warning! Only authorized personnel and qualified service persons should be allowed to install, replace, or service this equipment.

機器の設置

トレーニングを受け認定された人だけがこの装置の設置、交換、またはサービスを許可されています。

警告

只有经过培训且具有资格的人员才能进行此设备的安装、更换和维修。

警告

只有經過受訓且具資格人員才可安裝、更換與維修此設備。

Warnung

Nur autorisiertes Personal und qualifizierte Servicetechniker dürfen dieses Gerät installieren, austauschen oder warten.

¡Advertencia!

Sólo el personal autorizado y el personal de servicio calificado deben poder instalar, reemplazar o dar servicio a este equipo.

Attention

Seul le personnel autorisé et le personnel de maintenance qualifié doivent être autorisés à installer, remplacer ou entretenir cet équipement.

אזהרה!

יש לאפשר רק צוות מורשה ואנשי שירות מוסמכים להתקין, להחליף או לטפל בציוד זה

.ينبغي السماح فقط للموظفين المعتمدين وأفراد الخدمة المؤهلين بتركيب هذا الجهاز أو استبداله أو صيانته

경고!

승인된 직원과 자격을 갖춘 서비스 담당자만이 이 장비를 설치, 교체 또는 서비스할 수 있습니다.

Waarschuwing

Alleen geautoriseerd personeel en gekwalificeerd onderhoudspersoneel mag deze apparatuur installeren, vervangen of onderhouden.

Rack Stability Hazard



Warning! Stability hazard. The rack may tip over causing serious personal injury. Before extending the rack to the installation position, read the installation instructions. Do not put any load on the slide-rail mounted equipment in the installation position. Do not leave the slide-rail mounted equipment in the installation position.

ファンの警告

安定性に危険があります。ラックが転倒して、重大な人身事故を引き起こす可能性があります。ラックを設置位置まで伸ばす前に、設置手順をお読みください。設置位置にあるスライドレールに取り付けられた機器に負荷をかけないでください。スライドレールに取り付けられた機器を設置位置に放置しないでください。

警告

稳定性危险。机架可能会翻倒，造成严重的人身伤害。在将机架延伸到安装位置之前，请阅读安装说明。请勿在安装位置对滑轨安装的设备施加任何负载。请勿将滑轨安装的设备留在安装位置。

警告

穩定性危險。機架可能會翻倒，造成嚴重的人身傷害。將機架延伸至安裝位置前，請先閱讀安裝說明。請勿在安裝位置的滑軌安裝設備上放置任何負載。請勿將滑軌安裝設備留在安裝位置。

Warnung

Gefahr der Instabilität. Das Rack kann umkippen und schwere Verletzungen verursachen. Lesen Sie die Installationsanweisungen, bevor Sie das Rack in die Einbauposition ausfahren. Belasten Sie die auf den Gleitschienen montierten Geräte nicht in der Einbauposition. Lassen Sie die auf den Gleitschienen montierten Geräte nicht in der Einbauposition.

¡Advertencia!

Peligro de inestabilidad. El rack podría volcarse y causar lesiones personales graves. Antes de extender el rack a la posición de instalación, lea las instrucciones de instalación. No coloque ninguna carga sobre el equipo montado sobre rieles deslizantes en la posición de instalación. No deje el equipo montado sobre rieles deslizantes en la posición de instalación.

Attention

Danger d’instabilité. Le rack peut basculer et provoquer des blessures corporelles graves. Avant d’étendre le rack en position d’installation, lire les instructions d’installation. Ne pas charger l’équipement monté sur rail de glissière en position d’installation. Ne pas laisser l’équipement monté sur rail de glissière en position d’installation.

אזהרה!

סכנת חוסר יציבות

המתלה עלול להתהפך ולגרום לפציעה חמורה

לפני הארכת המתלה למצב ההתקנה, קרא את הוראות ההתקנה

אין להעמיס כל עומס על הציוד המותקן על מסילת ההחלקה במצב ההתקנה

אל תשאיר את הציוד המותקן על מסילת ההחלקה במצב ההתקנה

تحذير!

خطر عدم الاستقرار.

قد ينقلب الرف مسبباً إصابات جسدية خطيرة.

قبل تمديد الرف إلى موضع التركيب، اقرأ تعليمات التركيب.

لا تضع أي حمولة على الجهاز المثبت على سكة الانزلاق في موضع التركيب.

لا تترك الجهاز المثبت على سكة الانزلاق في موضع التركيب.

경고!

안정성 위험. 랙이 넘어져 심각한 개인 부상을 입을 수 있습니다. 랙을 설치 위치까지 확장하기 전에 설치 지침을 읽으십시오. 설치 위치에서 슬라이드 레일 장착 장비에 하중을 가하지 마십시오. 슬라이드 레일 장착 장비를 설치 위치에 두지 마십시오.

Waarschuwing

Gevaar voor instabiliteit. Het rek kan kantelen en ernstig persoonlijk letsel veroorzaken. Lees de installatie-instructies voordat u het rek uitschuift naar de installatiepositie. Plaats geen last op de op de glijrail gemonteerde apparatuur in de installatiepositie. Laat de op de glijrail gemonteerde apparatuur niet in de installatiepositie staan.

Restricted Area



Warning! This unit is intended for installation in restricted access areas. A restricted access area can be accessed only through the use of a special tool, lock and key, or other means of security. (This warning does not apply to workstations).

アクセス制限区域

このユニットは、アクセス制限区域に設置されることを想定しています。

アクセス制限区域は、特別なツール、鍵と錠前、その他のセキュリティの手段を用いてのみ出入りが可能です。

警告

此部件应安装在限制进出的场所，限制进出的场所指只能通过使用特殊工具、锁和钥匙或其它安全手段进出的场所。

警告

此裝置僅限安裝於進出管制區域，進出管制區域係指僅能以特殊工具、鎖頭及鑰匙或其他安全方式才能進入的區域。

Warnung

Diese Einheit ist zur Installation in Bereichen mit beschränktem Zutritt vorgesehen. Der Zutritt zu derartigen Bereichen ist nur mit einem Spezialwerkzeug, Schloss und Schlüssel oder einer sonstigen Sicherheitsvorkehrung möglich.

¡Advertencia!

Esta unidad ha sido diseñada para instalación en áreas de acceso restringido. Sólo puede obtenerse acceso a una de estas áreas mediante la utilización de una herramienta especial, cerradura con llave u otro medio de seguridad.

Attention

Cet appareil doit être installée dans des zones d'accès réservés. L'accès à une zone d'accès réservé n'est possible qu'en utilisant un outil spécial, un mécanisme de verrouillage et une clé, ou tout autre moyen de sécurité.

אזור עם גישה מוגבלת

אזהרה!

יש להתקין את היחידה באזורים שיש בהם הגבלת גישה. הגישה ניתנת בעזרת

'כלי אבטחה בלבד (מפתח, מנעול וכד.)

اتخصيص هذه انحذة نترك بُها ف مناطق محظورة تم .

مَكن انصل إن منطقت محظورة فقط من خلال استخذاو أداة خاصت،

أو أ وس هُت أخري نلالأمما قفم ومفتاح

경고!

이 장치는 접근이 제한된 구역에 설치하도록 되어있습니다. 특수도구, 잠금 장치 및 키, 또는 기타 보안 수단을 통해서만 접근 제한 구역에 들어갈 수 있습니다.

Waarschuwing

Dit apparaat is bedoeld voor installatie in gebieden met een beperkte toegang. Toegang tot dergelijke gebieden kunnen alleen verkregen worden door gebruik te maken van speciaal gereedschap, slot en sleutel of andere veiligheidsmaatregelen.

Battery Handling



CAUTION There is risk of explosion if the battery is replaced by an incorrect type. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions.

電池の取り扱い

バッテリーを間違ったタイプに交換すると爆発の危険があります。交換する電池はメーカーが推奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さい。

警告

如果更换的电池类型不正确。请只使用同类电池或制造商推荐的功能相当的电池更换原有电池。请按制造商的说明处理废旧电池。

警告

如果更換的電池類型不正確。請使用製造商建議之相同或功能相當的電池更換原有電池。請按照製造商的說明指示處理廢棄舊電池。

WARNUNG

Es besteht Explosionsgefahr, wenn die Batterie durch einen falschen Typ ersetzt wird. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

ADVERTENCIA

Existe riesgo de explosión si la batería se reemplaza por un tipo incorrecto. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

ATTENTION

Il existe un risque d'explosion si la batterie est remplacée par un type incorrect. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

אזהרה!

קיימת סכנת פיצוץ אם הסוללה תוחלף בסוג שגוי. יש להחליף

את הסוללה בסוג התואם מחברת יצרן מומלצת.

סילוק הסוללות המשומשות יש לבצע לפי הוראות היצרן.

هناك خطر الانفجار إذا تم استبدال البطارية بنوع غير صحيح.

اسحبذال البطارية

فقط بنفس النمع أو ما يعادلها مما أوصث به الشرمة المصنعة

جخلص من البطاريات المسحعملة وفقا لحعليمات الشرمة الصانعة

경고!

배터리를 잘못된 종류로 교체하면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

WAARSCHUWING

Er bestaat explosiegevaar als de batterij wordt vervangen door een verkeerd type. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Redundant Power Supplies



Warning! This unit might have more than one power supply connection. All connections must be removed to de-energize the unit.

冗長電源装置

このユニットは複数の電源装置が接続されている場合があります。

ユニットの電源を切るためには、すべての接続を取り外さなければなりません。

警告

此部件连接的电源可能不止一个，必须将所有电源断开才能停止给该部件供电。

警告

此裝置連接的電源可能不只一個，必須切斷所有電源才能停止對該裝置的供電。

Warnung

Dieses Gerät kann mehr als eine Stromzufuhr haben. Um sicherzustellen, dass der Einheit kein trom zugeführt wird, müssen alle Verbindungen entfernt werden.

¡Advertencia!

Puede que esta unidad tenga más de una conexión para fuentes de alimentación. Para cortar por completo el suministro de energía, deben desconectarse todas las conexiones.

Attention

Cette unité peut avoir plus d'une connexion d'alimentation. Pour supprimer toute tension et tout courant électrique de l'unité, toutes les connexions d'alimentation doivent être débranchées.

אם קיים יותר מספק אחד

אזהרה!

ליחדה יש יותר מחיבור אחד של ספק. יש להסיר את כל החיבורים על מנת לרוקן

את היחידה.

قد يكون لهذا الجهاز عدة اتصالات بوحدات امداد الطاقة .

يجب إزالة كافة الاتصالات لعسل الوحدة عن الكهرباء

경고!

이 장치에는 한 개 이상의 전원 공급 단자가 연결되어 있을 수 있습니다. 이 장치에 전원을 차단하기 위해서는 모든 연결 단자를 제거해야만 합니다.

Waarschuwing

Deze eenheid kan meer dan één stroomtoevoeraansluiting bevatten. Alle aansluitingen dienen verwijderd te worden om het apparaat stroomloos te maken.

Backplane Voltage



Warning! Hazardous voltage or energy is present on the backplane when the system is operating. Use caution when servicing.

バックプレーンの電圧

システムの稼働中は危険な電圧または電力が、バックプレーン上にかかっています。

修理する際には注意ください。

警告

当系统正在进行时，背板上有很危险的电压或能量，进行维修时务必小心。

警告

當系統正在進行時，背板上有危險的電壓或能量，進行維修時務必小心。

Warnung

Wenn das System in Betrieb ist, treten auf der Rückwandplatine gefährliche Spannungen oder Energien auf. Vorsicht bei der Wartung.

¡Advertencia!

Cuando el sistema está en funcionamiento, el voltaje del plano trasero es peligroso. Tenga cuidado cuando lo revise.

Attention

Lorsque le système est en fonctionnement, des tensions électriques circulent sur le fond de panier. Prendre des précautions lors de la maintenance.

מתח בפנל האחורי

אזהרה!

קיימת סכנת מתח בפנל האחורי בזמן תפעול המערכת. יש להיזהר במהלך

העבודה.

هناك خطز مه التيار الكهزبائي أوالطاقة المىجىدة على اللىحة

عندما يكىن النظام يعمل كه حذرا عند خدمة هذا الجهاس

경고!

시스템이 동작 중일 때 후면판 (Backplane)에는 위험한 전압이나 에너지가 발생 합니다. 서비스 작업 시 주의하십시오.

Waarschuwing

Een gevaarlijke spanning of energie is aanwezig op de backplane wanneer het systeem in gebruik is. Voorzichtigheid is geboden tijdens het onderhoud.

Comply with Local and National Electrical Codes



Warning! Installation of the equipment must comply with local and national electrical codes.

地方および国の電気規格に準拠

機器の取り付けはその地方および国の電気規格に準拠する必要があります。

警告

设备安装必须符合本地与本国电气法规。

警告

設備安裝必須符合本地與本國電氣法規。

Warnung

Die Installation der Geräte muss den Sicherheitsstandards entsprechen.

¡Advertencia!

La instalacion del equipo debe cumplir con las normas de electricidad locales y nacionales.

Attention

L'équipement doit être installé conformément aux normes électriques nationales et locales.

תיאום חוקי החשמל הארצי

אזהרה!

התקנת הציוד חייבת להיות תואמת לחוקי החשמל המקומיים והארציים.

تركيب المعدات الكهربائية يجب أن يمتثل للقناويه المحلية والبطنية المتعلقة

بالكهرباء

경고!

현 지역 및 국가의 전기 규정에 따라 장비를 설치해야 합니다.

Waarschuwing

Bij installatie van de apparatuur moet worden voldaan aan de lokale en nationale elektriciteitsvoorschriften.

Product Disposal

Warning! Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄

この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告

本产品的废弃处理应根据所有国家的法律和规章进行。

警告

本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung

Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!

Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

אזהרה!

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

عند التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقا لجميع القانين واللنائح النطنية

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Fan Warning

Warning! Hazardous moving parts. Keep away from moving fan blades. The fans might still be turning when you remove the fan assembly from the chassis. Keep fingers, screwdrivers, and other objects away from the openings in the fan assembly's housing



ファンの警告

警告！ 回転部品に注意。運転中は回転部(羽根)に触れないでください。シャーシから冷却ファン装置を取り外した際、ファンがまだ回転している可能性があります。ファンの開口部に、指、ドライバー、およびその他のものを近づけないで下さい。

警告!

警告！ 危险的可移动性零件。请务必与转动的风扇叶片保持距离。当您从机架移除风扇装置，风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇

警告

危險的可移動性零件。請務必與轉動的風扇葉片保持距離。當您從機架移除風扇裝置，風扇可能仍在轉動。小心不要將手指、螺絲起子和其他物品太靠近風扇。

Warnung

Gefährlich Bewegende Teile. Von den bewegenden Lüfterblätter fern halten. Die Lüfter drehen sich u. U. noch, wenn die Lüfterbaugruppe aus dem Chassis genommen wird. Halten Sie Finger, Schraubendreher und andere Gegenstände von den Öffnungen des Lüftergehäuses entfernt.

¡Advertencia!

Riesgo de piezas móviles. Mantener alejado de las aspas del ventilador. Los ventiladores podran dar vuelta cuando usted quite ell montaje del ventilador del chasis. Mandtenga los dedos, los destornilladores y todos los objetos lejos de las aberturas del ventilador.

Attention

Pieces mobiles dangereuses. Se tenir a l’ecart des lames du ventilateur Il est possible que les ventilateurs soient toujours en rotation lorsque vous retirerez le bloc ventilateur du châssis. Prenez garde à ce que doigts, tournevis et autres objets soient éloignés du logement du bloc ventilateur.

אזהרה!

חלקים נעים מסוכנים. התרחק מלהבי המאוורר בפעולהכאשר מסירים את חלקי

המאוורר מהמארז, יתכן והמאוררים עדיין עובדים. יש להרחיק למרחק בטוח את

האצבעות וכלי עבודה שונים מהפתחים בתוך המאוורר

تحذير! أجزاء متحركة خطرة. ابتعد عن شفرات المروحة المتحركة.من الممكن أن

المراوح لا تزال تدور عند إزالة كتلة المروحة من الهيكل يجب إبقاء الأصابع

ومفكات البراغي وغيرها من الأشياء بعيدا عن الفتحات في كتلة المروحة.

경고!

움직이는 위험한 부품. 회전하는 송풍 날개에 접근하지 마세요. 섀시로부터 팬 조립품을 제거할 때 팬은 여전히 회전하고 있을 수 있습니다. 팬 조림품 외관의 열려있는 부분들로부터 손가락 및 스크류드라이버, 다른 물체들이 가까이 하지 않도록 배치해 주십시오.

Waarschuwing

Gevaarlijk bewegende onderdelen. Houd voldoende afstand tot de bewegende ventilatorbladen. Het is mogelijk dat de ventilator nog draait tijdens het verwijderen van het ventilatorsamenstel uit het chassis. Houd uw vingers, schroevendraaiers en eventuele andere voorwerpen uit de buurt van de openingen in de ventilatorbehuizing.

Power Cable and AC Adapter



Warning! When installing the product, use the provided or designated connection cables, power cables and AC adaptors. Using any other cables and adaptors could cause a malfunction or a fire. Electrical Appliance and Material Safety Law prohibits the use of UL or CSA -certified cables (that have UL/CSA shown on the cord) for any other electrical devices than products designated by Supermicro only.

電源コードとACアダプター

製品を設置する場合、提供または指定および購入された接続ケーブル、電源コードとACアダプターを該当する地域の条例や安全基準に適合するコードサイズやプラグと共に使用下さい。他のケーブルやアダプタを使用すると故障や火災の原因になることがあります。

電気用品安全法は、ULまたはCSA認定のケーブル(UL/CSAマークがコードに表記)をSupermicroが指定する製品以外に使用することを禁止しています。

警告

安装此产品时,请使用本身提供的或指定的或采购的连接线,电源线和电源适配器,包含遵照当地法规和安全要求的合规的电源线尺寸和插头.使用其它线材或适配器可能会引起故障或火灾。除了Supermicro所指定的产品,电气用品和材料安全法律规定禁止使用未经UL或CSA认证的线材。(线材上会显示UL/CSA符号)。

警告

安裝此產品時,請使用本身提供的或指定的或採購的連接線,電源線和電源適配器,包含遵照當地法規和安全要求的合規的電源線尺寸和插頭.使用其它線材或適配器可能會引起故障或火災。除了Supermicro所指定的產品,電氣用品和材料安全法律規定禁止使用未經UL或CSA認證的線材。(線材上會顯示UL/CSA符號)。

Warnung

Nutzen Sie beim Installieren des Produkts ausschließlich die von uns zur Verfügung gestellten Verbindungskabeln, Stromkabeln und/oder Adapater, die Ihre örtlichen Sicherheitsstandards einhalten. Der Gebrauch von anderen Kabeln und Adapter können Fehlfunktionen oder Feuer verursachen. Die Richtlinien untersagen das Nutzen von UL oder CAS zertifizierten Kabeln (mit UL/CSA gekennzeichnet), an Geräten oder Produkten die nicht mit Supermicro gekennzeichnet sind.

¡Advertencia!

Cuando instale el producto, utilice la conexión provista o designada o procure cables, Cables de alimentación y adaptadores de CA que cumplan con los códigos locales y los requisitos de seguridad, incluyendo el tamaño adecuado del cable y el enchufe. El uso de otros cables y adaptadores podría causar un mal funcionamiento o un incendio. La Ley de Seguridad de Aparatos Eléctricos y de Materiales prohíbe El uso de cables certificados por UL o CSA (que tienen el certificado UL / CSA en el código) para cualquier otros dispositivos eléctricos que los productos designados únicamente por Supermicro.

Attention

Lors de l'installation du produit, utilisez les cables de connection fournis ou désigné ou achetez des cables, cables de puissance et adaptateurs respectant les normes locales et les conditions de securite y compris les tailles de cables et les prises electriques appropries. L'utilisation d'autres cables et adaptateurs peut provoquer un dysfonctionnement ou un incendie. Appareils électroménagers et la Loi sur la Sécurité Matériel interdit l'utilisation de câbles certifies- UL ou CSA (qui ont UL ou CSA indiqué sur le code) pour tous les autres appareils électriques sauf les produits désignés par Supermicro seulement.

AC ימאתמו סיילמשח סילבכ

הרהזא!

ררוצל ומאתוה וא ושכרנ רשא AC סימאתמו סיקפס ,סילבכב שמתשהל שי ,רצומה תא סיניקתמ רשאכ לכב שומיש . עקתהו לבכה לש הנוכנ הדימ ללוכ ,תוימוקמה תוחיטבה תושירדל ומאתוה רשאו ,הנקתהה למשחה ירישכמב שומישה יקוחל סאתהב .ילמשח רצק וא הלקתל סורגל לולע ,רחא גוסמ סאתמ וא לבכ לש דוק סהילע עיפומ רשאכ) CSA- ב וא UL - ב סיכמסומה סילבכב שמתשהל רוסיא סייק ,תוחיטבה יקוחו דבלב Supermicro י"ע סאתוה רשא רצומב קר אלא ,רחא ילמשח רצומ לכ רובע UL/CSA).

تالباكلا ءارشب مق وأ ةددحملا وأ ةرفوتملا تاليصوتلا مادختساب مق ،جتنملا بيكرت دنع

كلذ يف امب ةيلحملا ةمالسلا تابلطتمو نيناوقب مازتلالا عم ددرتملا رايتلا تالوحمو ةيئابرهكلا

قيرح وأ لطع يف ببستي دق برخأ تالوحمو تالباك يأ مادختسا .ميلسلا سباقلاو لصوملا مجح.

CSA وأ UL لبق نم ةدمتعملا تالباكلا مادختسا تادعملاو ةيئابرهكلا ةزهجألل ةمالسلا نوناق رظحي

Supermicro لبق نم ةددحملاو ةينعملا تاجتنملا ريغ برخأ تادعم يأ عم (UL/CSA) ةمالع لمحت يتلاو.

전원 케이블 및 AC 어댑터

경고! 제품을 설치할 때 현지 코드 및 적절한 굵기의 코드와 플러그를 포함한 안전 요구 사항을 준수하여 제공되거나 지정된 연결 혹은 구매 케이블, 전원 케이블 및 AC 어댑터를 사용하십시오.

다른 케이블이나 어댑터를 사용하면 오작동이나 화재가 발생할 수 있습니다. 전기 용품 안전법은 UL 또는 CSA 인증 케이블 (코드에 UL / CSA가 표시된 케이블)을 Supermicro 가 지정한 제품 이외의 전기 장치에 사용하는 것을 금지합니다.

Stroomkabel en AC-Adapter

Waarschuwing! Bij het aansluiten van het Product uitsluitend gebruik maken van de geleverde Kabels of een andere geschikte aan te schaffen Aansluitmethode, deze moet altijd voldoen aan de lokale voorschriften en veiligheidsnormen, inclusief de juiste kabeldikte en stekker. Het gebruik van niet geschikte Kabels en/of Adapters kan een storing of brand veroorzaken. Wetgeving voor Elektrische apparatuur en Materiaalveiligheid verbied het gebruik van UL of CSA -gecertificeerde Kabels (met UL/CSA in de code) voor elke andere toepassing dan de door Supermicro hiervoor beoogde Producten.

Appendix C:

System Specifications

Processors
Dual Intel® Xeon® 6700/6500-series processors (in Socket E2 LGA4710) with four UPIs (24 GT/s max.) and a thermal design power (TDP) up to 350 W air cooled
BIOS
AMI SPI BIOS NAND Flash 64/256 Mb support SPI dual/quad speed control, RTC (Real Time Clock) wakeup, riser card auto detection support, IPMIView, SMCIPMITOOL, IPMI CFG, Redundant power supply unit detection, SPM, SUM-OOB/InBand
Memory
32 DIMM slots supports up to 4 TB of ECC DDR5 RDIMM memory with speeds of up to 6400 MT/s (1DPC) or 5200 MT/s (2DPC)
Storage Drives
24 hot-swap 2.5" NVMe/SAS/SATA drive bays (additional storage cards and cables required) Two M.2 PCIe 5.0 x2 NVMe SSD slots M-key in the 22110 or 2280 form factors for boot; VROC required for RAID **Note:** M.2 slots are intended to be used only for boot devices. Write-intensive workloads may result in the SSD overheating. PCIe lanes are shared between CEM slots and drive bays. Enabling more CEM slots may reduce the number of NVme drives available.
PCI Expansion Slots
Two PCIe 5.0 x16 AIOM (OCP 3.0 compatible) Option 1 and 2: Four PCIe 5.0 x16 slots (full-height, full-length) One PCIe 5.0 x8 slot (full-height, full-length) Option 2: Two PCIe 5.0 x16 slot (full-height, full-length) One PCIe 5.0 x8 slot (full-height, full-length) Option 3: Six PCIe 5.0 x16 slots (full-height, full-length) **Note:** PCIe lanes are shared between CEM slots and drive bays. Enabling more NVMe drives may reduce the number of CEM slots available. Full-length card requires 1U heatsinks with special air shroud.
Input/Output
Via DC-SCM: One RJ45 1 GbE Dedicated IPMI LAN port One USB 3.0 Type-A port One USB 2.0 Type-A port One VGA port One TPM header

Motherboard
X14DBHM: proprietary 13.70" x 16.70" (347.98 mm x 424.18 mm) (WxL)
Chassis
CSE-DC201TS-R000NP: 2U rackmount 17.2" x 3.5" x 30.7" (438 x 88 x 780 mm) (WxHxD)
System Cooling
Four 8-cm heavy duty fans with optimal fan speed control Two air shroud
Power Supply
Model: PWS-2K09A-1R, 2000 W dual redundant modules, 80 Plus Titanium level Input: 1000 W: 100-127 VAC 1800 W: 200-220 VAC 1980 W: 220-230 VAC 2000 W: 230-240 VAC 2000 W: 220-240 VAC (UL only) 2000 W: 230-240 VAC (CQC only) Output: +12 V Max: 83 A (100-127 VAC)/150 A (200-220 VAC)/165 A (220-230 VAC)/166 A (230-240 VAC) + 12 VSB Max: 3.5 A
Operating Environment
Operating Temperature: 10º to 35º C (50º to 95º F) Non-operating Temperature: -30º to 60º C (-30º to 140º F) Operating Relative Humidity: 8% to 80% (non-condensing) Non-operating Relative Humidity: 8% to 90% (non-condensing)
Regulatory Compliance
FCC, ICES, CE, VCCI, RCM, UKCA, NRTL, CB, KCC
Certified Safety Models
Compliant with UL or CSA: DC201-R20X14 or DC201-MHS

Applied Directives, Standards

EMC/EMI: 2014/30/EU (EMC Directive)

Electromagnetic Compatibility Regulations 2016

FCC Part 15

ICES-003

VCCI-CISPR 32

AS/NZS CISPR 32

BS/EN55032

BS/EN55035

CISPR 32

CISPR 35

BS/EN 61000-3-2

BS/EN 61000-3-3

BS/EN 61000-4-2

BS/EN 61000-4-3

BS/EN 61000-4-4

BS/EN 61000-4-5

BS/EN 61000-4-6

BS/EN 61000-4-8

BS/EN 61000-4-11

Environment:

2011/65/EU (RoHS Directive)

EC 1907/2006 (REACH)

2012/19/EU (WEEE Directive)

California Proposition 65

Product Safety: 2014/35/EU (LVD Directive)

UL/CSA 62368-1 (USA and Canada)

Electrical Equipment (Safety) Regulations 2016

IEC/BS/EN 62368-1

Perchlorate Warning

California Best Management Practices Regulations for Perchlorate Materials: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. “Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate”

Appendix D:

RoHS

限用物質含有情況標示聲明書

Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱：伺服器/ Server
Equipment name

型號（型式）：DC201-R20X14 (系列型號: DC201-MHS, SYS-222C-TN)
Type designation (Type)

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr^{+6})	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
機殼 (Chassis)	○	○	○	○	○	○
機殼風扇 (Chassis Fan)	—	○	○	○	○	○
線材 (Cable)	○	○	○	○	○	○
主機板 (Motherboard)	—	○	○	○	○	○
電源供應器 (Power Supply)	—	○	○	○	○	○
硬碟 (SSD)	—	○	○	○	○	○
附加卡 (Add on Card)	—	○	○	○	○	○

備考1. 〝超出0.1 wt %〞及〝超出0.01 wt %〞係指限用物質之百分比含量超出百分比含量基準值。
Note 1：“Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. 〝○〞係指該項限用物質之百分比含量未超出百分比含量基準值。
Note 2：“○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. 〝—〞係指該項限用物質為排除項目。
Note 3：The “–” indicates that the restricted substance corresponds to the exemption.

警告: 為避免電磁干擾, 本產品不應安裝或使用於住宅環境。

輸入額定:

100-127V ~, 60-50Hz, 12-9A (X2)
200-240V ~, 60-50Hz, 10-9.8A (X2)

*使用者不能任意拆除或替換內部配備
*報驗義務人之姓名或名稱：美超微電腦股份有限公司
*報驗義務人之地址：新北市中和區建一路 150 號 3 樓

Appendix E:

General Data Center Environmental Specifications

Particulate Contamination Specifications

Air filtration: Data centers must be kept clean to Class 8 of ISO 14644-1 (ISO 2015). The air entering the data center should be filtered with a MERV 11 filter or better. The air within the data center should be continuously filtered with a MERV 8 filter or better.

Conductive dust: Air should be free of conductive dust, zinc whiskers, or other conductive particles.

Corrosive dust: Air should be free of corrosive dust.

Gaseous Contamination Specifications

Copper coupon corrosion rate: <300 Å/month per class G1 as defined by ANSI.ISA71.04-2013, reference by ASHRAE TC 9.9

Silver coupon corrosion rate: <200 Å/month per class G1 as defined by ANSI.ISA71.04-2013, reference by ASHRAE TC 9.9

Note: If testing with silver or copper coupons results in values less that 200 Å/month or 300 Å/month, respectively, then operating up to 70% relative humidity (RH) is acceptable. If the testing shows corrosion levels exceed these limits, then catalyst type pollutants are probably present and RH should be driven to 50% or lower.

Appendix F:

Statement of Volatility (SOV)

The Statement of Volatility provides information about volatile and non-volatile components of the SYS-222C-TN server. When power is removed from the system, non-volatile components retain their data, while volatile components lose their data.

SMC Product Number SYS-222C-TN				
Device	**Reference**	**Volatility**	**User Data**	**Procedure to Clear**
X14DBHM				
LCMXO3LF-6900C-6BG324C	U3	NO	NO	USE PROGRAMMER TO CLEAR
LCMXO2-640HC-4TG100C	U135	NO	NO	USE PROGRAMMER TO CLEAR
MX25L512EMI-10G	U169	NO	NO	USE PROGRAMMER TO CLEAR
MP2985BGLUT-4206	UV10, UV30	NO	NO	USE PROGRAMMER TO CLEAR
MP2985BGLUT-0019	UV16, UV36	NO	NO	USE PROGRAMMER TO CLEAR
MP2992BGMKT-4688	UV1, UV21	NO	NO	USE PROGRAMMER TO CLEAR
MP9941GMJT-0035	UV15, UV35	NO	NO	USE PROGRAMMER TO CLEAR
MP5990-003F	UV43, UV45	NO	NO	USE PROGRAMMER TO CLEAR
AOM-SCM-DCX6				
BIOS SPI FLASH	UM16	NO	NO	USE SOFTWARE AND UTILITY TO ERASE
BMC EMMC	UM10	NO	NO	USE SOFTWARE AND UTILITY TO ERASE
BMC SPI FLASH	UM7	NO	NO	USE SOFTWARE AND UTILITY TO ERASE
AOM-DC201-FAN				

SMC Product Number SYS-222C-TN				
Device	**Reference**	**Volatility**	**User Data**	**Procedure to Clear**
FRU EEPROM	U2	NO	NO	USE SOFTWARE AND UTILITY TO ERASE
RSC-M-6G5				
EEPROM	U1	NO	NO	USE EEPROMRW TOOL TO ERASE
RSC-M2R-6G5				
EEPROM	U1	NO	NO	USE EEPROMRW TO ERASE
CBL-ASMC-1226MT16P				
FRU-EEPROM	U1	NO	NO	USE PROGRAMMER TO CLEAR
CBL-ASMC-1240MT16P				
FRU-EEPROM	U1	NO	NO	USE SOFTWARE AND UTILITY TO ERASE
CBL-ASMC-1281DM5RYP				
FRU-EEPROM	U1	NO	NO	USE SOFTWARE AND UTILITY TO ERASE
BPN-NVME5-HS219N-S8				
LCMXO2-4000HC-4MG-132C	U3	NO	NO	USE PROGRAMMER TO CLEAR
PWS-2K09A-1R				
UCD3138RHAR	U13	NO	NO	USE PROGRAMMER TO CLEAR
UCD3138064RGCR	U601	NO	NO	USE PROGRAMMER TO CLEAR

Appendix G:

Compliance Certifications

The SYS-222C-TN server was tested and certified for various compliance standards, including EMC and safety. The EMC and safety evaluations were conducted by HCT America and CSA Lab, respectively, using the following safety models: DC201-R16DX14, DC201-R32X14, DC201-R22X14, DC201-MHS, DC201-R12X14, and DC201-R20X14. Additionally, the server received certifications from BSMI (Taiwan), KCC (Korea), and Lot 9 (Europe). Below is a comprehensive list of tests performed by HCT America on the sample system.

Phenomena	Test Method(s)	Limit/Performance Criteria
Radiated Emissions (30 MHz to 1 GHz)	EN 55032 ANSI 63.4-2014 KS C 9832 VCCI-CISPR 32	Quasi-Peak (dBµV/m) = 40-57
Radiated Emissions (1 GHz to 6 GHz)	EN 55032 KS C 9832 VCCI-CISPR 32	Average dBµV/m = 56-60 Peak dBµV/m = 76-80
Radiated Emission (1 GHz to 18 GHz)	ANSI 63.4-2014	Average dBµV/m = 60 Peak dBµV/m = 80
Radiated Emission (18 GHz to 28 GHz)	ANSI 63.4-2014	Average dBµV/m = 60 Peak dBµV/m = 80
Conducted Emission	EN 55032 ANSI 63.4-2014 KS C 9832 VCCI-CISPR 32	AC Main Power Port Average dBµV/m = 60-66 Peak dBµV/m = 73-79 Wired Network/Antenna Port Average dBµV/m = 74-84 Peak dBµV/m = 87-90
Harmonics	EN 61000-3-2	Refer to test method
Flicker	EN 61000-3-3	Refer to test method
Electrostatic Discharge (ESD)	EN 61000-4-2 KS C 9610-4-2	Criteria B
RF Electro-Magnetic Field (EMF)	EN 61000-4-3 KS C 9610-4-3	Criteria A

Phenomena	Test Method(s)	Limit/Performance Criteria
Fast Transients Common Mode	EN 61000-4-4 KS C 9610-4-4	Criteria B
Surge	EN 61000-4-5 KS C 9610-4-5	Criteria B
RF Common Mode	EN 61000-4-6 KS C 9610-4-6	Criteria A
Voltage Dips and Interruptions	EN 61000-4-11 KS C 9610-4-11	Criteria B, C

Performance Criteria

- **Performance Criteria A:** The equipment must function as intended without requiring any intervention from the operator. There should be no degradation in performance, loss of function, or change in operating state below the performance level specified by the manufacturer when the equipment is used as intended. If applicable, the performance level may be substituted by an acceptable loss of performance. If the manufacturer does not specify a minimum performance level or permissible performance loss, these can be inferred from the product description and documentation, as well as from what the user can reasonably expect when using the equipment as intended.
- **Performance Criteria B:** During the disturbance application, a temporary degradation of performance is acceptable. However, no unintended changes to the actual operating state or stored data should persist after the test concludes. Following the test, the equipment must operate as intended without requiring operator intervention. There should be no degradation of performance or loss of function below the level specified by the manufacturer when the equipment is used as intended. If a minimum performance level or permissible performance loss is not defined by the manufacturer, these parameters can be inferred from the product description, documentation, and reasonable user expectations when the equipment is used properly.
- **Performance Criteria C:** Loss of function is permitted, as long as the function can recover on its own or can be restored by the user following the manufacturer's instructions. A reboot or restart operation is acceptable. Information stored in non-volatile memory or protected by a battery backup must not be lost.

National Compliance

The system fulfills the requirements of national differences for the following: EU Group Differences, EU Special National Differences, Argentina (AR), Australia (AU), Canada (CA), China (CN), Japan (JP), New Zealand (NZ), United States (US), and Saudi Arabia (SA). The requirements that the system fulfills are listed below.

- EN IEC 62368-1:2020+A11:2020
- CSA C22.2 No. 62368-1:19, UL 62368-1, 3rd Edition
- BS EN IEC 62368-1:2020+A11:2020
- AS/NZS 62368.1:2020
- GB 4943.1-2022
- J62368-1(2023)
- KC 62368-1
- SASO-IEC 62368-1:2020

Power Supply Considerations

The server has been verified with a variety of power supplies. Below is a list of the tested and safe power supplies with their wattage.

Important: PWS-1K21A and PWS-2K21A-1R are not valid with KCC (Korea).

- PWS-1K61A-1R (AC | 1600 W)
- PWS-1K62D-1R (DC | 1600 W)
- PWS-3K21A-1R2 (AC | 3200 W)
- PWS-1K21A-1R (AC | 1200 W)
- PWS-2K21A-1R (AC | 2200 W)